

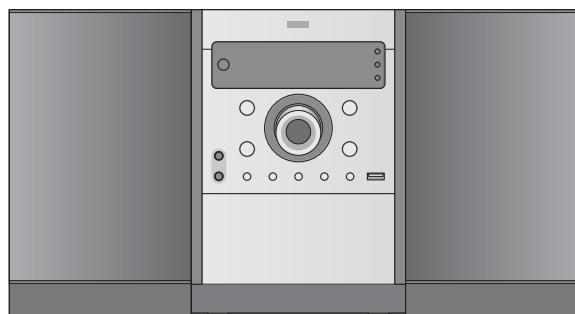


SERVICE MANUAL

MICRO Hi-Fi SYSTEM SERVICE MANUAL

CAUTION

BEFORE SERVICING THE UNIT, READ THE "SAFETY PRECAUTIONS" IN THIS MANUAL.



P/NO : AFN33894938

APRIL, 2007

MODEL : XC62-A0U (XCS62F)

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SECTION 1 GENERAL

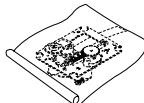
SERVICING PRECAUTIONS

NOTES REGARDING HANDLING OF THE PICK-UP

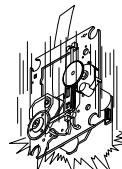
1. Notes for transport and storage

- 1) The pick-up should always be left in its conductive bag until immediately prior to use.
- 2) The pick-up should never be subjected to external pressure or impact.

Storage in conductive bag



Drop impact

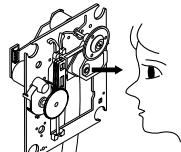


2. Repair notes

- 1) The pick-up incorporates a strong magnet, and so should never be brought close to magnetic materials.
- 2) The pick-up should always be handled correctly and carefully, taking care to avoid external pressure and impact. If it is subjected to strong pressure or impact, the result may be an operational malfunction and/or damage to the printed-circuit board.
- 3) Each and every pick-up is already individually adjusted to a high degree of precision, and for that reason the adjustment point and installation screws should absolutely never be touched.
- 4) Laser beams may damage the eyes!

Absolutely never permit laser beams to enter the eyes!

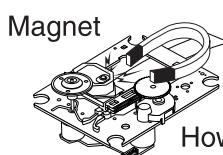
Also NEVER switch ON the power to the laser output part (lens, etc.) of the pick-up if it is damaged.



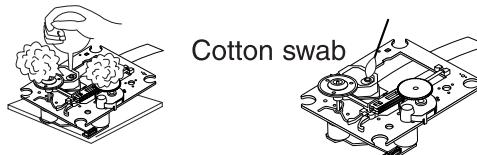
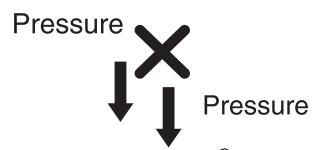
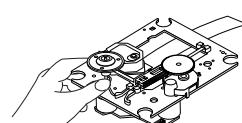
NEVER look directly at the laser beam, and don't let contact fingers or other exposed skin.

5) Cleaning the lens surface

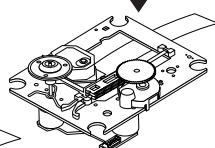
If there is dust on the lens surface, the dust should be cleaned away by using an air bush (such as used for camera lens). The lens is held by a delicate spring. When cleaning the lens surface, therefore, a cotton swab should be used, taking care not to distort this.



How to hold the pick-up



Cotton swab



Conductive Sheet

6) Never attempt to disassemble the pick-up.

Spring by excess pressure. If the lens is extremely dirty, apply isopropyl alcohol to the cotton swab. (Do not use any other liquid cleaners, because they will damage the lens.) Take care not to use too much of this alcohol on the swab, and do not allow the alcohol to get inside the pick-up.

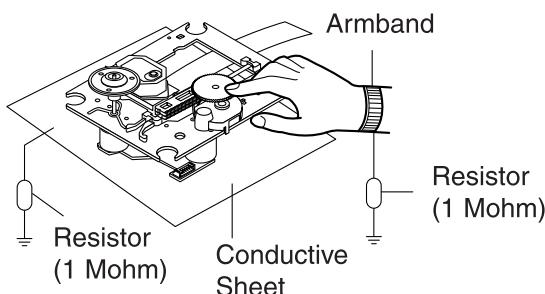
NOTES REGARDING COMPACT DISC PLAYER REPAIRS

1. Preparations

- 1) Compact disc players incorporate a great many ICs as well as the pick-up (laser diode). These components are sensitive to, and easily affected by, static electricity. If such static electricity is high voltage, components can be damaged, and for that reason components should be handled with care.
- 2) The pick-up is composed of many optical components and other high-precision components. Care must be taken, therefore, to avoid repair or storage where the temperature or humidity is high, where strong magnetism is present, or where there is excessive dust.

2. Notes for repair

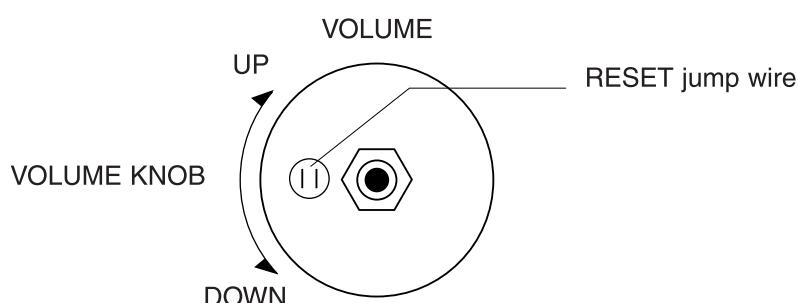
- 1) Before replacing a component part, first disconnect the power supply lead wire from the unit
- 2) All equipment, measuring instruments and tools must be grounded.
- 3) The workbench should be covered with a conductive sheet and grounded.
When removing the laser pick-up from its conductive bag, do not place the pick-up on the bag. (This is because there is the possibility of damage by static electricity.)
- 4) To prevent AC leakage, the metal part of the soldering iron should be grounded.
- 5) Workers should be grounded by an armband ($1\text{M}\Omega$)
- 6) Care should be taken not to permit the laser pick-up to come in contact with clothing, in order to prevent static electricity changes in the clothing to escape from the armband.
- 7) The laser beam from the pick-up should NEVER be directly facing the eyes or bare skin.



CLEARING MALFUNCTION

You can reset your unit to initial status if malfunction occur(button malfunction, display, etc.).
Using a pointed good conductor(such as driver), simply short the RESET jump wire on the inside of the volume knob for more than 3 seconds.
If you reset your unit, you must reenter all its settings(stations, clock, timer)

NOTE: 1. To operate the RESET jump wire, pull the volume rotary knob and release it.
2. If you wish to operate the RESET jump wire, it is necessary to unplug the power cord.



ESD PRECAUTIONS

Electrostatically Sensitive Devices (ESD)

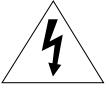
Some semiconductor (solid state) devices can be damaged easily by static electricity. Such components commonly are called electrostatically sensitive devices (ESD). Examples of typical ESD devices are integrated circuits and some field-effect transistors and semiconductor chip components. The following techniques should be used to help reduce the incidence of component damage caused by static electricity.

1. Immediately before handling any semiconductor component or semiconductor-equipped assembly, drain off any electrostatic charge on your body by touching a known earth ground. Alternatively, obtain and wear a commercially available discharging wrist strap device, which should be removed for potential shock reasons prior to applying power to the unit under test.
2. After removing an electrical assembly equipped with ESD devices, place the assembly on a conductive surface such as aluminum foil, to prevent electrostatic charge buildup or exposure of the assembly.
3. Use only a grounded-tip soldering iron to solder or unsolder ESD devices.
4. Use only an anti-static solder removal device. Some solder removal devices not classified as "anti-static" can generate electrical charges sufficient to damage ESD devices.
5. Do not use freon-propelled chemicals. These can generate electrical charges sufficient to damage ESD devices.
6. Do not remove a replacement ESD device from its protective package until immediately before you are ready to install it. (Most replacement ESD devices are packaged with leads electrically shorted together by conductive foam, aluminum foil or comparable conductive materials).
7. Immediately before removing the protective material from the leads of a replacement ESD device, touch the protective material to the chassis or circuit assembly into which the device will be installed.

CAUTION : BE SURE NO POWER IS APPLIED TO THE CHASSIS OR CIRCUIT, AND OBSERVE ALL OTHER SAFETY PRECAUTIONS.

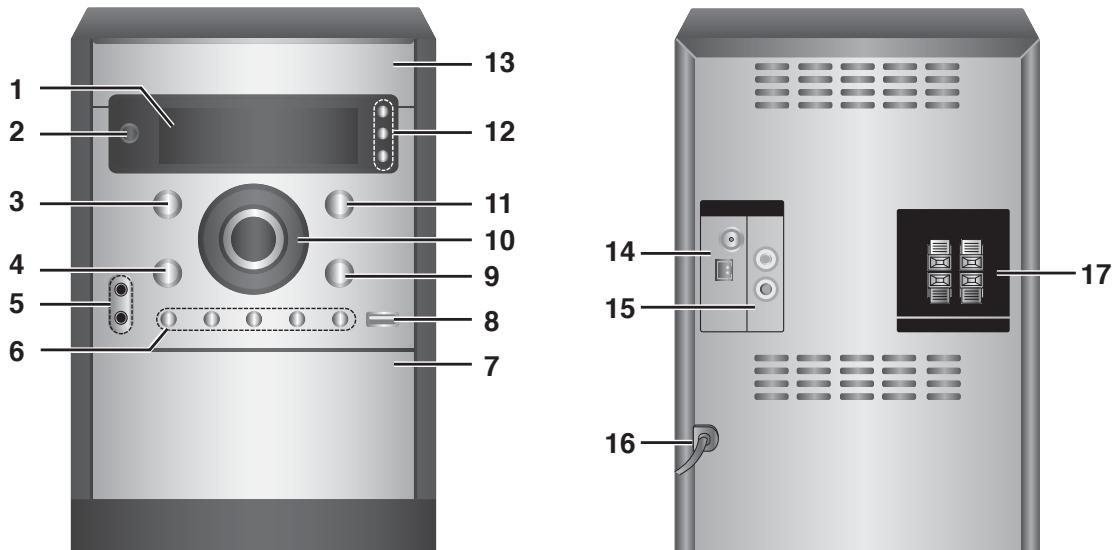
8. Minimize bodily motions when handing unpackaged replacement ESD devices. (Otherwise harmless motion such as the brushing together of your clothes fabric or the lifting of your foot from a carpeted floor can generate static electricity sufficient to damage an ESD device).

[CAUTION. GRAPHIC SYMBOLS]

	THE LIGHTNING FLASH WITH ARROWHEAD SYMBOL, WITHIN AN EQUILATERAL TRIANGLE, IS INTENDED TO ALERT THE SERVICE PERSONNEL TO THE PRESENCE OF UNINSULATED "DANGEROUS VOLTAGE" THAT MAY BE OF SUFFICIENT MAGNITUDE TO CONSTITUTE A RISK OF ELECTRIC SHOCK.
	THE EXCLAMATION POINT WITHIN AN EQUILATERAL TRIANGLE IS INTENDED TO ALERT THE SERVICE PERSONNEL TO THE PRESENCE OF IMPORTANT SAFETY INFORMATION IN SERVICE LITERATURE.

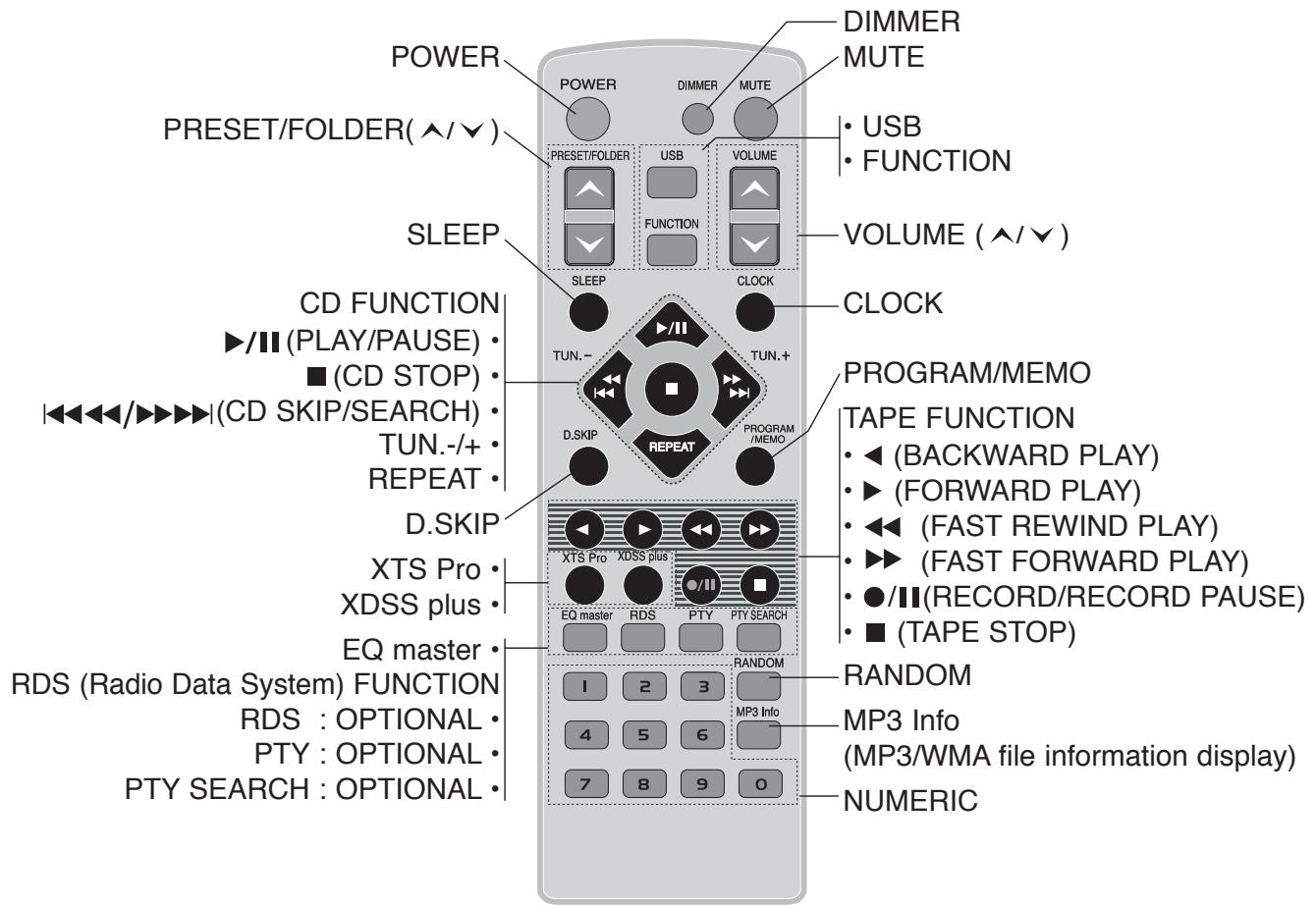
LOCATION OF USERS CONTROLS

FRONT / BACK PANEL



1. DISPLAY WINDOW
2. \odot/I (POWER)
3. $\blacktriangleleft/\text{II}$ PLAY(PAUSE)
4. • $\blacktriangleleft\blacktriangleleft$ (CD SKIP/SEARCH)
 ($\blacktriangleleft\blacktriangleleft$ FAST REWIND PLAY)
5. • PORT.IN jack
 • \cap (Headphone jack) : ø3.5mm
6. • FUNCTION
 (FM, AM, CD, USB, AUX, PORTABLE, TAPE)
 • XDSS plus
 • PLAY MODE/ST./MONO
 • CD SYNC
 • Δ CD OPEN (DEMO)
7. PUSH EJECT position
8. $\leftarrow\rightarrow$ (USB connector)
9. • $\blacktriangleright\blacktriangleright\blacktriangleright$ (CD SKIP/SEARCH)
 ($\blacktriangleright\blacktriangleright\blacktriangleright$ FAST FORWARD PLAY)
10. VOLUME CONTROL KNOB
11. ■ STOP
12. • TIMER
 • CLOCK
 • SET (RDS - OPTIONAL)
13. DISC TRAY
14. AM/FM ANTENNA TERMINAL
15. AUX IN (AUXILIARY INPUT) connector
16. POWER IN (POWER CORD)
17. SPEAKER TERMINAL

REMOTE CONTROL



SPECIFICATIONS

• GENERAL

Power supply	Refer to the back panel of the unit.
Power consumption	Refer to the back panel of the unit.
Net Weight	3.4kg
External dimensions (WxHxD)	170 x 243 x 282mm

• TUNER

FM	Tuning Range Intermediate Frequency Signal to Noise Ratio Frequency Response	87.5 ~ 108.0MHz or 65 ~ 74MHz, 87.5 ~ 108.0MHz 10.7MHz 60/55dB (MONO/STEREO) 50 ~ 10000Hz
AM	Tuning Range Intermediate Frequency Signal to Noise Ratio Frequency Response	522 ~ 1620kHz or 520 ~ 1720kHz 450kHz 30dB 140 ~ 1800Hz

• AMPLIFIER

Output Power	30W + 30W
T.H.D	0.5%
Frequency Response	40 ~ 20000Hz
Signal-to-noise ratio	75dB

• CD

Frequency response	40 ~ 20000Hz
Signal-to-noise ratio	75dB
Dynamic range	75dB

• CASSETTE TAPE PLAYER

Tape Speed	3000 ± 3% (MTT-111. NORMAL-SPEED)
Wow Flutter	0.25% (MTT-111, JIS-WTD)
F.F/REW Time	120sec (C-60)
Frequency Response	250 ~ 8000Hz
Signal to Noise Ratio	43dB
Channel Separation	45dB (P/B) / 45dB (R/P)
Erase Ratio	50dB (MTT-5511)

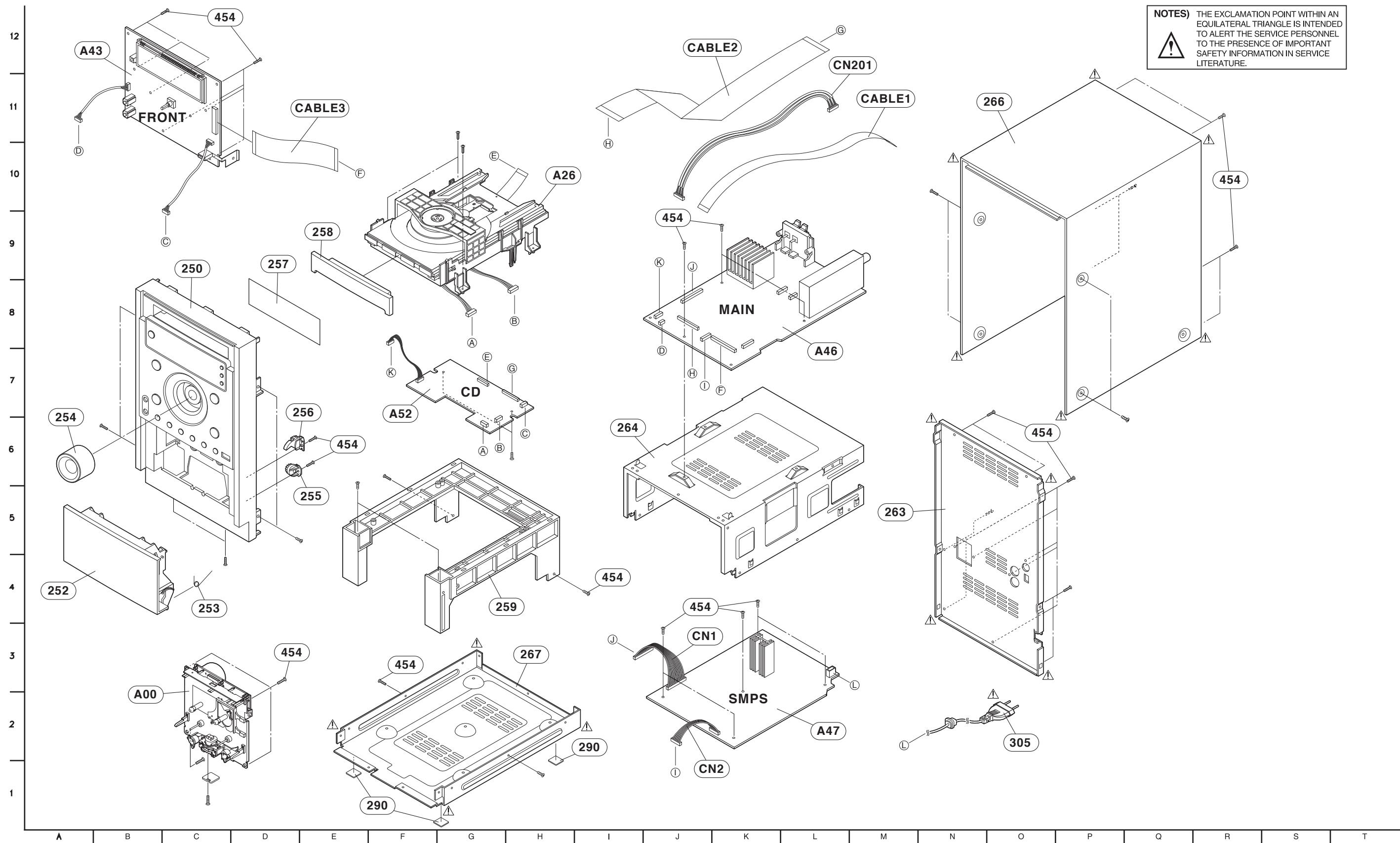
• SPEAKERS

Type	1Way 1Speaker
Impedance	4Ω
Frequency Response	75 ~ 17000Hz
Sound Pressure Level	83dB/W (1m)
Rated Input Power	30W
Max. Input Power	60W
Net Dimensions (WxHxD)	144 x 243 x 171mm
Net Weight (1EA)	1.47kg

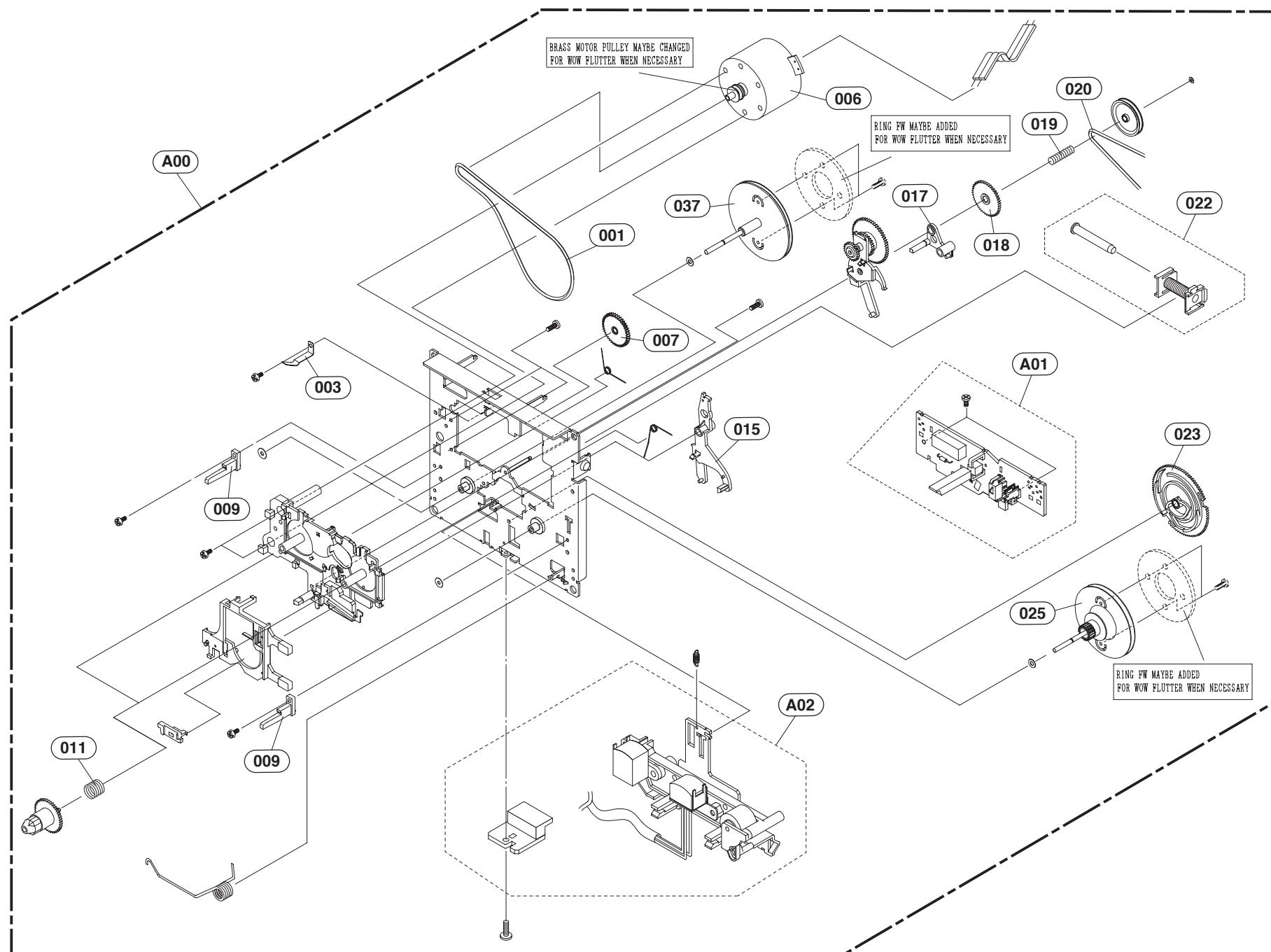
MEMO

SECTION 2 EXPLODED VIEWS

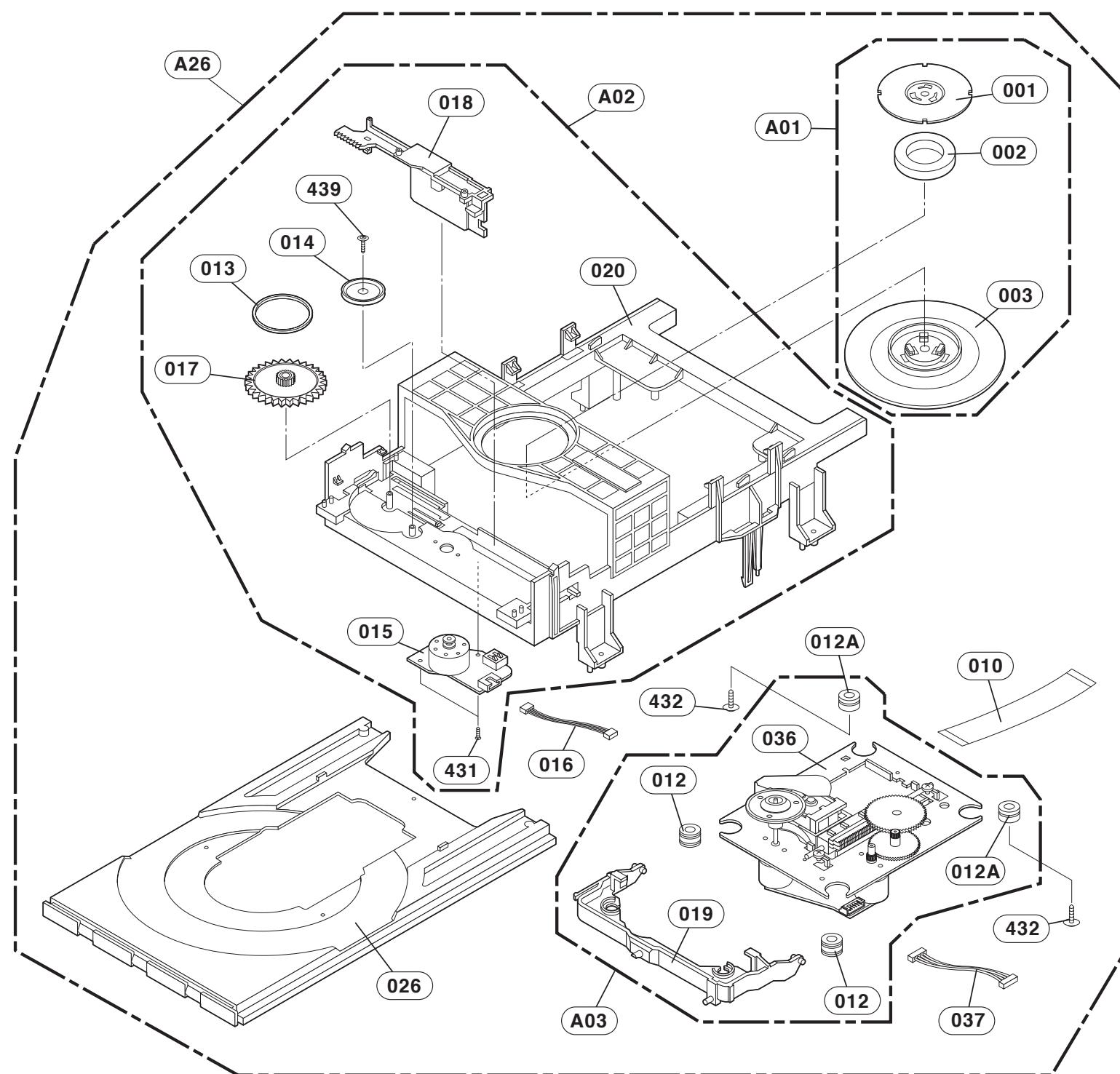
CABINET EXPLODED VIEW



TAPE DECK MECHANISM (SINGLE DECK) EXPLODED VIEW

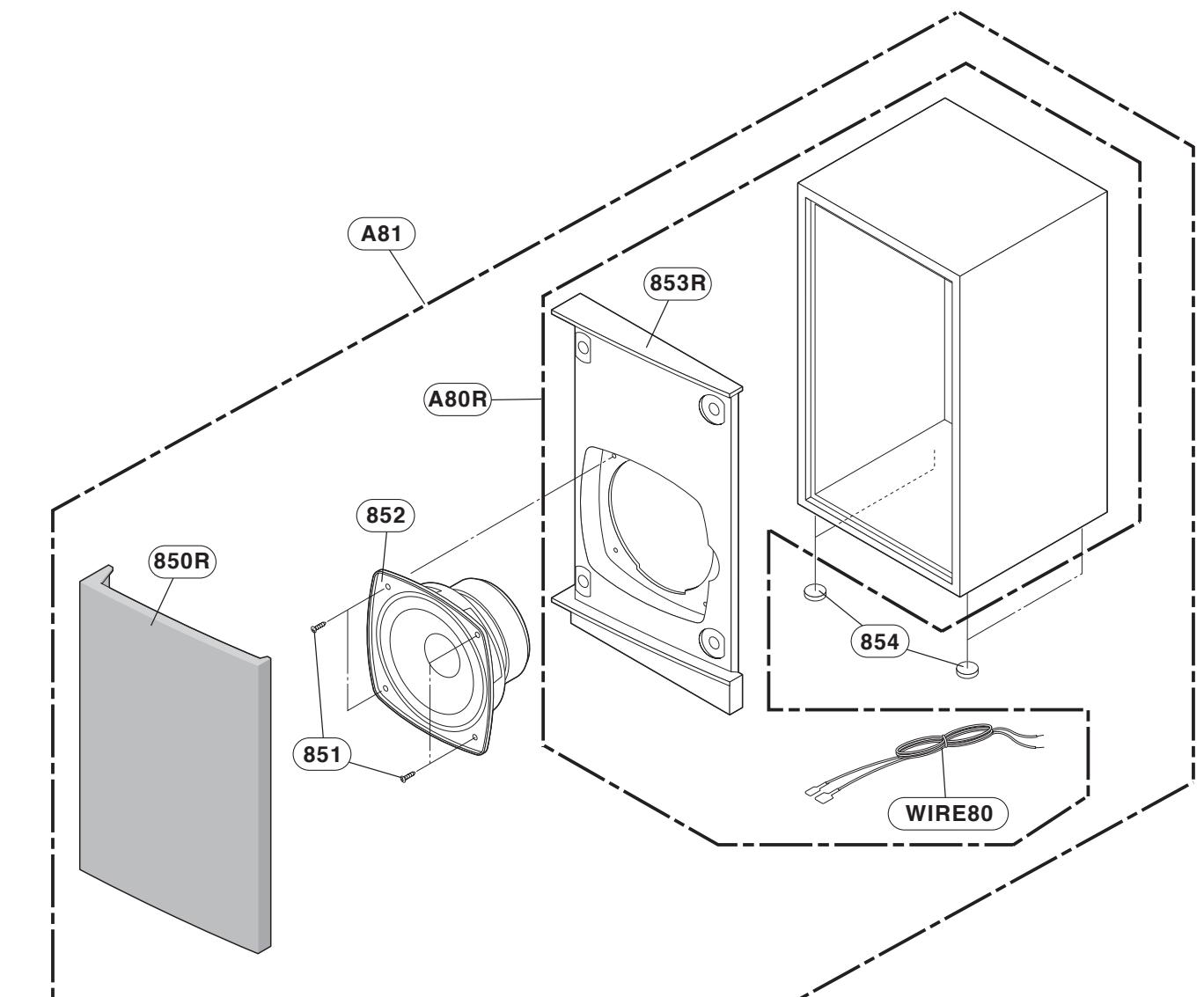
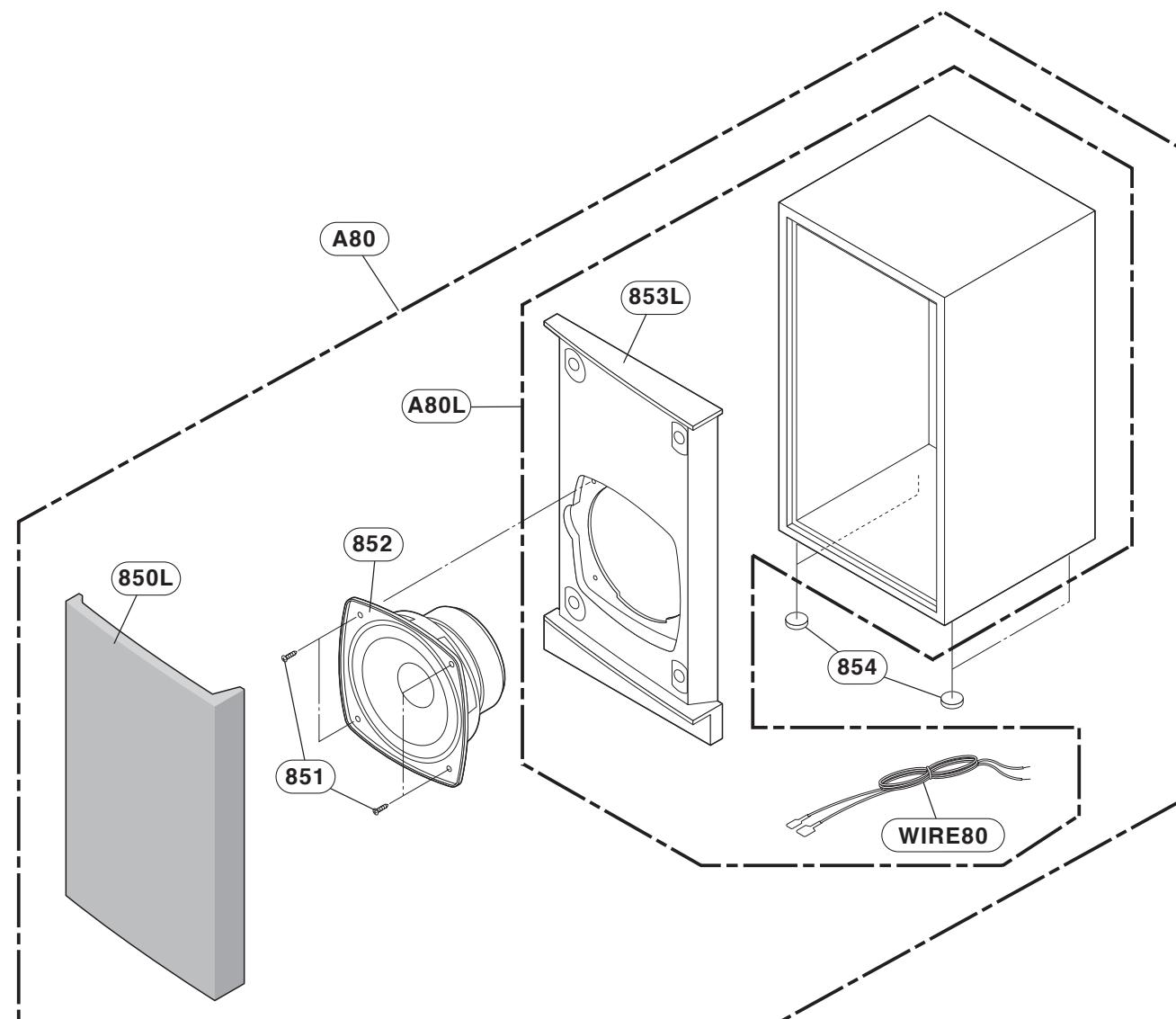


CD MECHANISM (CDM-330) EXPLODED VIEW

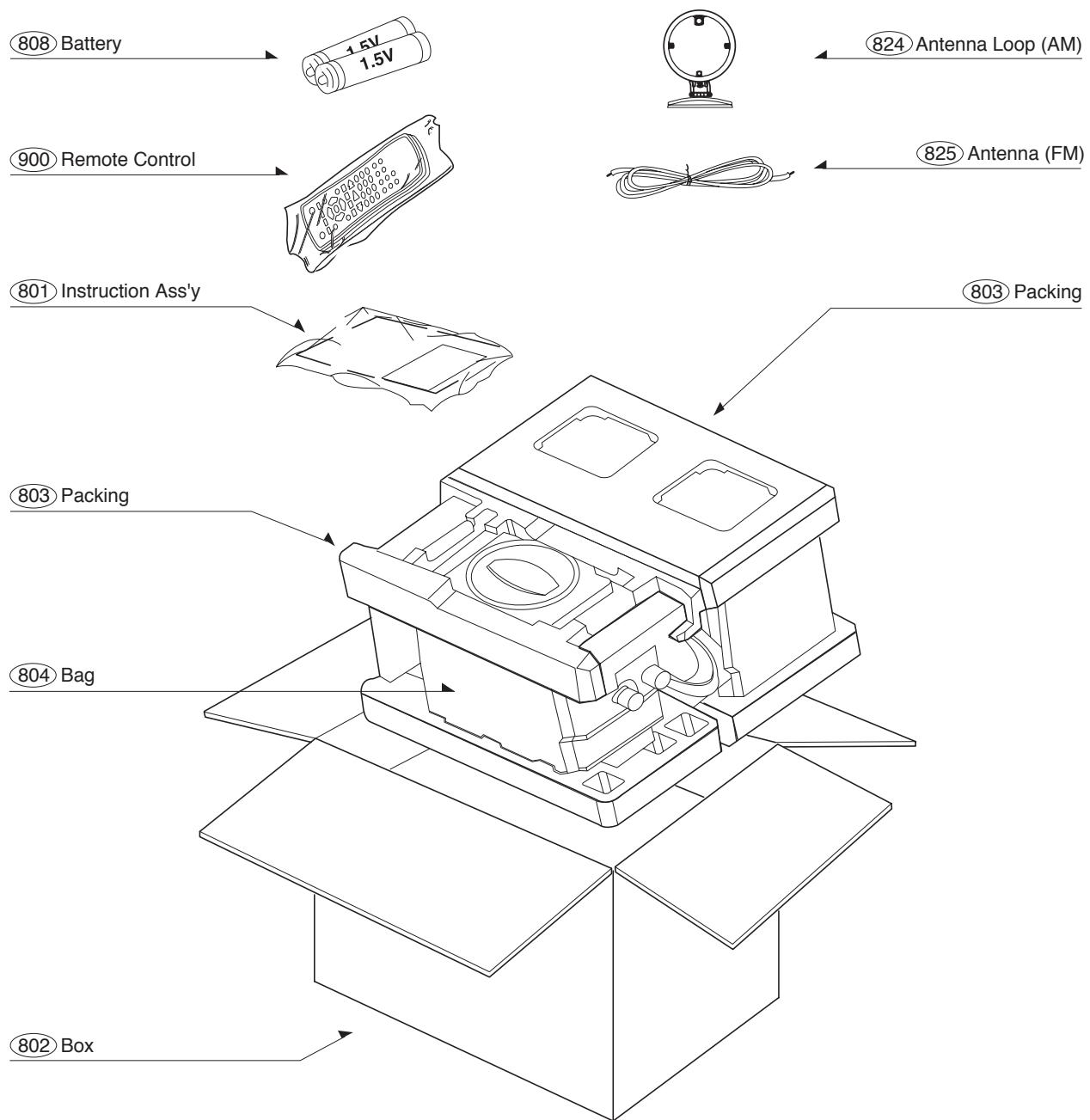


SPEAKER EXPLODED VIEW

MODEL : XCS62F



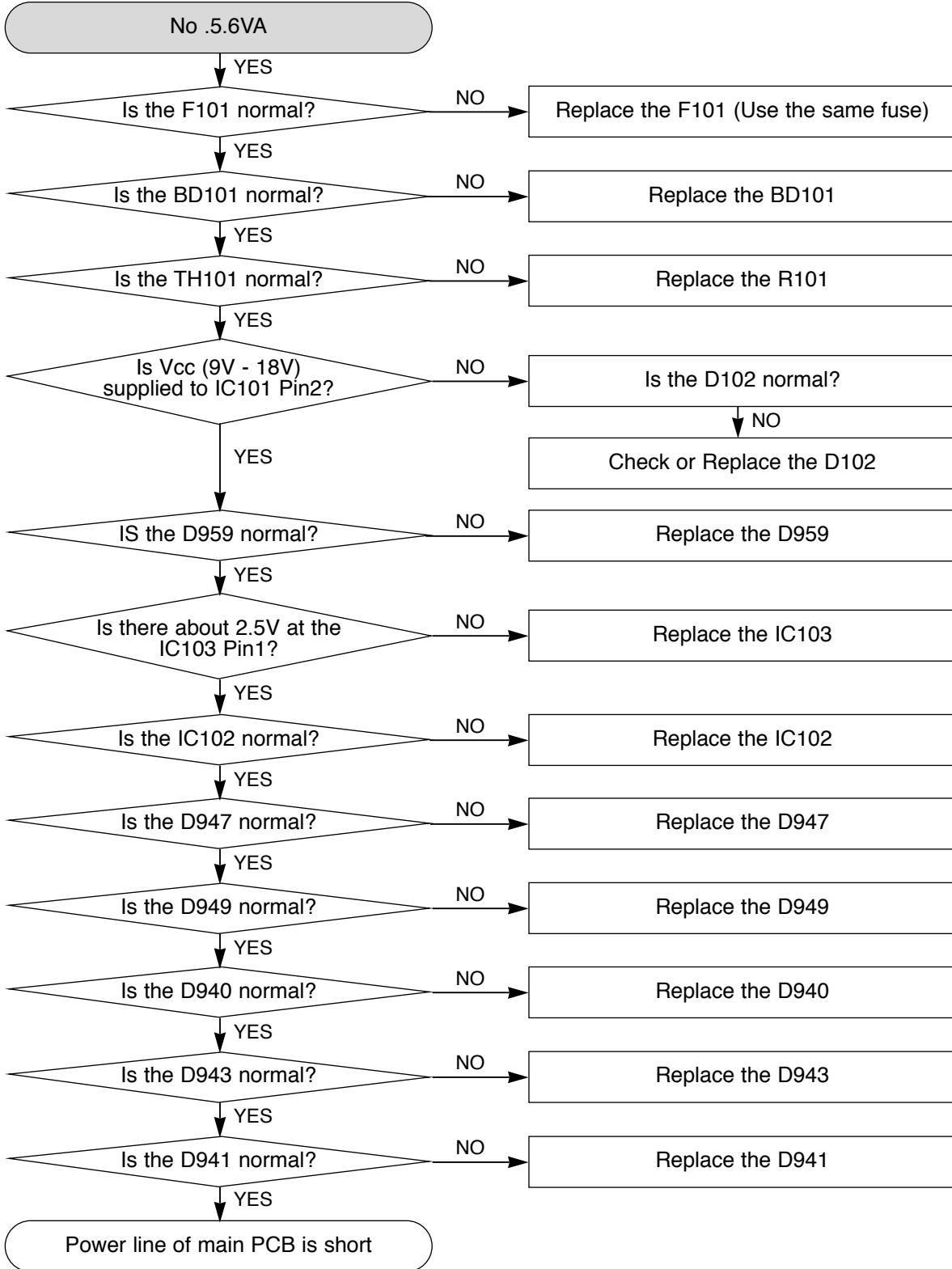
PACKING ACCESSORY VIEW

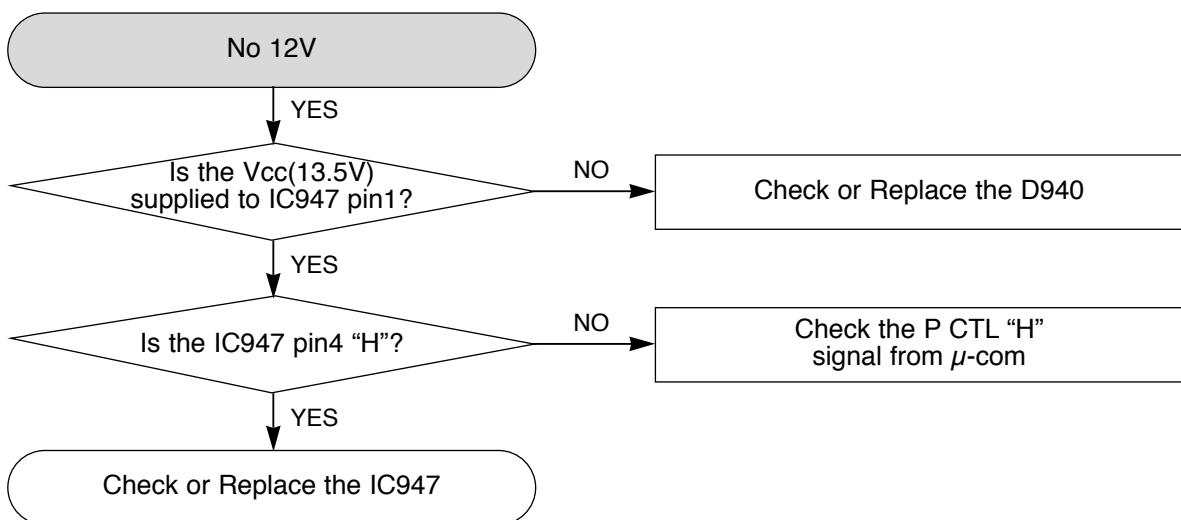
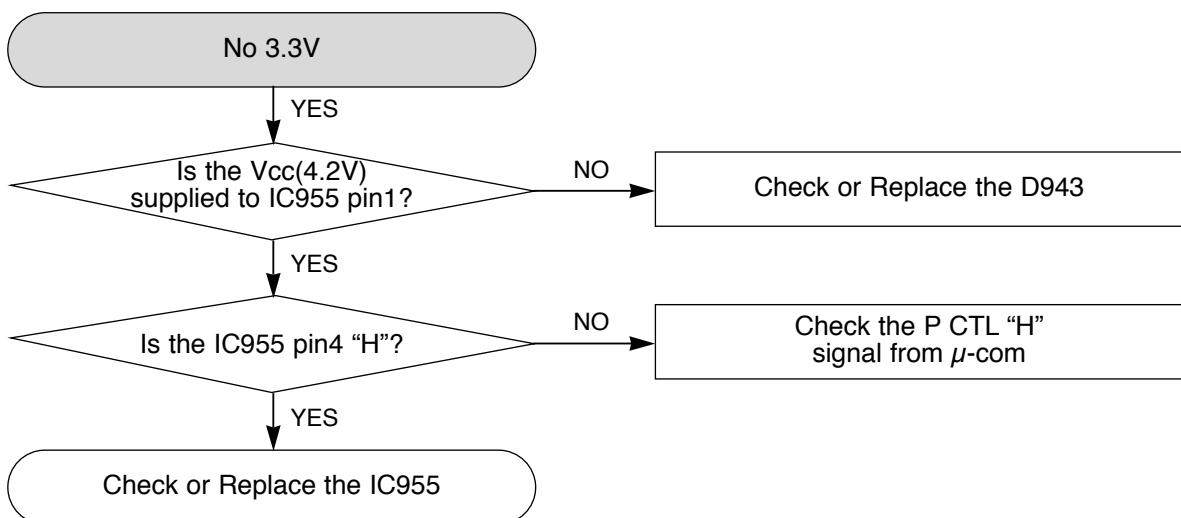
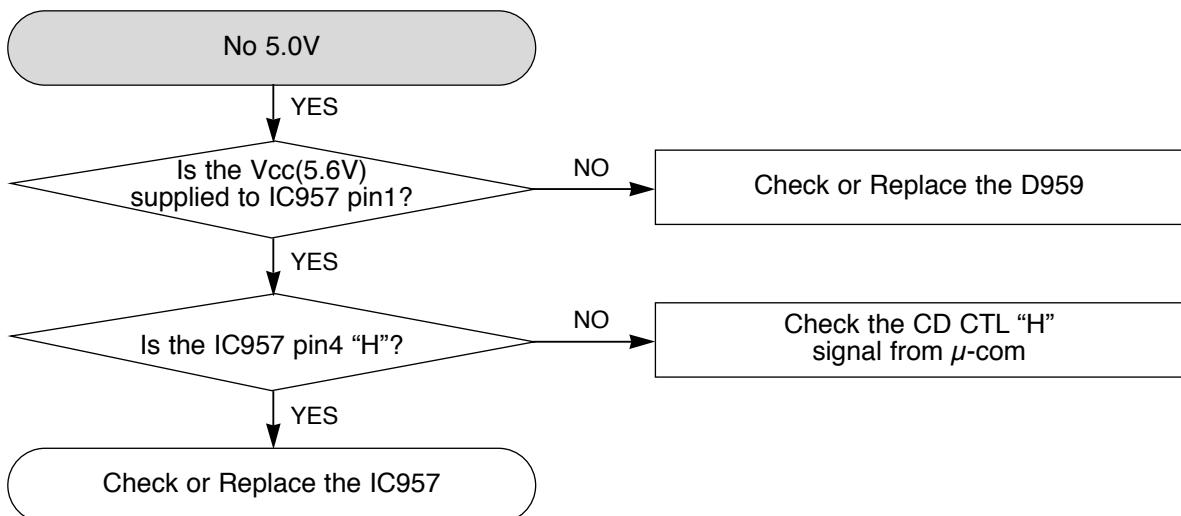


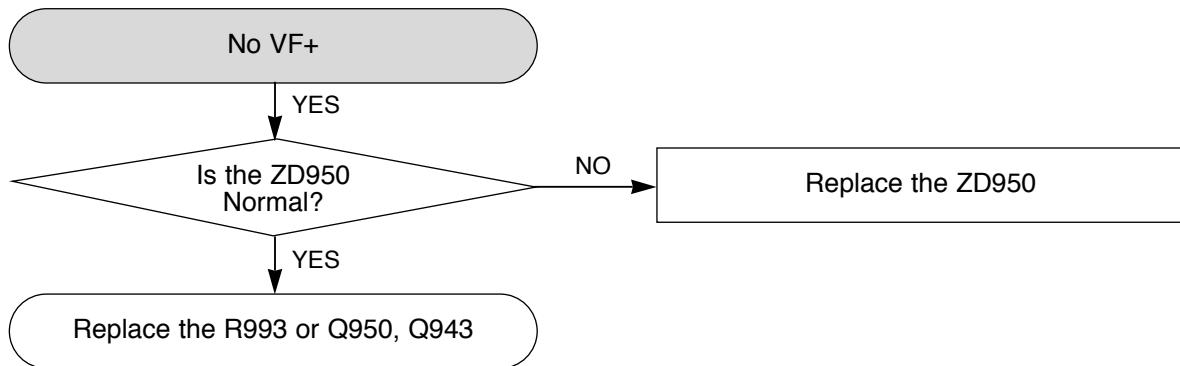
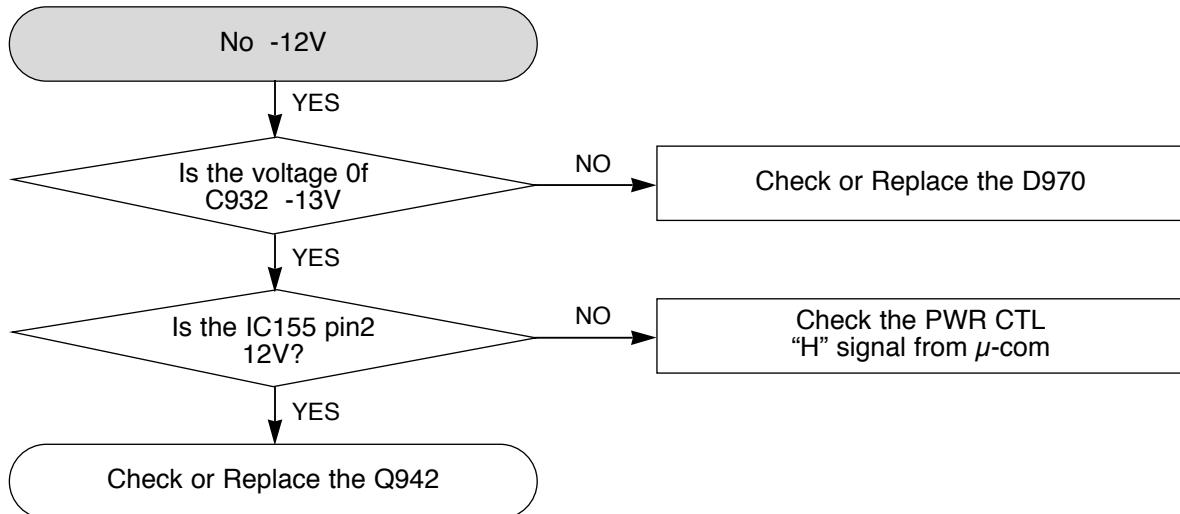
SECTION 3 AUDIO PART ELECTRICAL

AUDIO ELECTRICAL TROUBLESHOOTING GUIDE

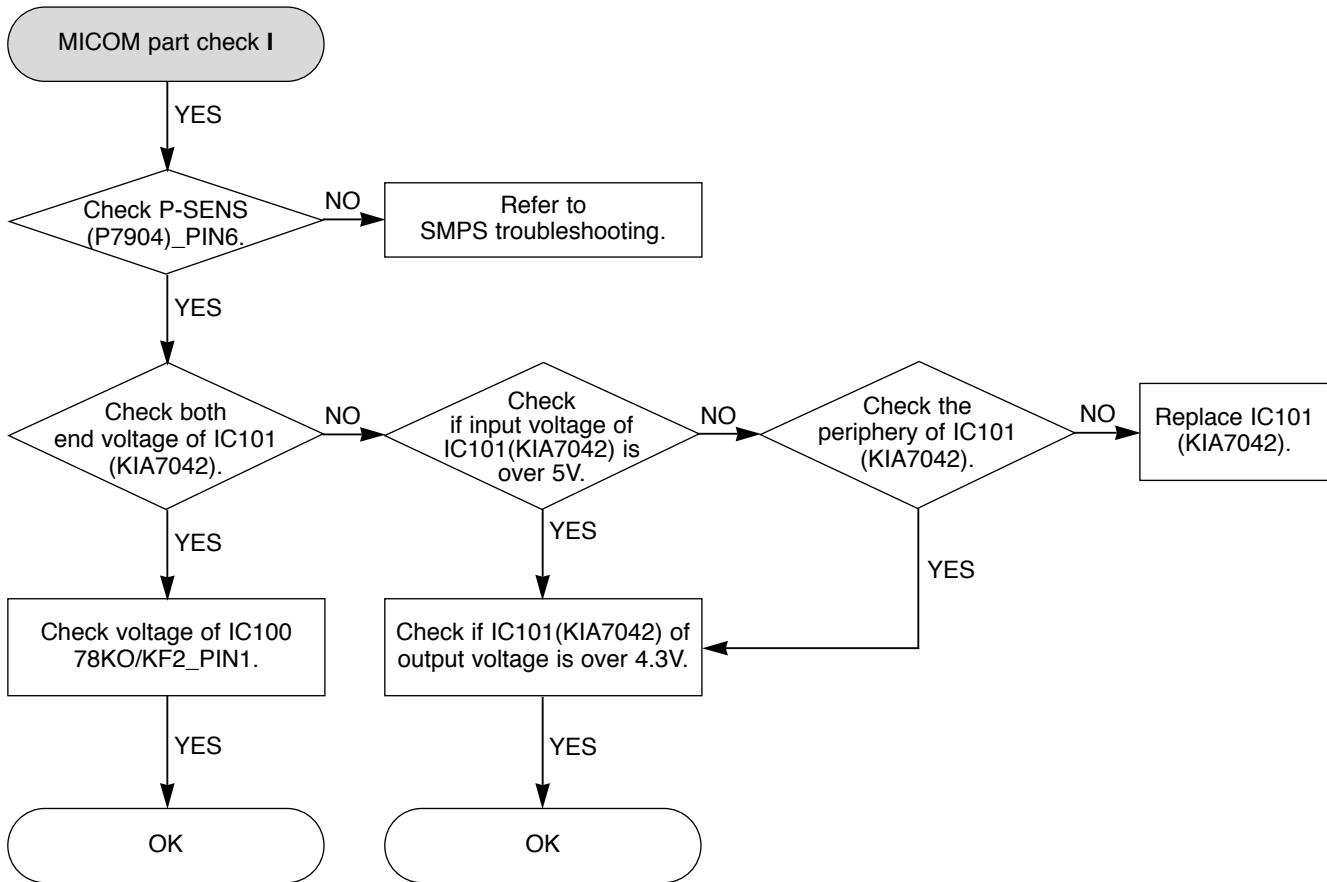
1. POWER (SMPS)



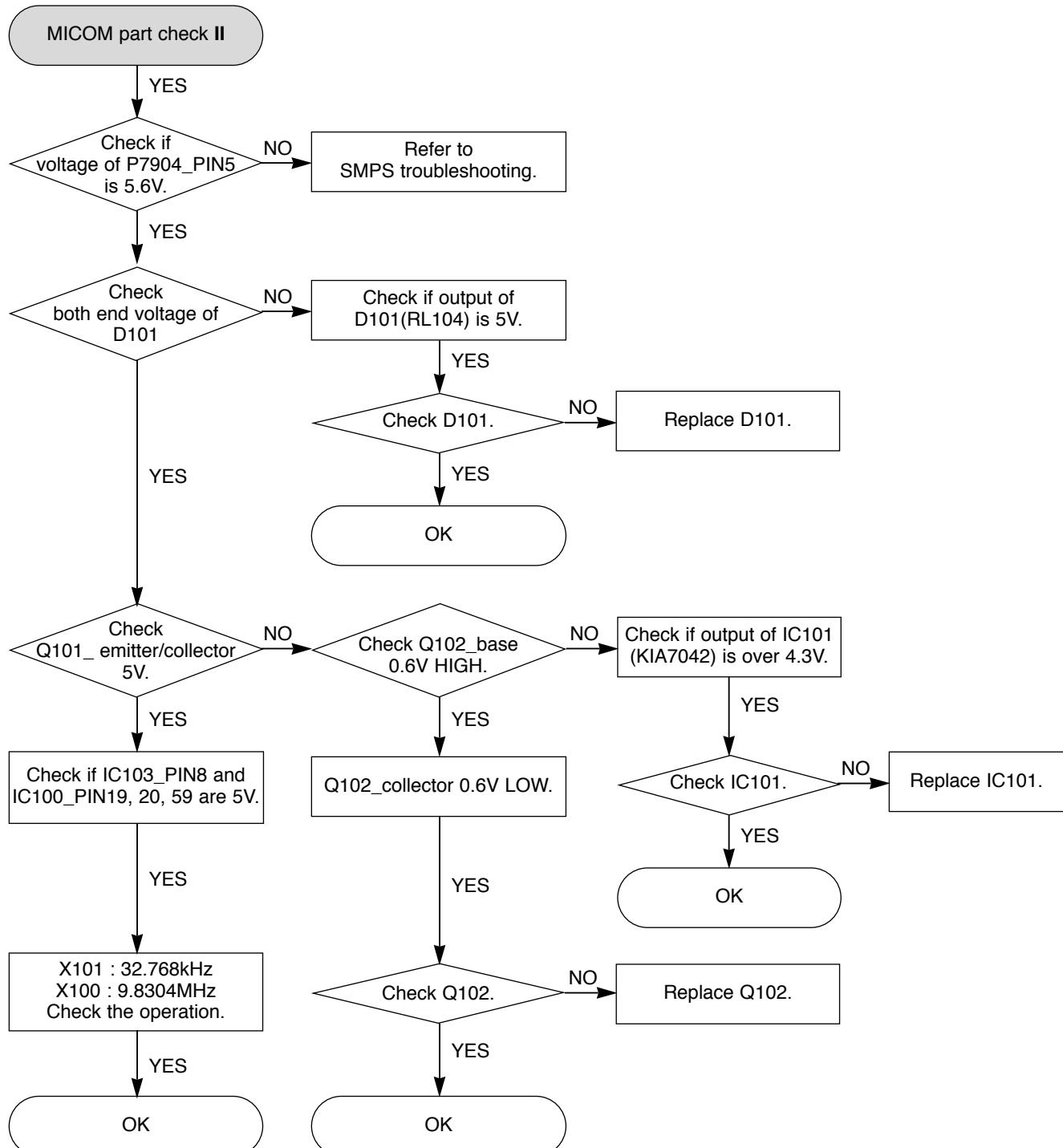




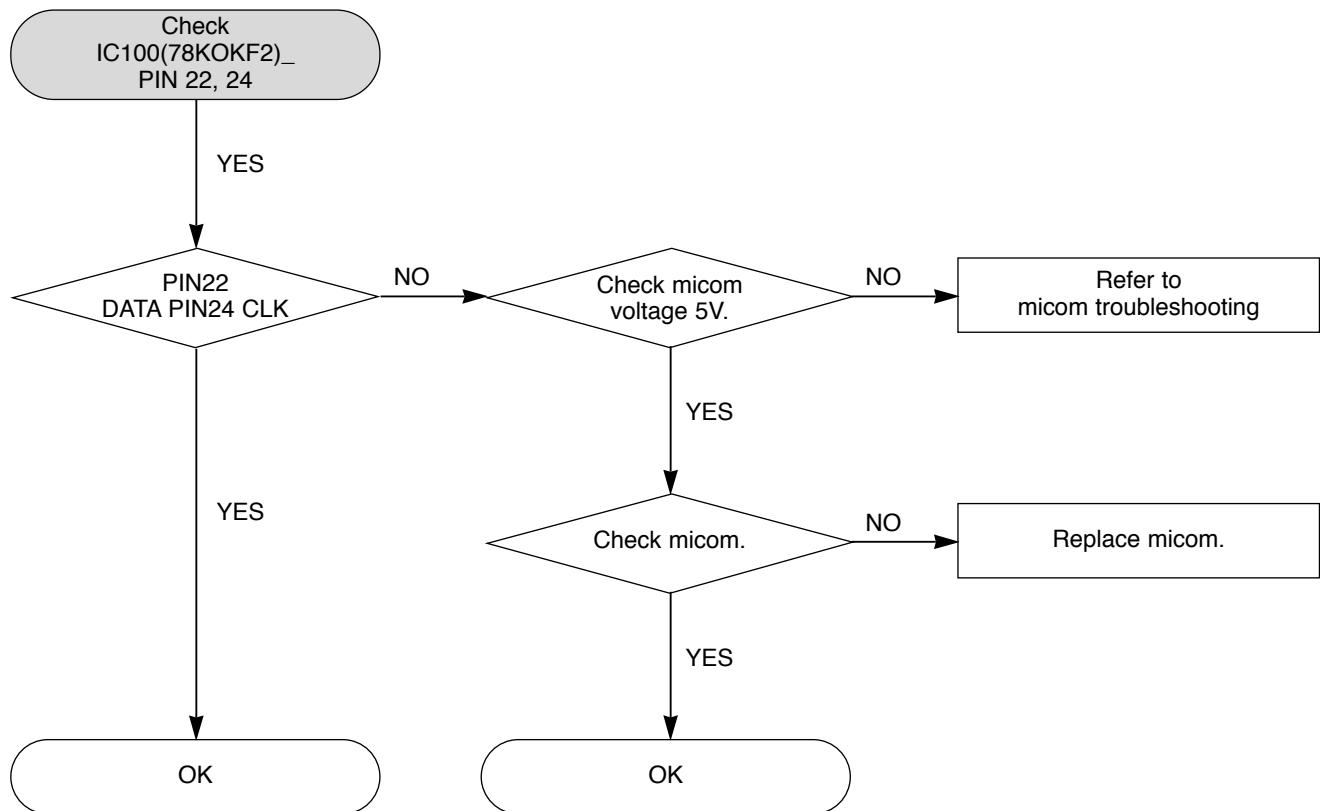
2. MICOM PART CHECK I



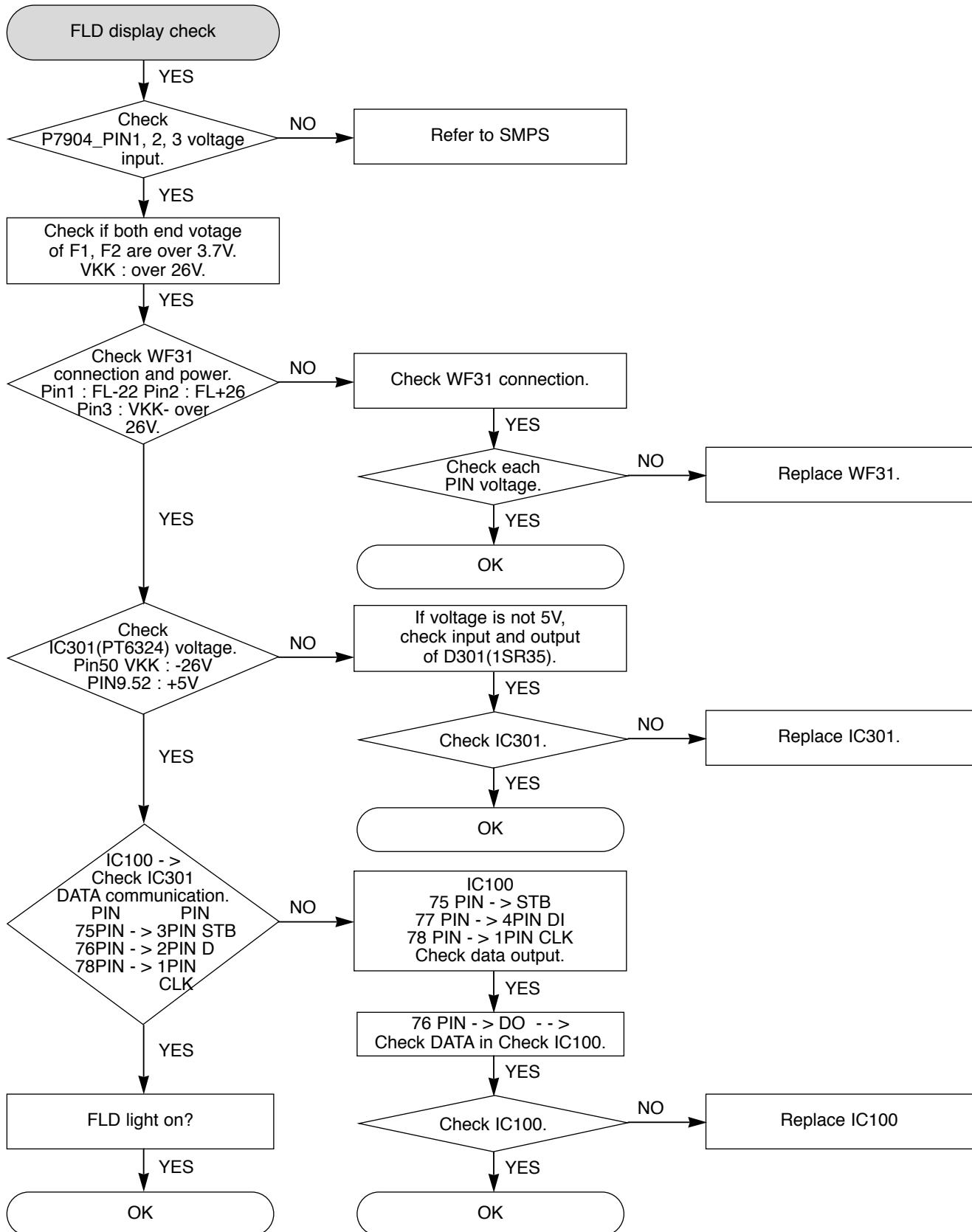
3. MICOM PART CHECK II



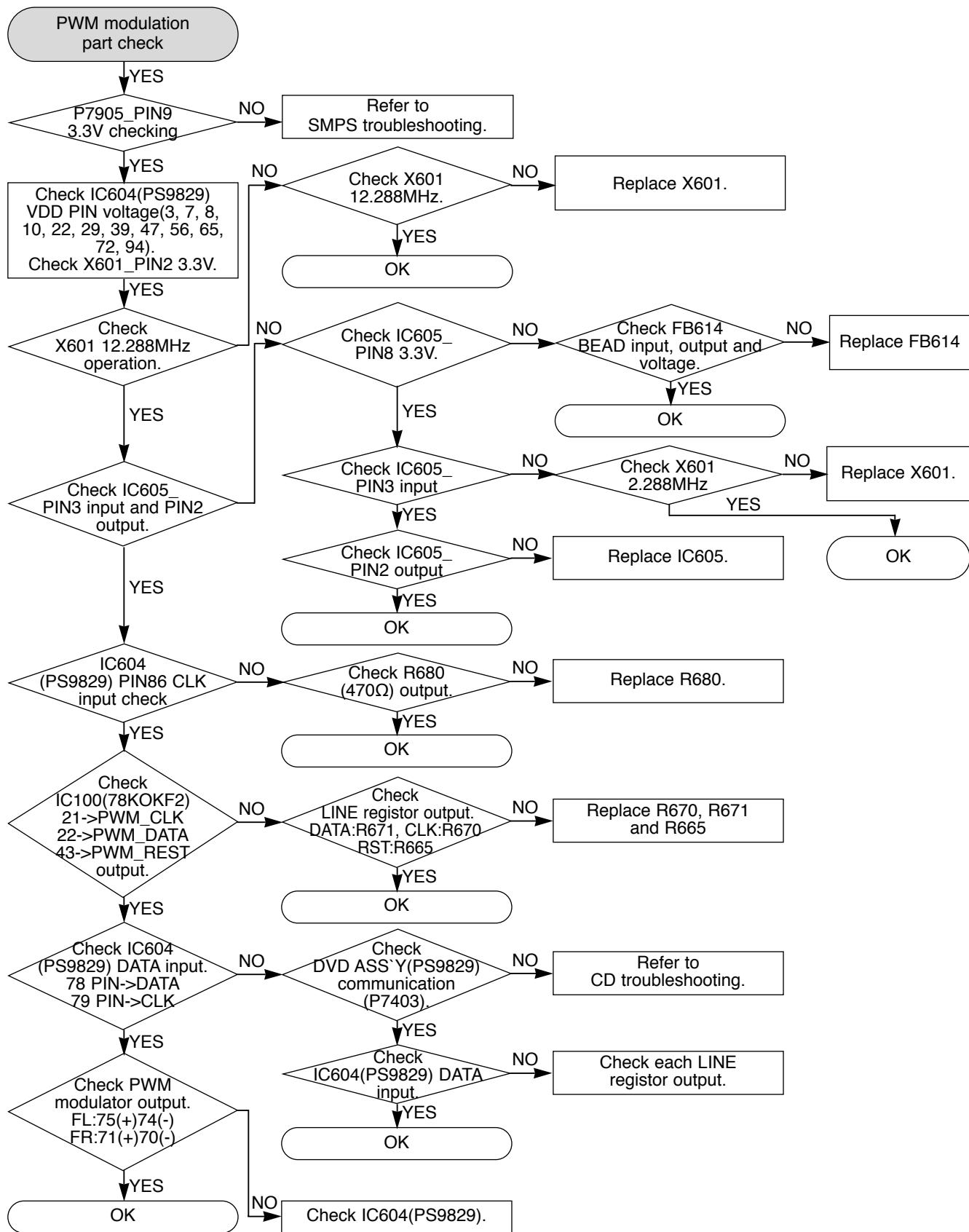
4. IC103(KS4CD21CS) CHECK



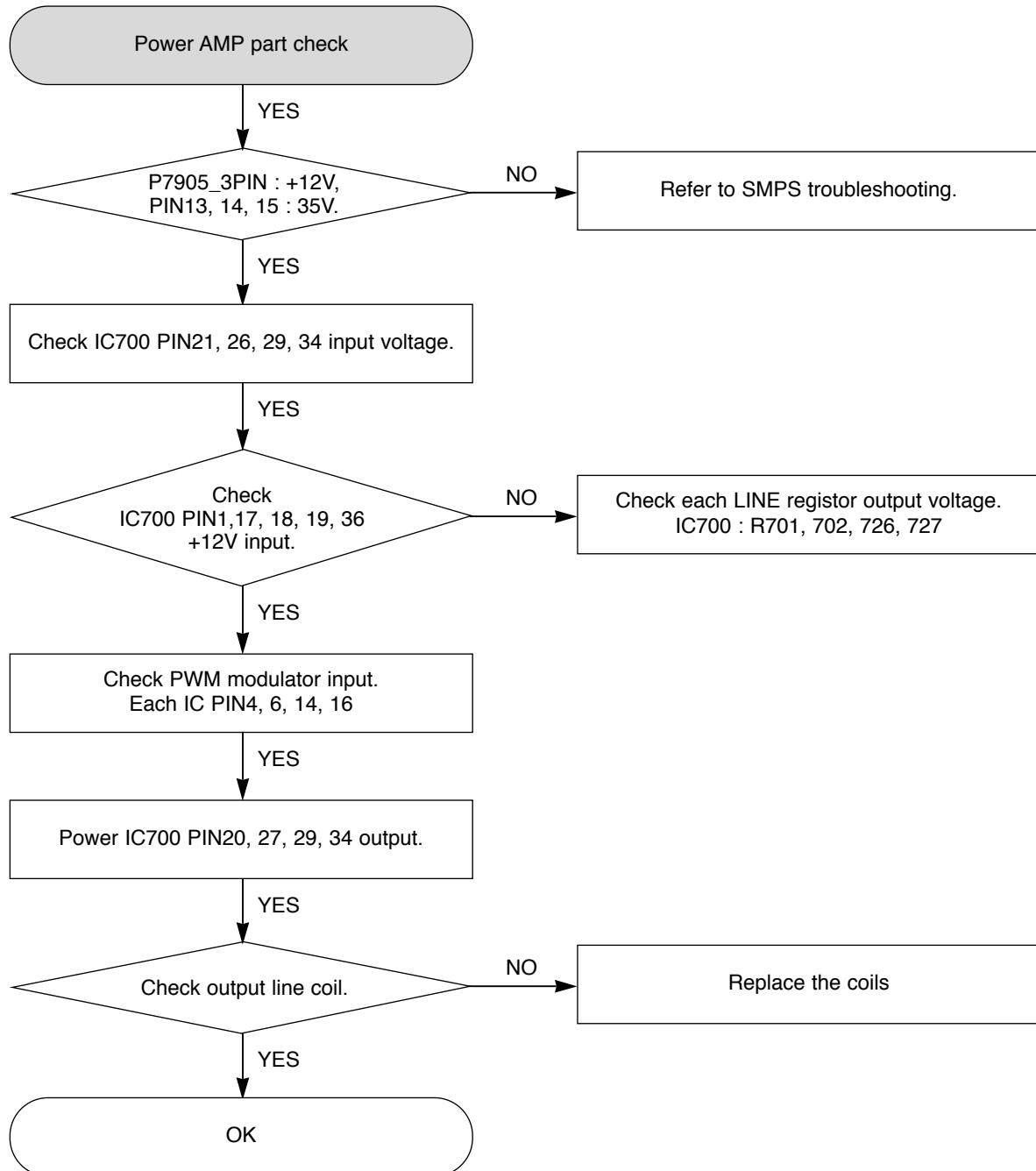
5. FLD DISPLAY CHECK



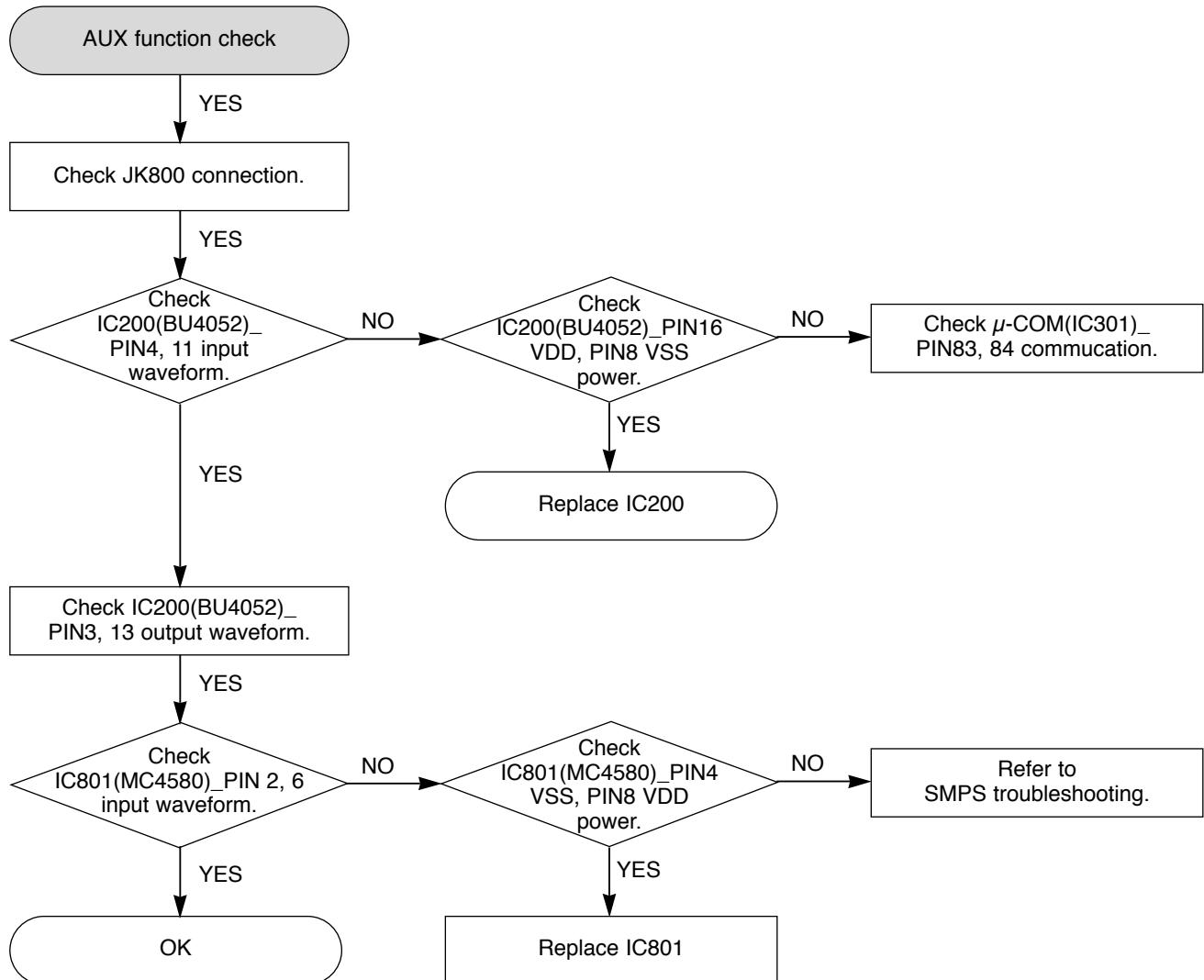
6. PWM MODULATION PART CHECK



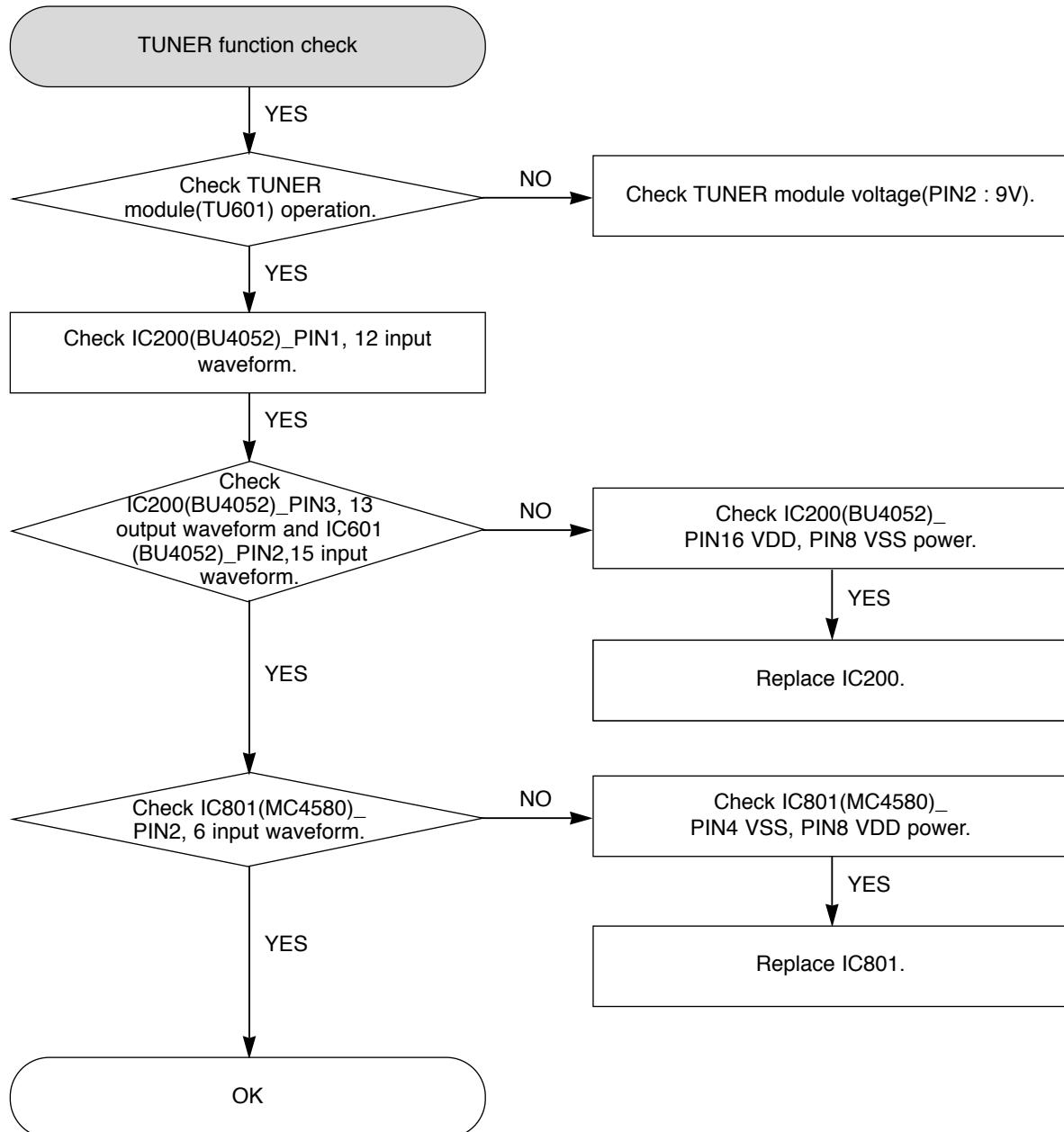
7. POWER AMP PART CHECK



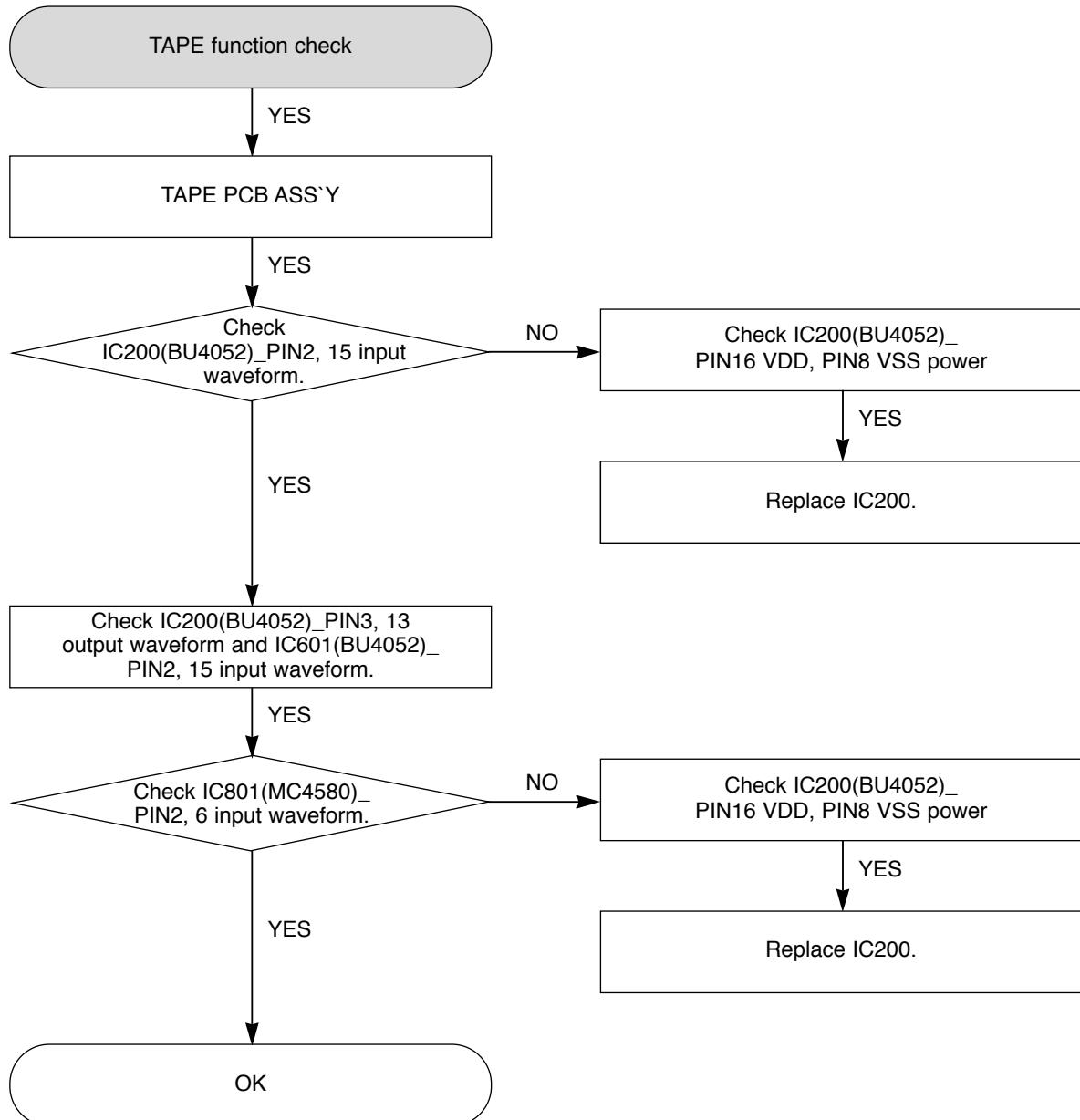
8. AUX FUNCTION CHECK



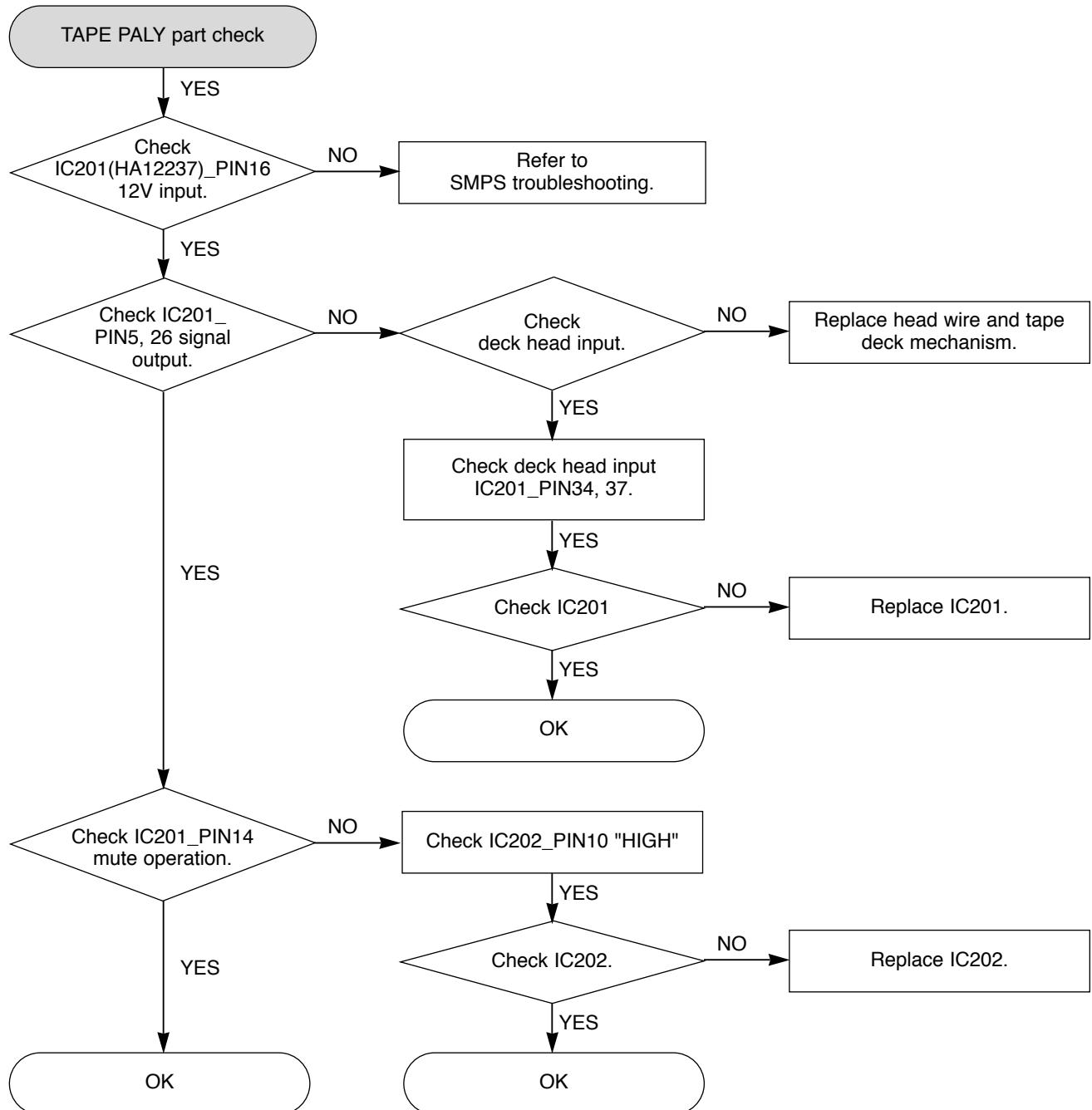
9. TUNER FUNCTION CHECK



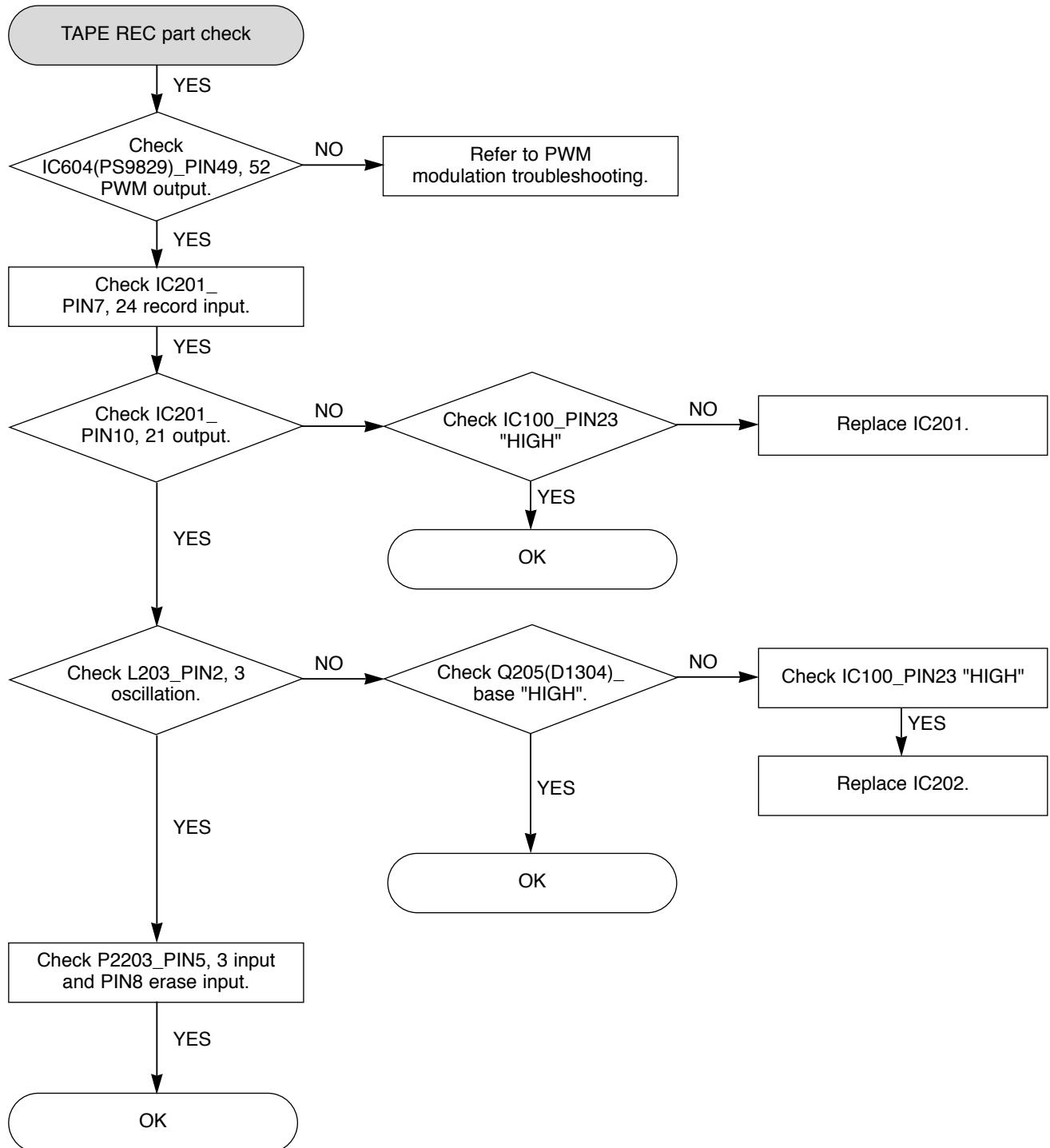
10. TAPE FUNCTION CHECK



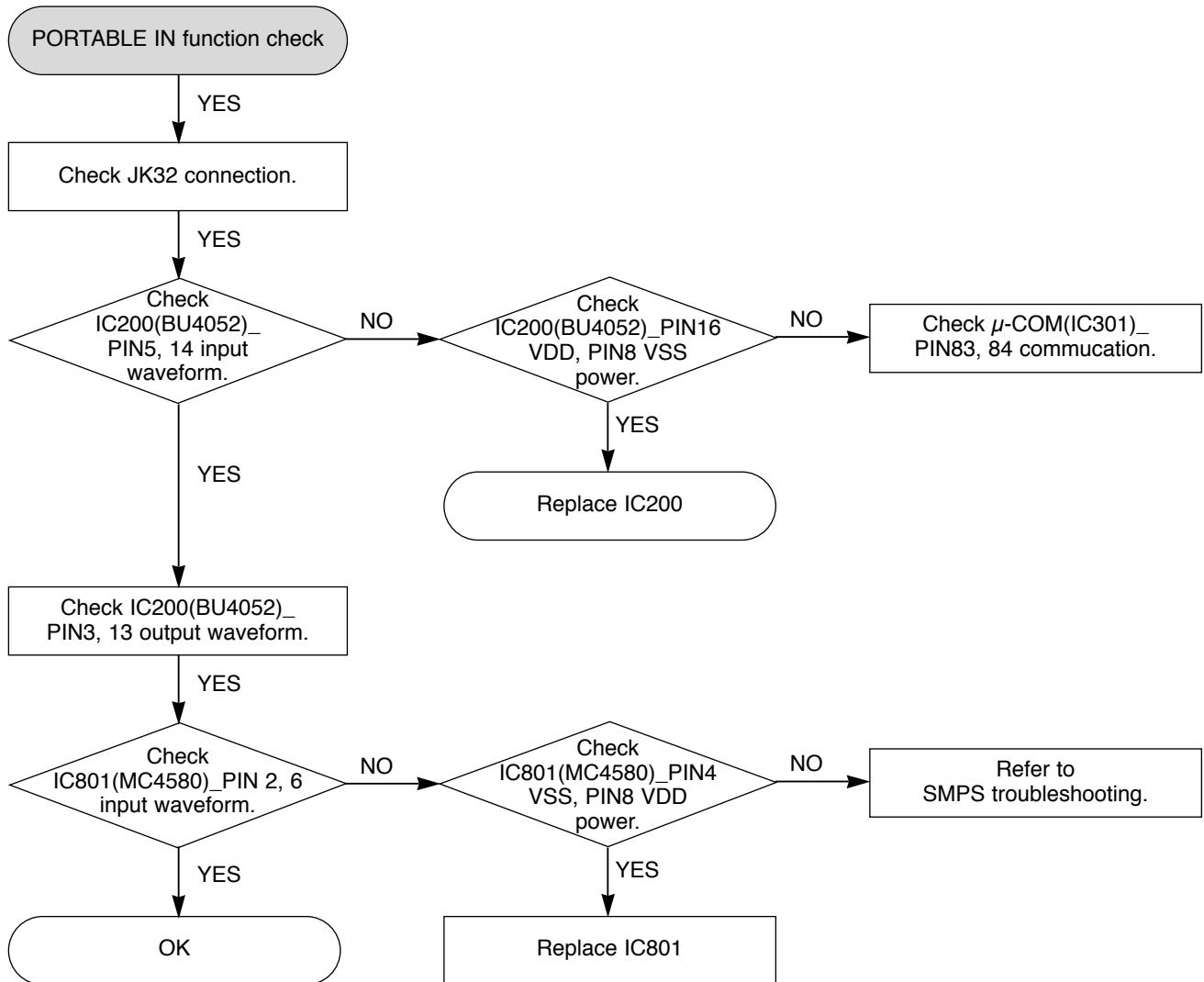
11. TAPE PLAY PART CHECK



12. TAPE REC PART CHECK

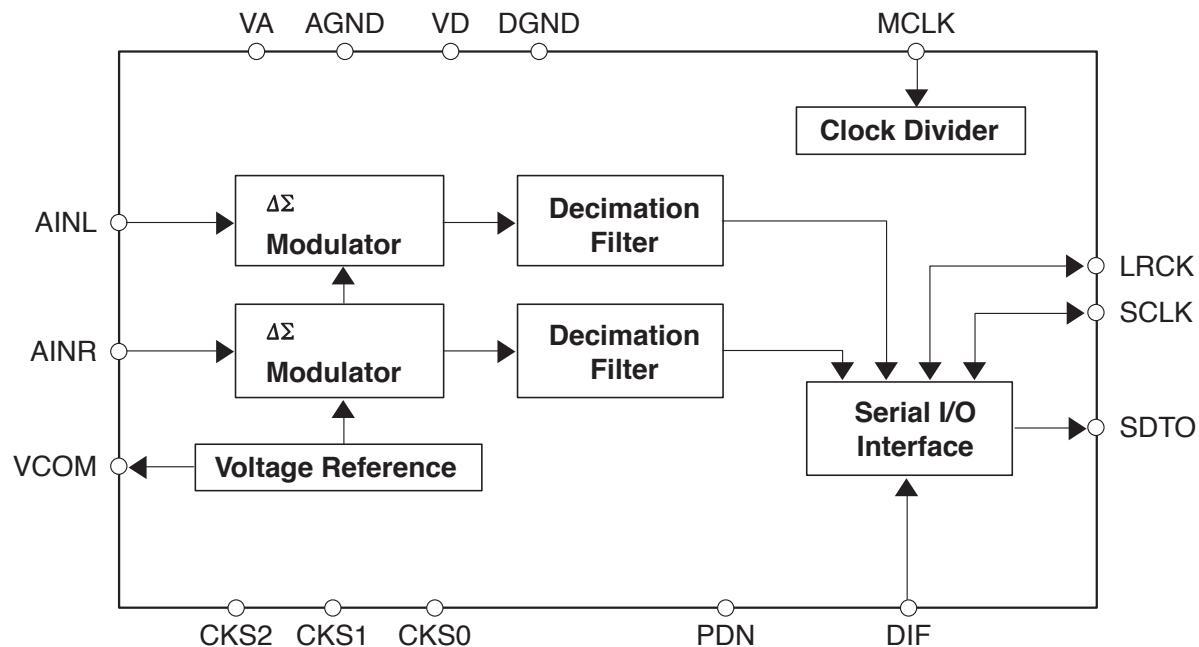


13. PORTABLE IN FUNCTION CHECK

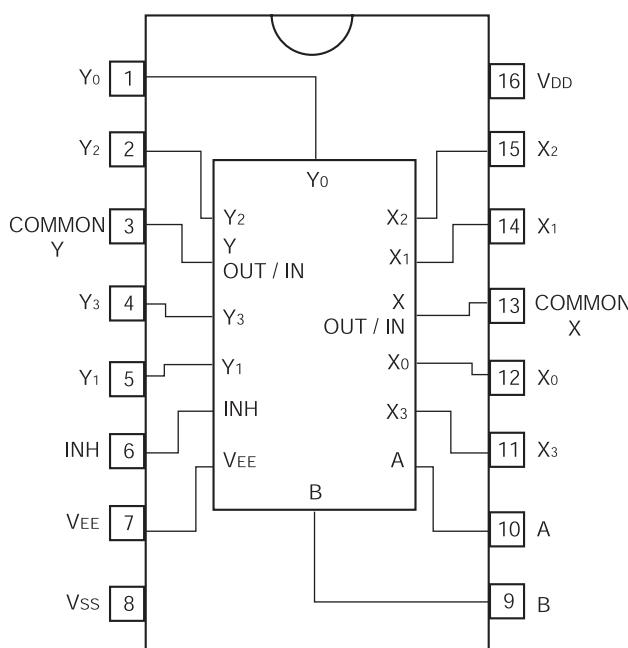


INTERNAL BLOCK DIAGRAM OF ICs

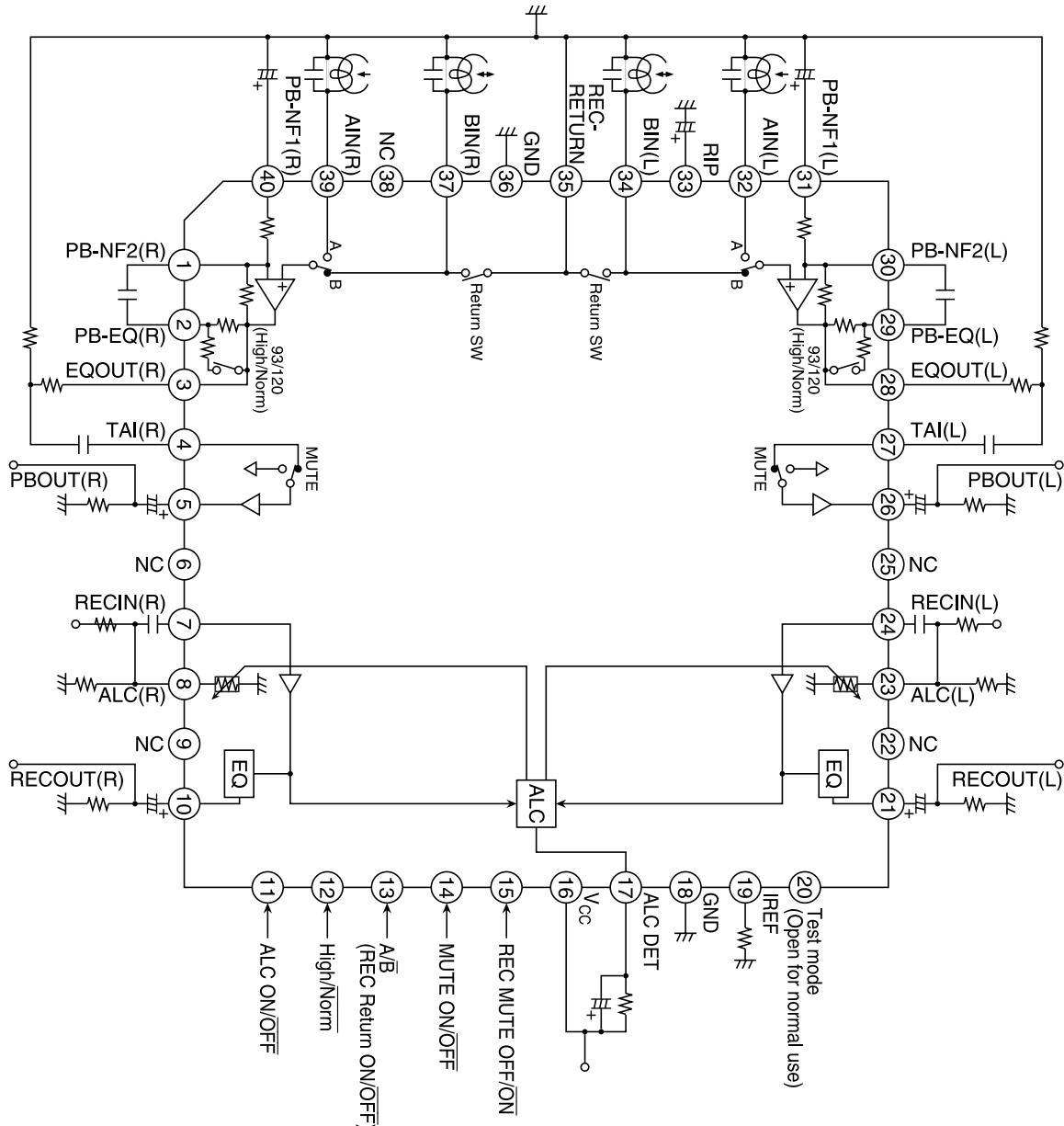
1. AK5358



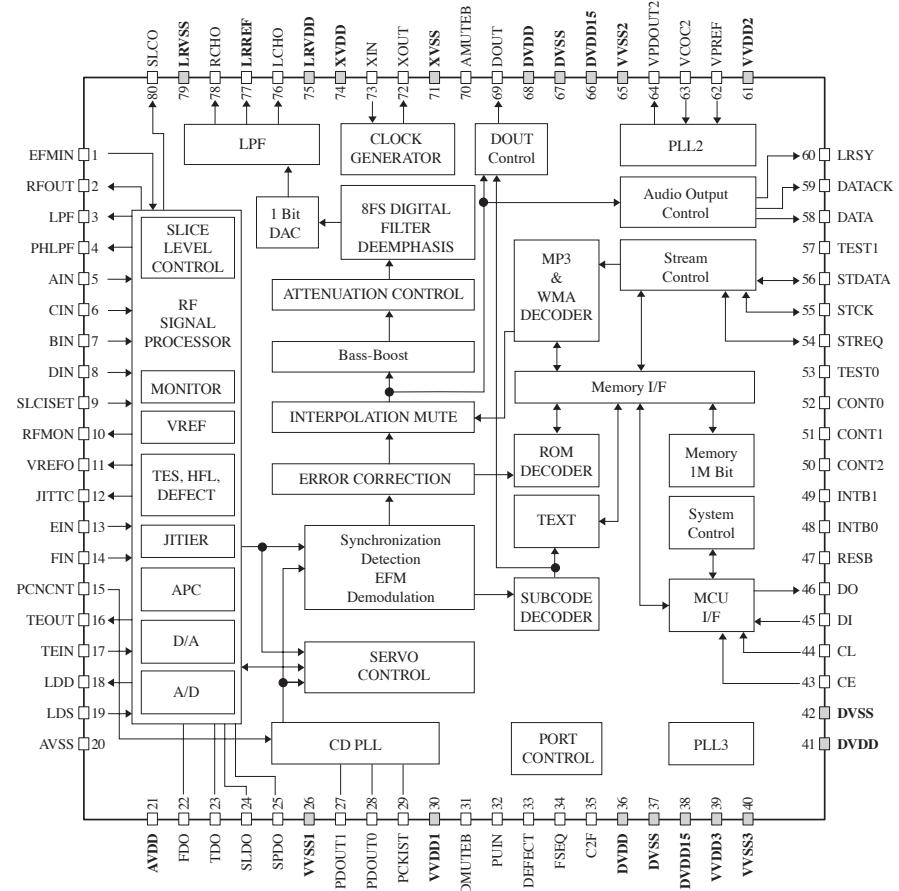
2. BU4052



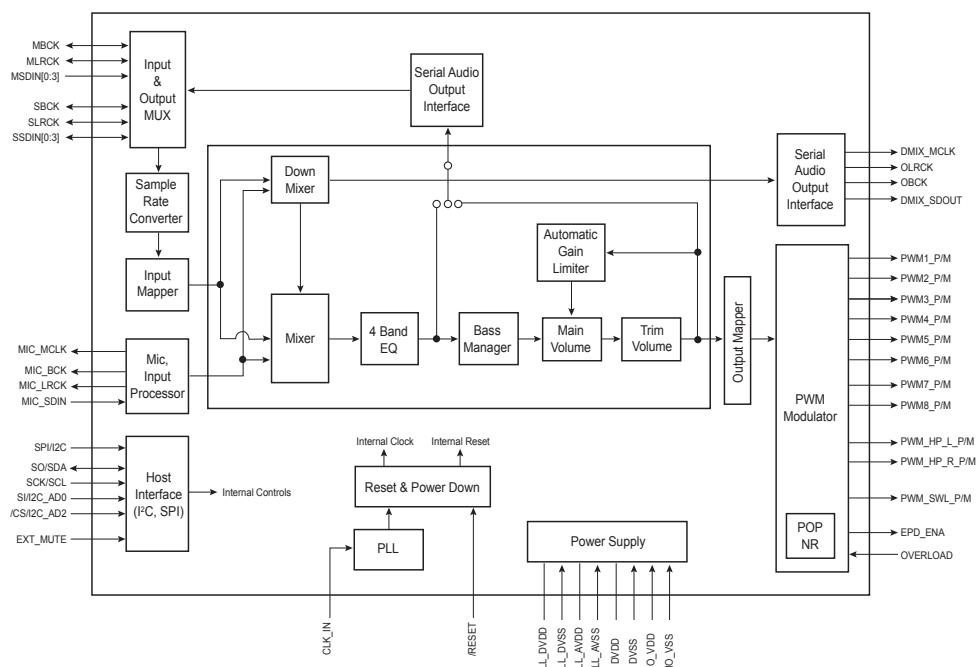
3. HA12237F



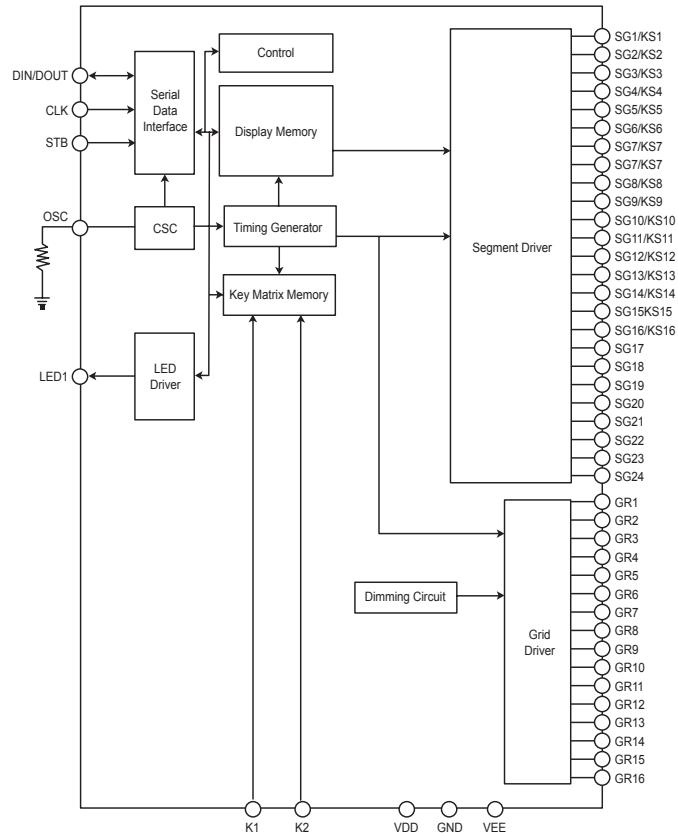
4. LC78692NW



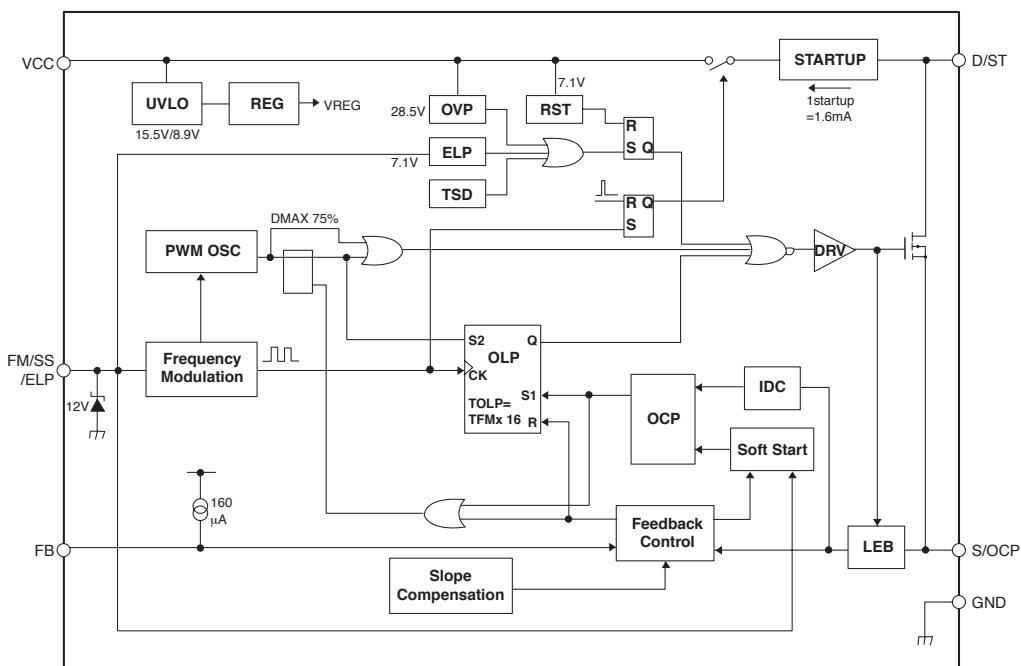
5. PS9829B



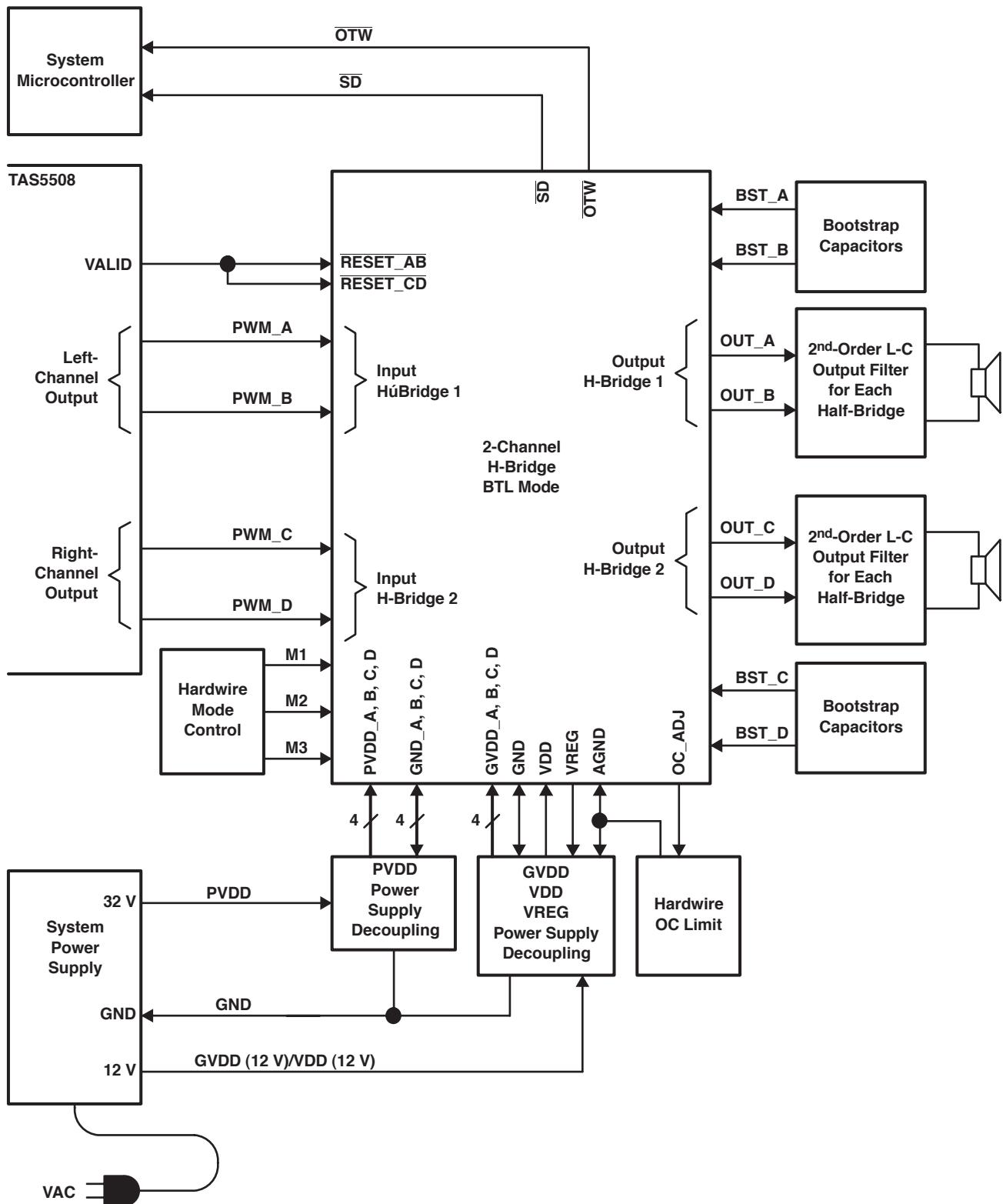
6. PT6324



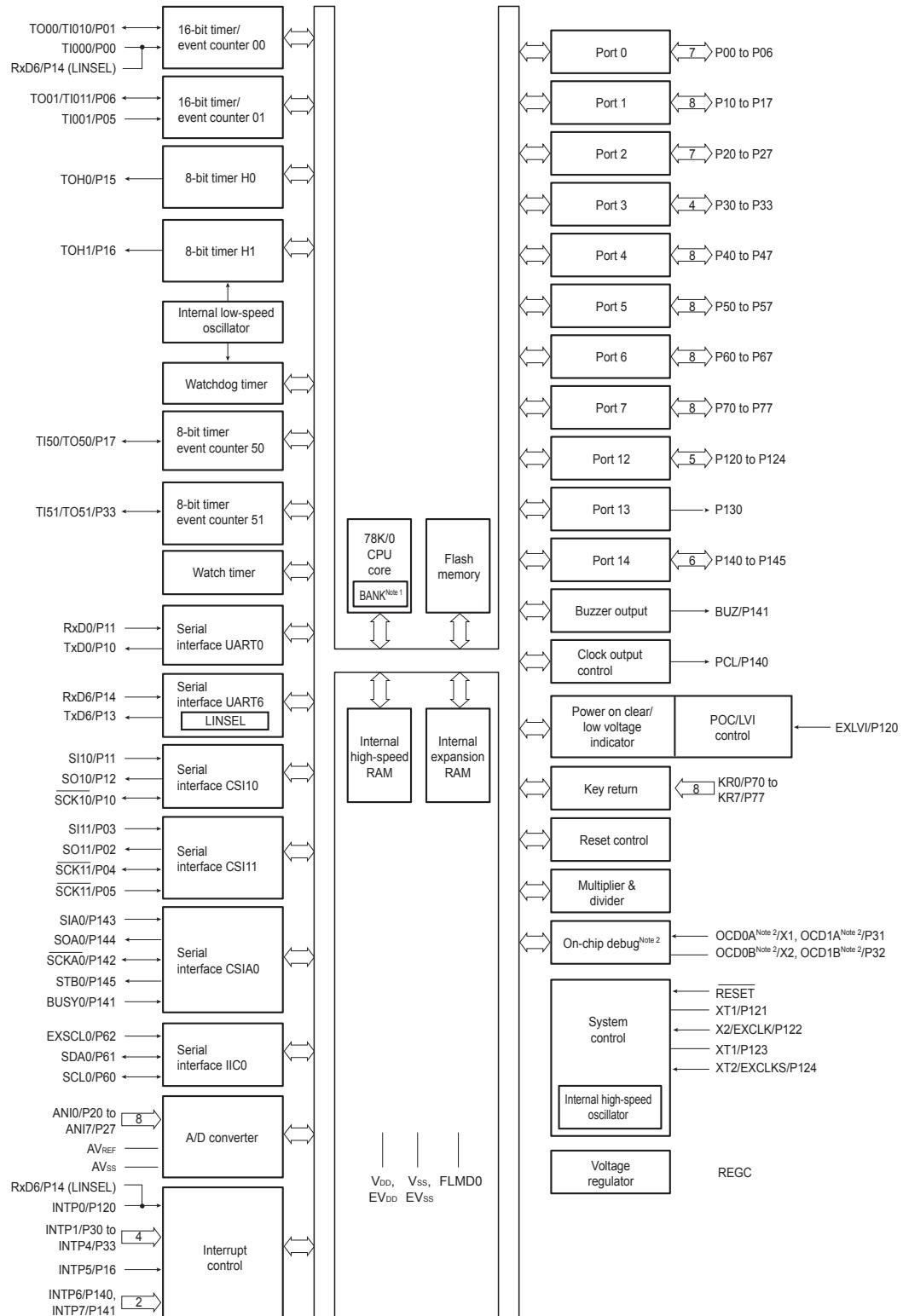
7. STR-W6253



8. TAS5142

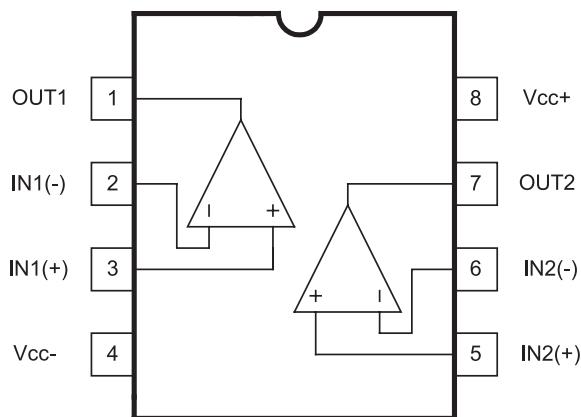


9. U1739EJ2V1UD00/KF2_E

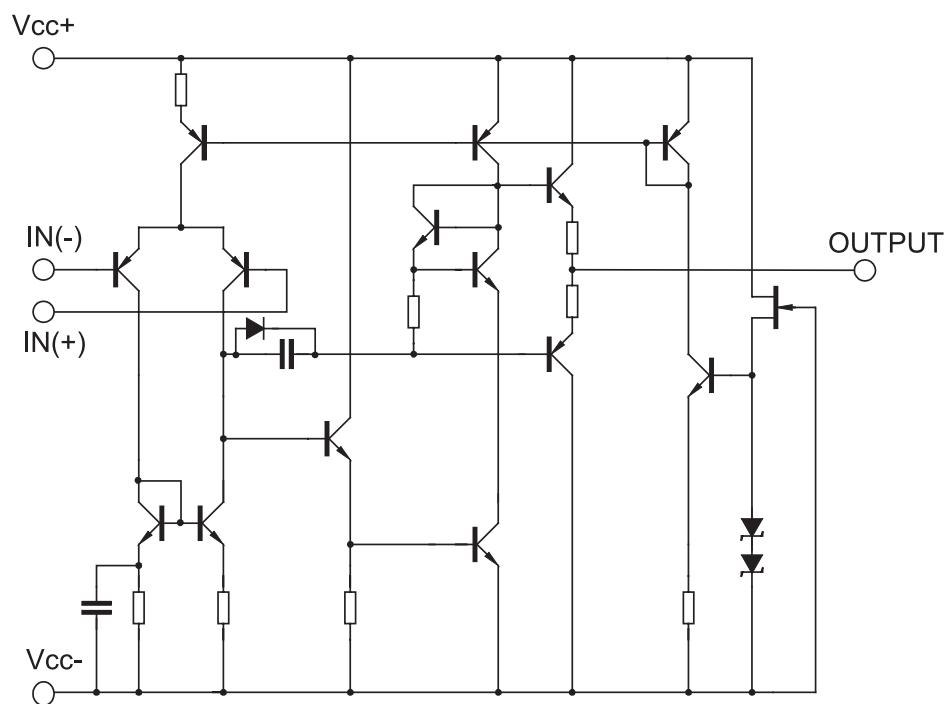


10. UTC MC4580

10-1. PIN CONFIGURATION



10-2. TEST CIRCUIT

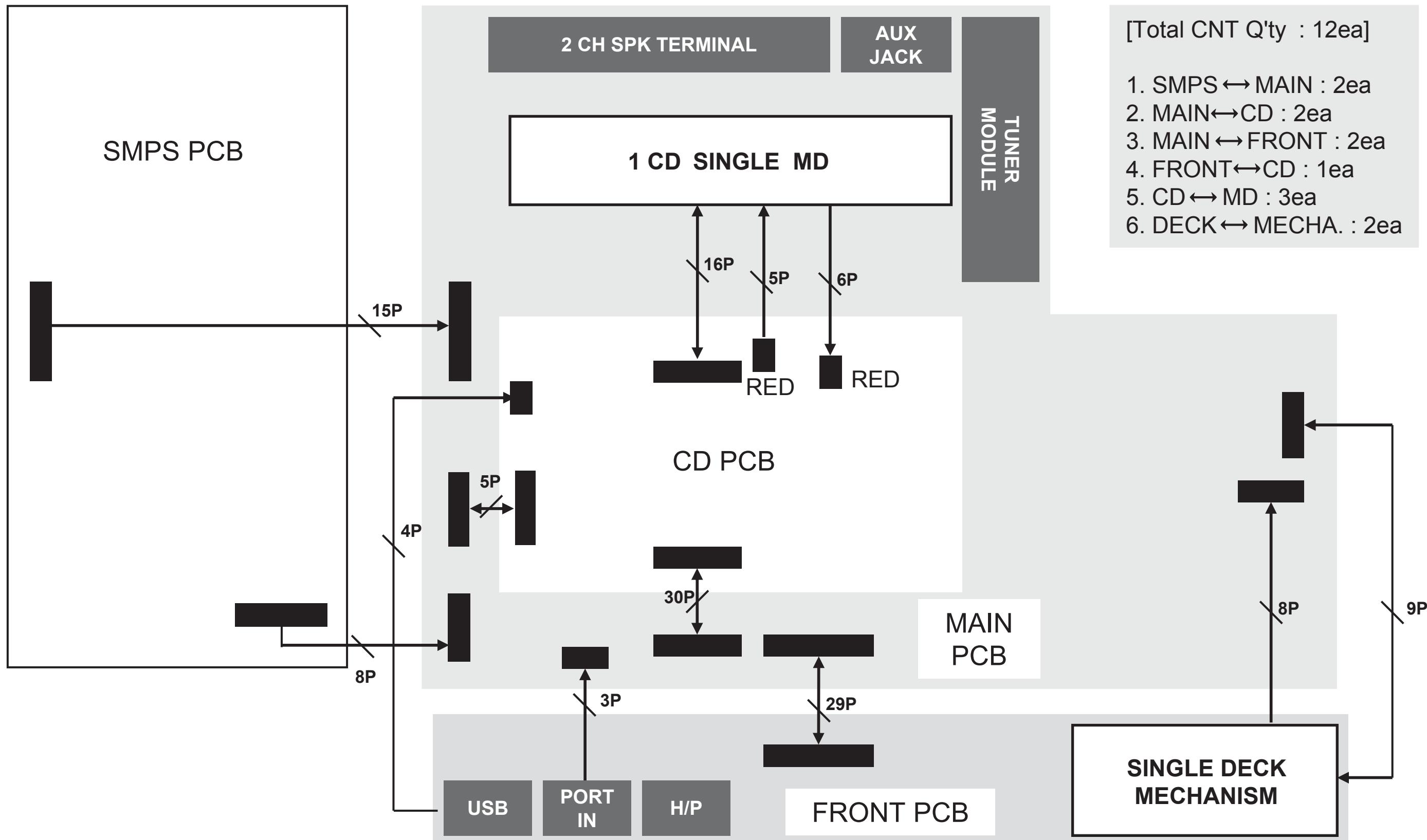


ABSOLUTE MAXIMUM RATINGS ($T_a=25\text{ C}$)

PARAMETER	SYMBOL	RATINGS	UNIT
Supply Voltage	V^+/V^-	± 18	V
Input Voltage	V_{IC}	± 15	V
Differential Input Voltage	V_{ID}	± 30	V
Output Current	I_o	± 50	mA
Power Dissipation	P_D	300 (SOP-8) 800 (DIP-8) 250 (TSSOP-8)	mW
Operating Temperature Range	T_{opr}	-40 to +85	°C
Storage Temperature Range	T_{stg}	-40 to +125	°C

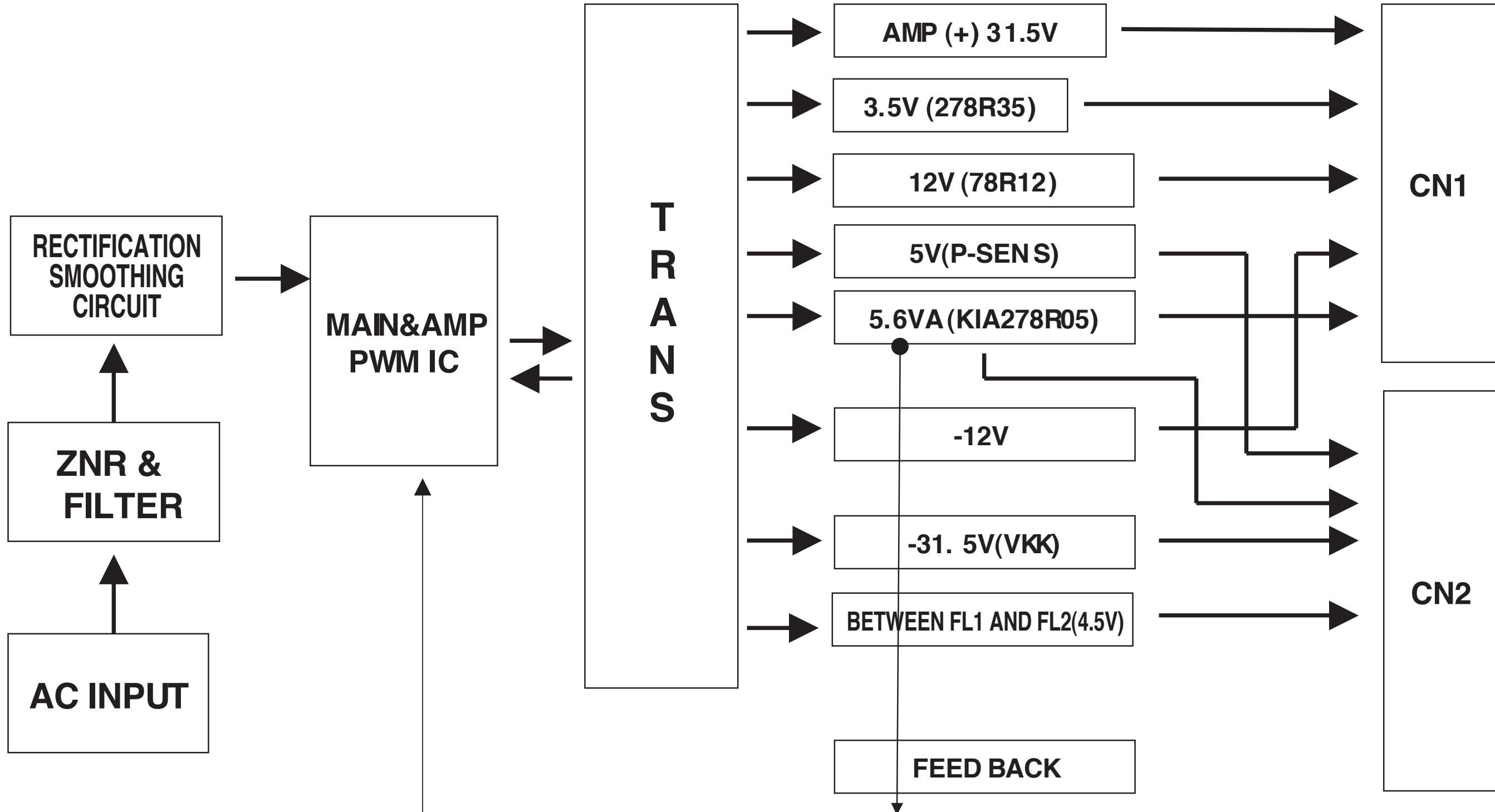
MEMO

WIRING DIAGRAM

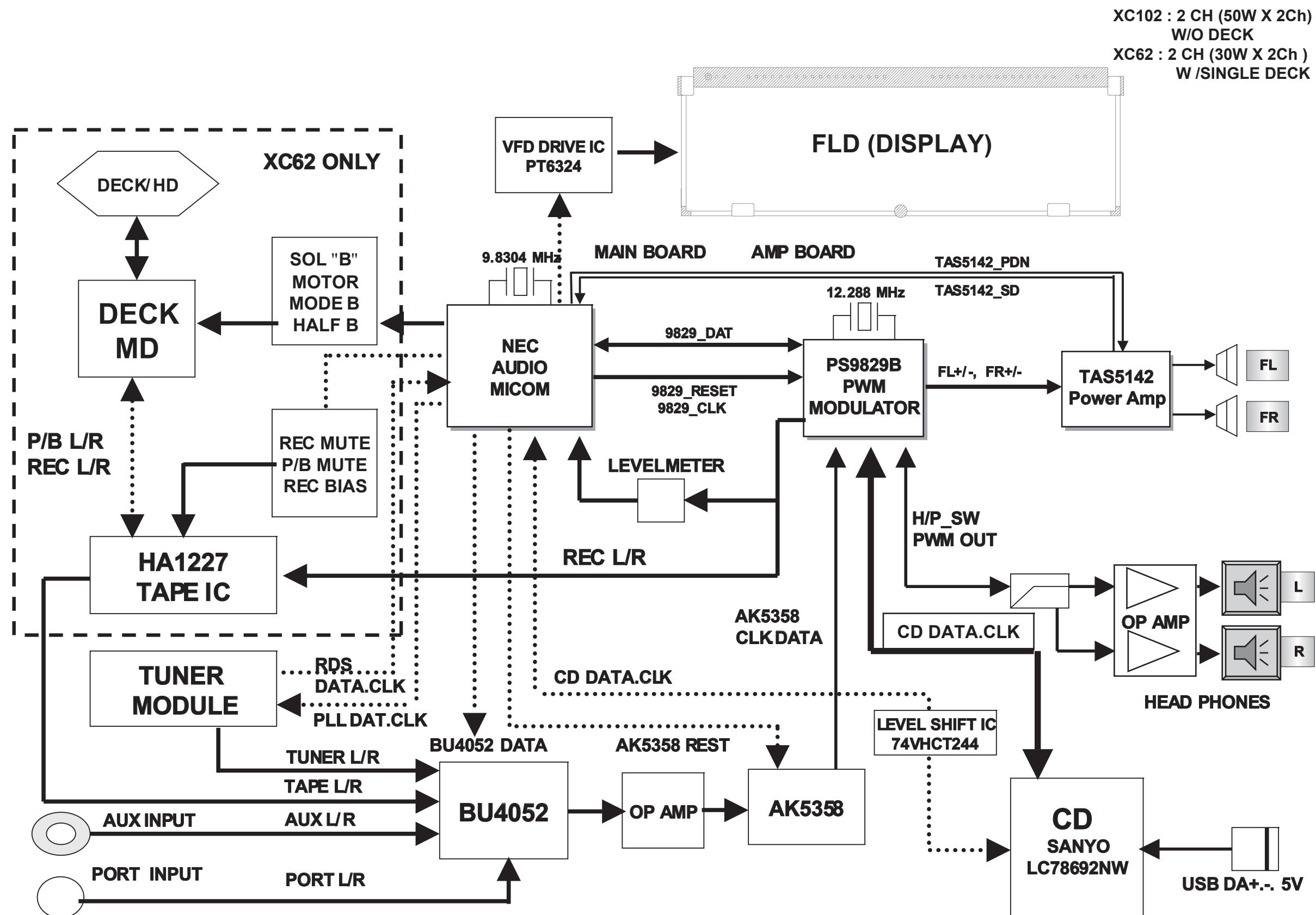


BLOCK DIAGRAMS

1. SMPS BLOCK DIAGRAM

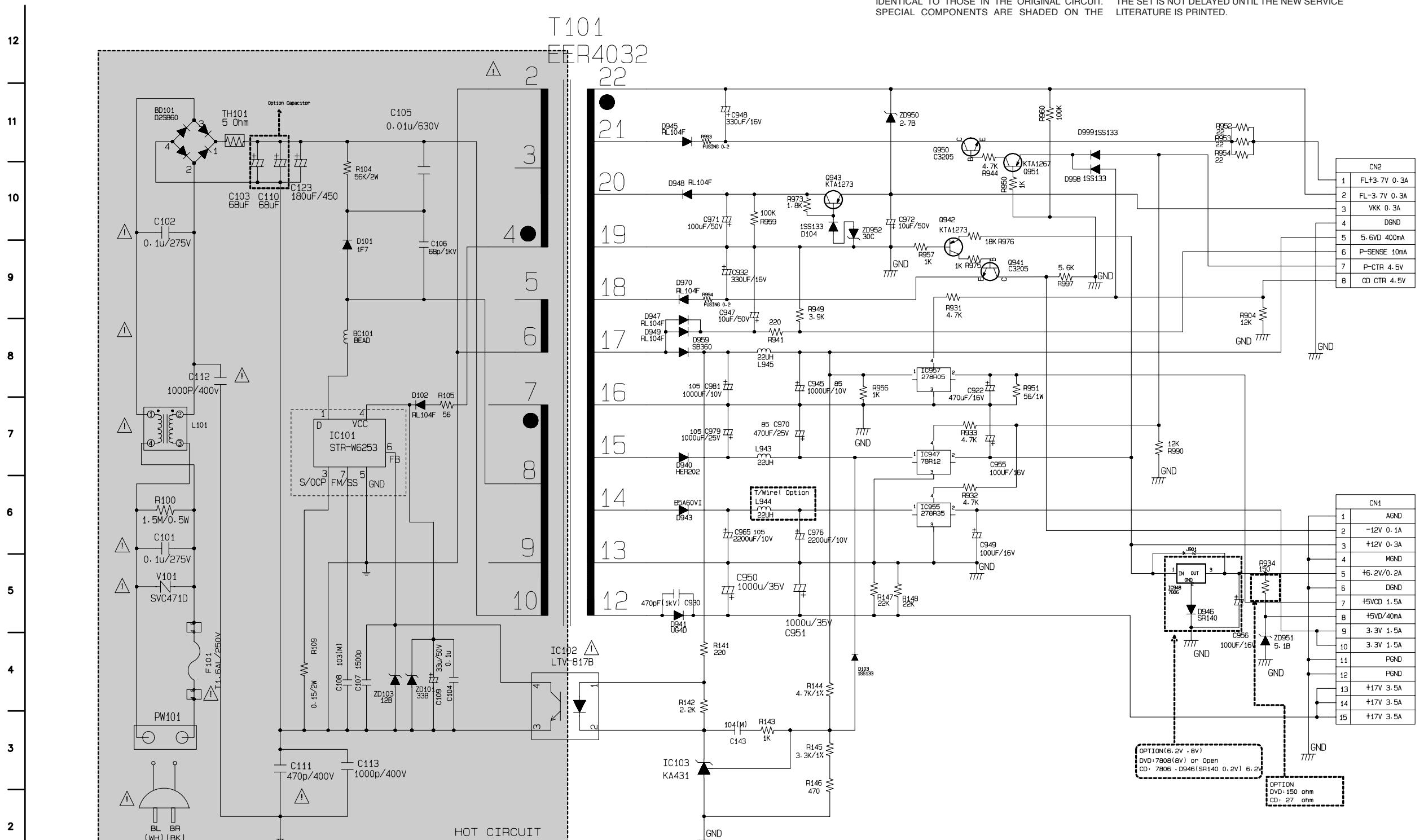


2. MAIN & FRONT BLOCK DIAGRAM



SCHEMATIC DIAGRAMS

1. SMPS SCHEMATIC DIAGRAM



IMPORTANT SAFETY

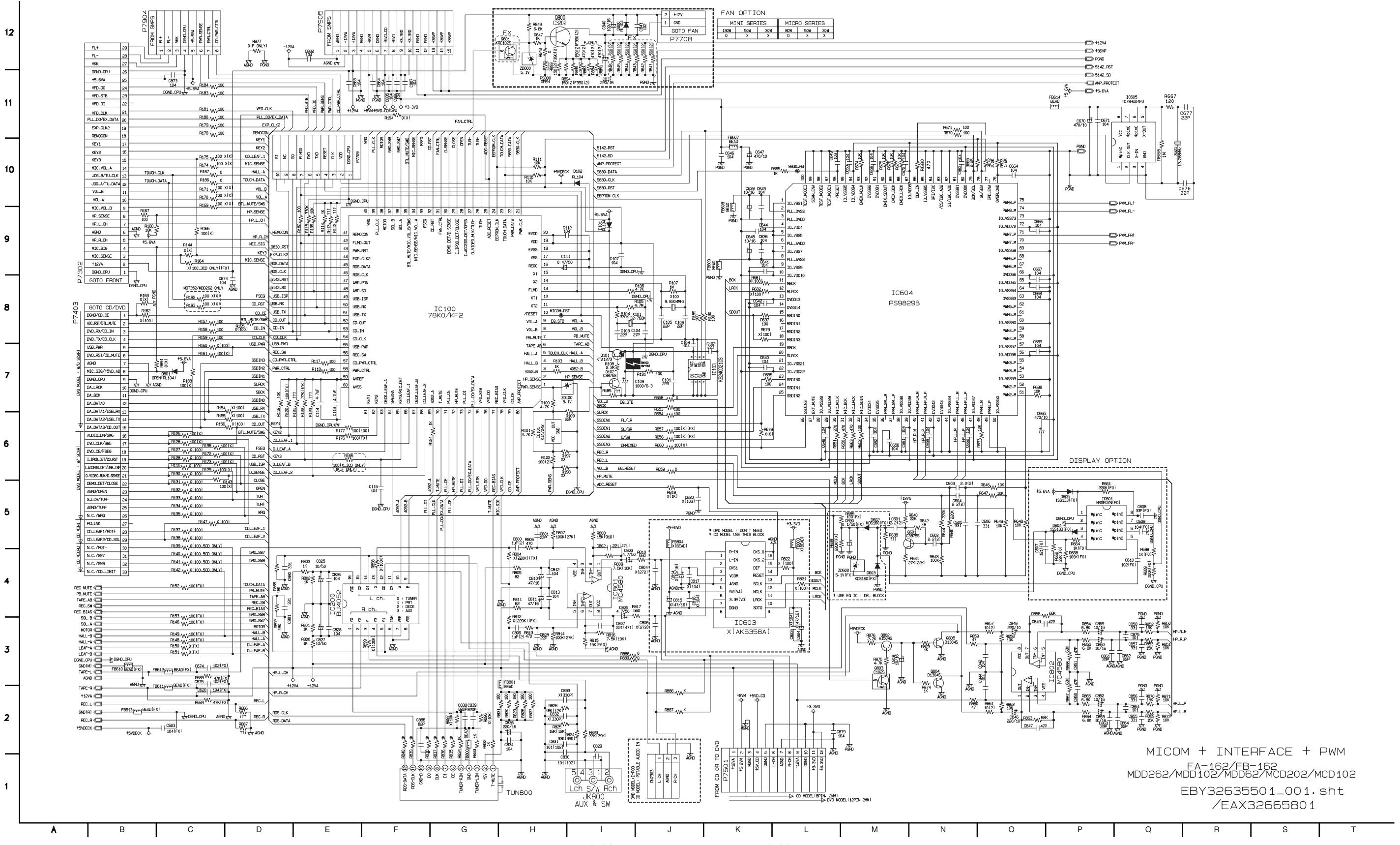
WHEN SERVICING THIS CHASSIS, UNDER NO CIRCUMSTANCES SHOULD THE ORIGINAL DESIGN BE MODIFIED OR ALTERED WITHOUT PERMISSION FROM THE LG CORPORATION. ALL COMPONENTS SHOULD BE REPLACED ONLY WITH TYPES IDENTICAL TO THOSE IN THE ORIGINAL CIRCUIT. SPECIAL COMPONENTS ARE SHADED ON THE

SCHEMATIC FOR EASY IDENTIFICATION. THIS CIRCUIT DIAGRAM MAY OCCASIONALLY DIFFER FROM THE ACTUAL CIRCUIT USED. THIS WAY, IMPLEMENTATION OF THE LATEST SAFETY AND PERFORMANCE IMPROVEMENT CHANGES INTO THE SET IS NOT DELAYED UNTIL THE NEW SERVICE LITERATURE IS PRINTED.

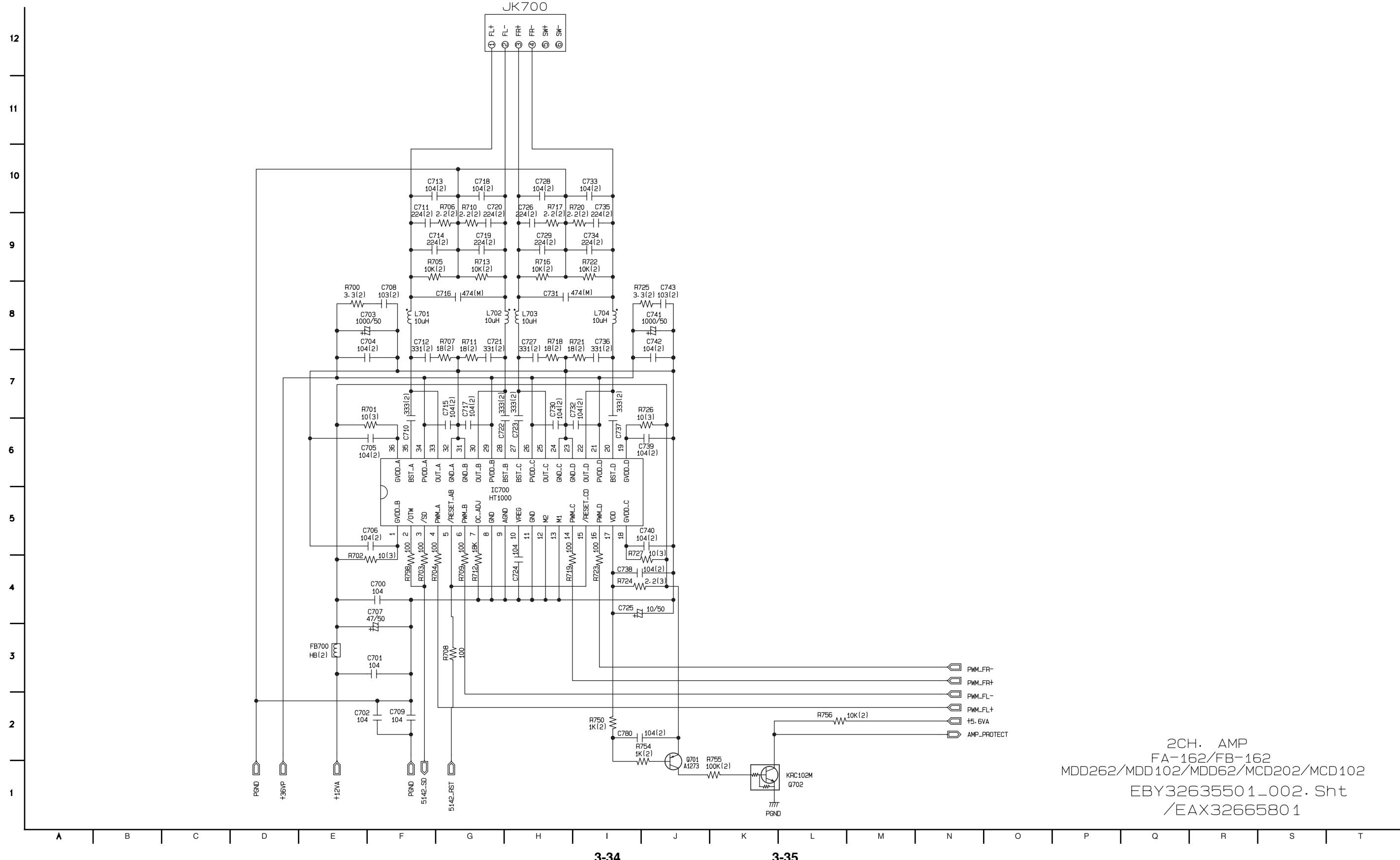
NOTE :

1. Shaded(█) parts are critical for safety. Replace only with specified part number.
 2. Voltages are DC-measured with a digital voltmeter during Play mode.

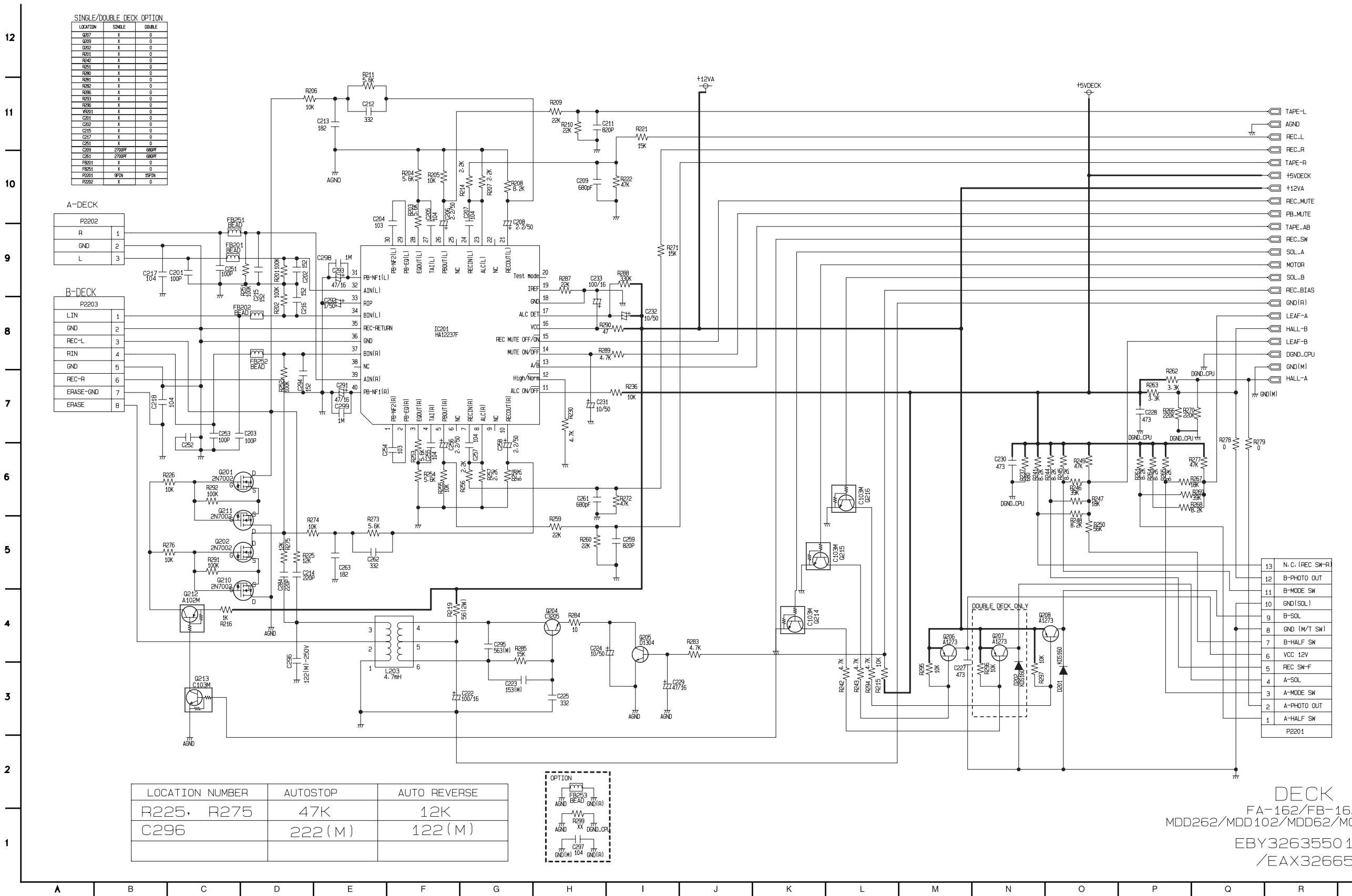
2. MAIN SCHEMATIC DIAGRAM



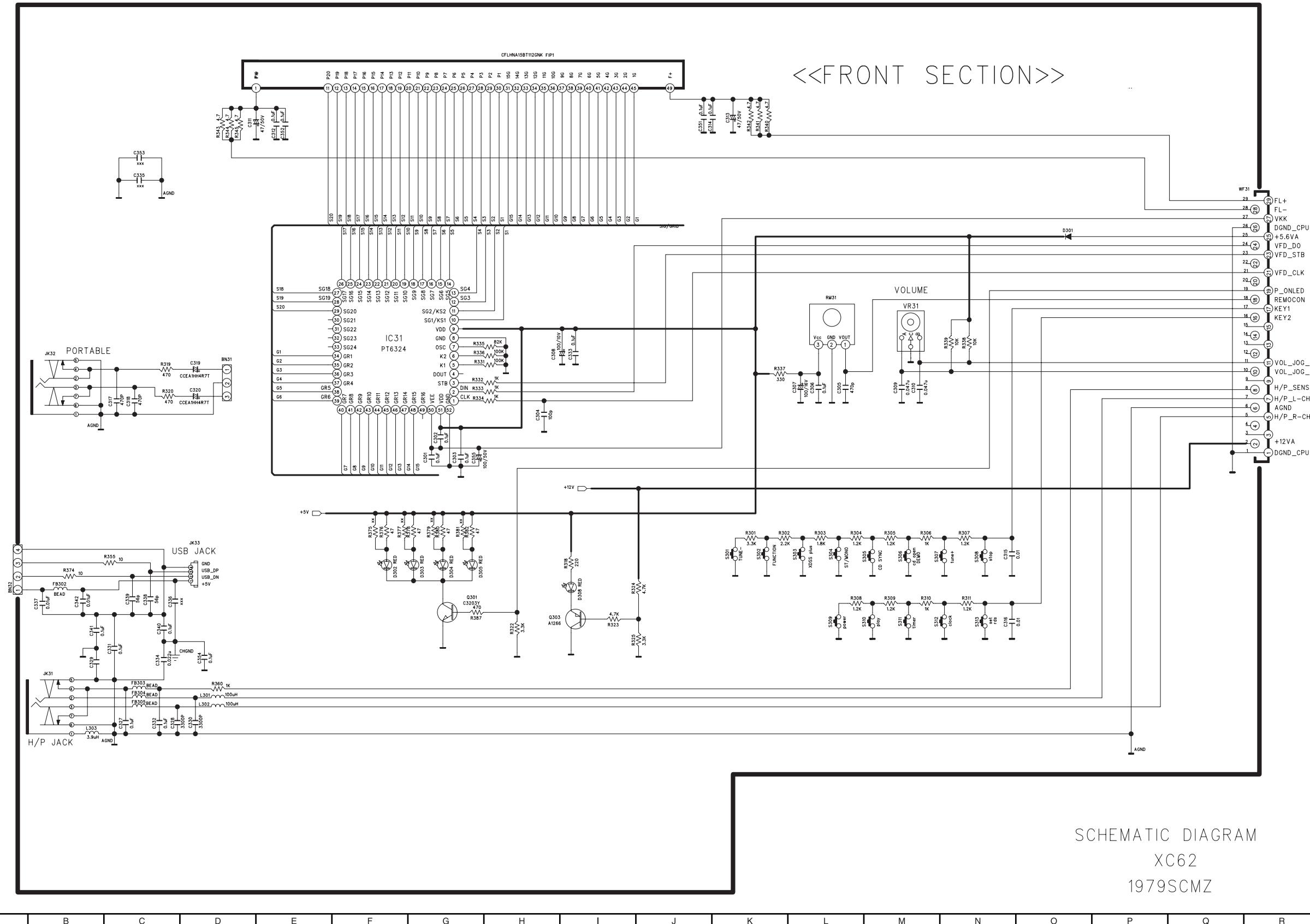
3. AMP SCHEMATIC DIAGRAM



4. DECK SCHEMATIC DIAGRAM



5. FRONT SCHEMATIC DIAGRAM

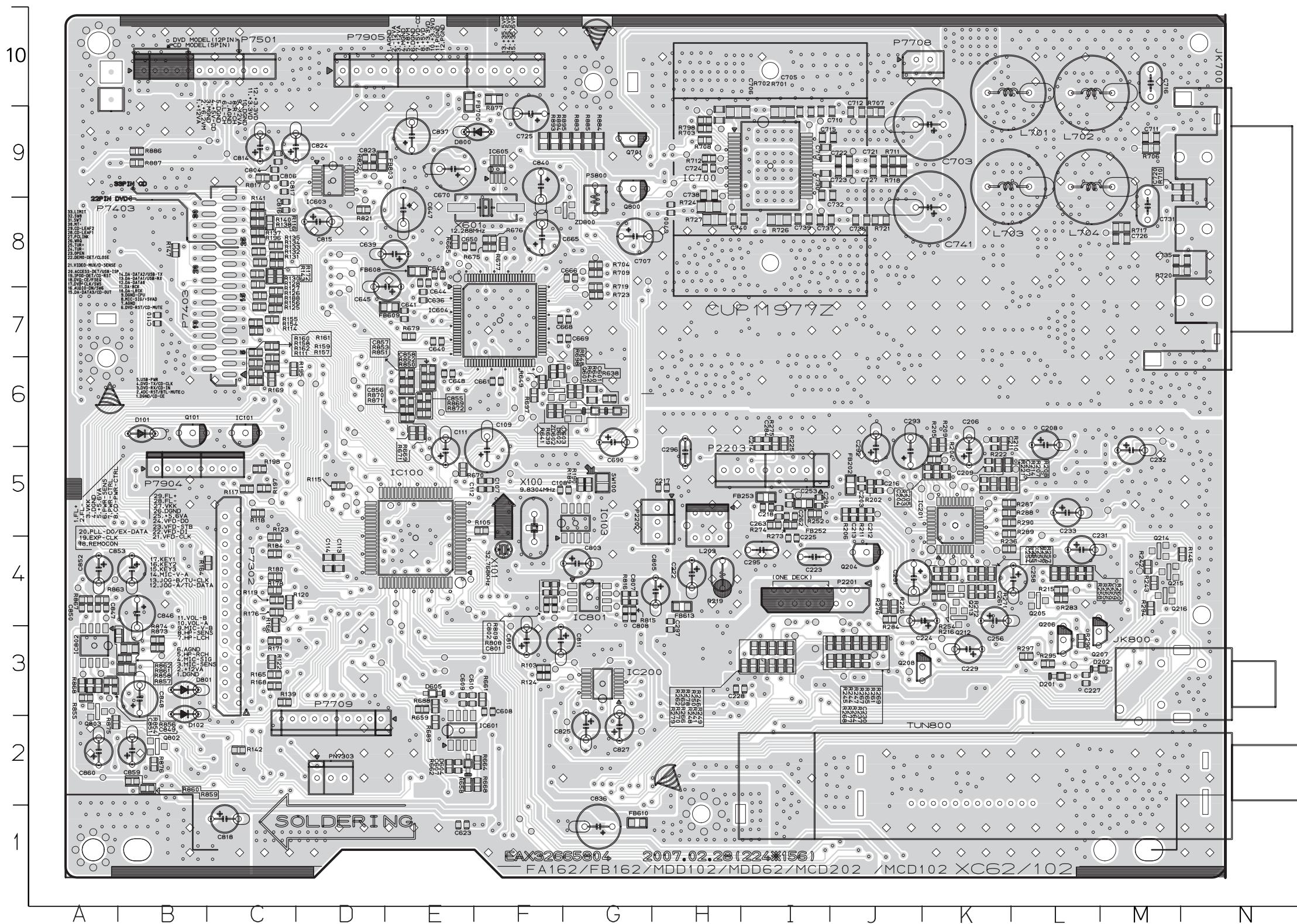


SCHEMATIC DIAGRAM
XC62
1979SCMZ

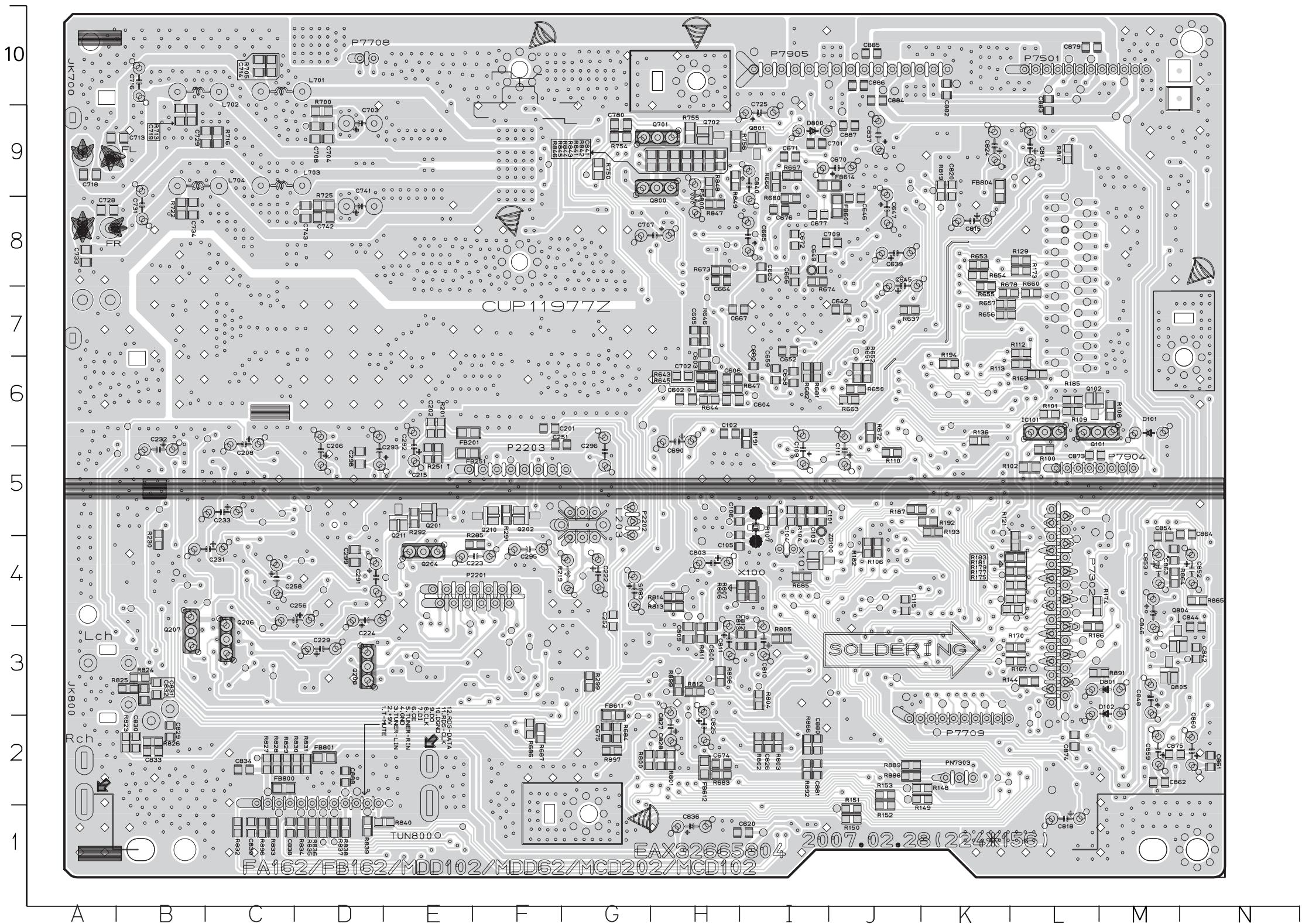
PRINTED CIRCUIT BOARD DIAGRAMS

1. MAIN P.C.BOARD

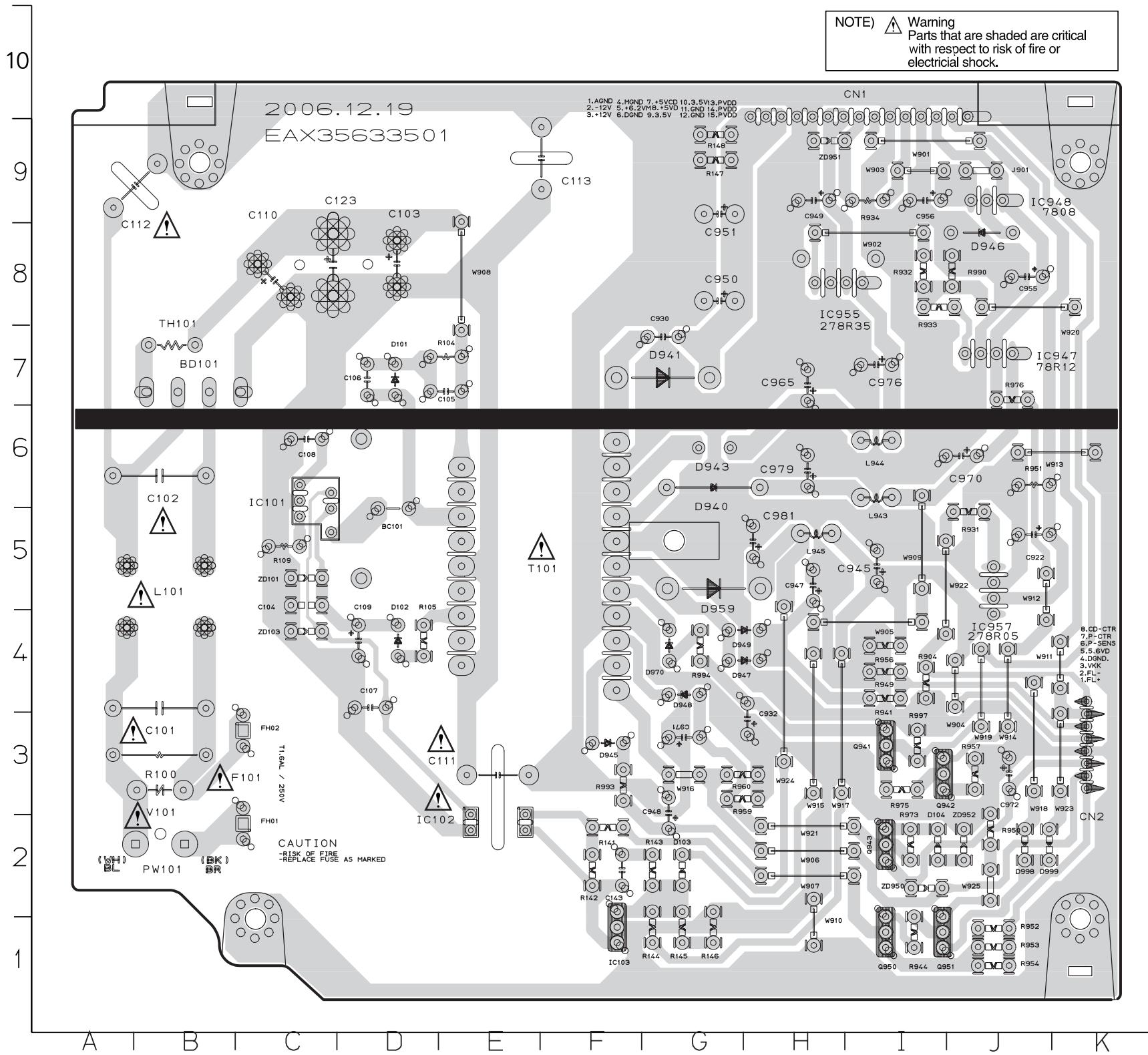
(TOP VIEW)



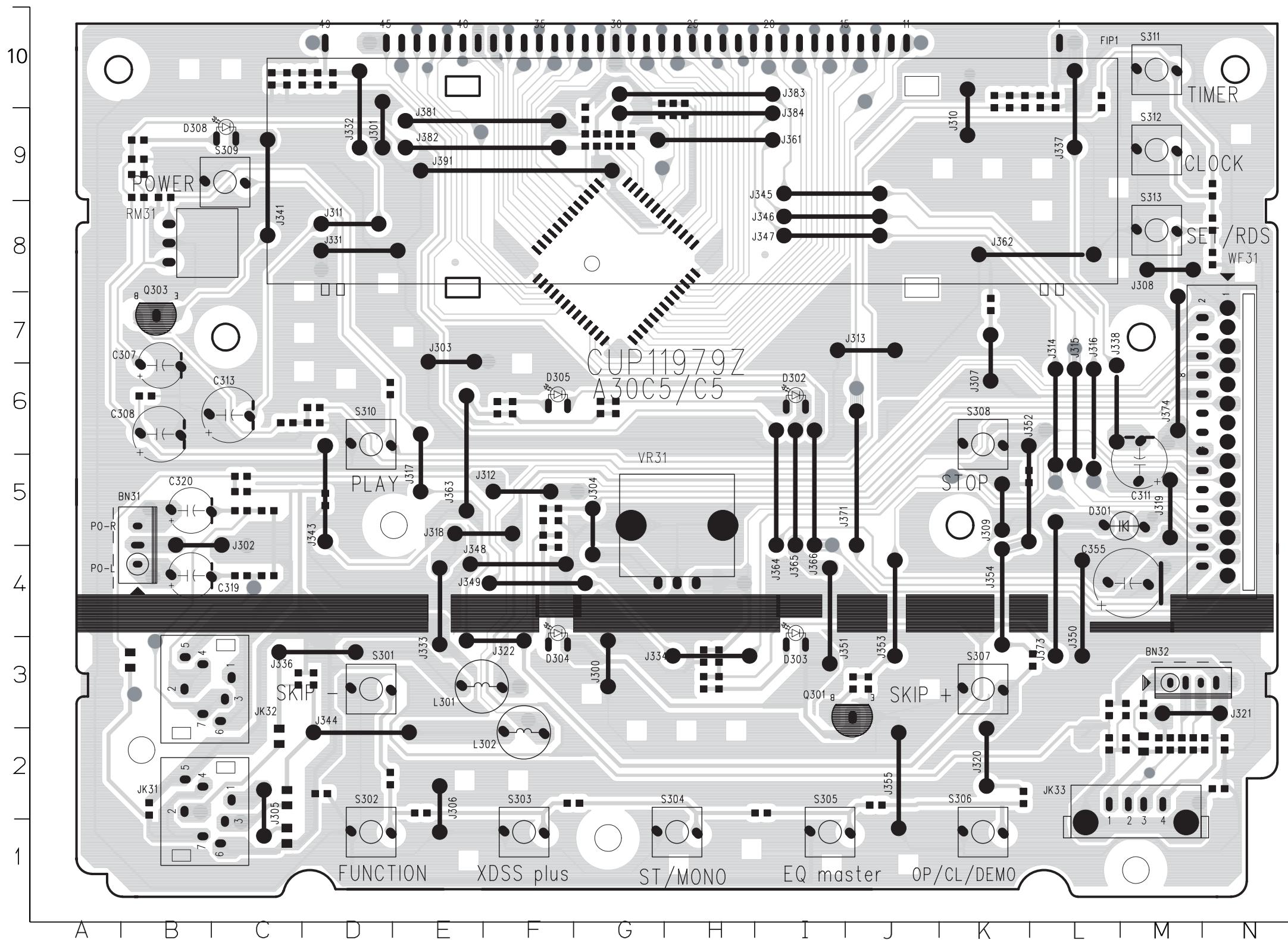
MAIN P.C.BOARD (BOTTOM VIEW)



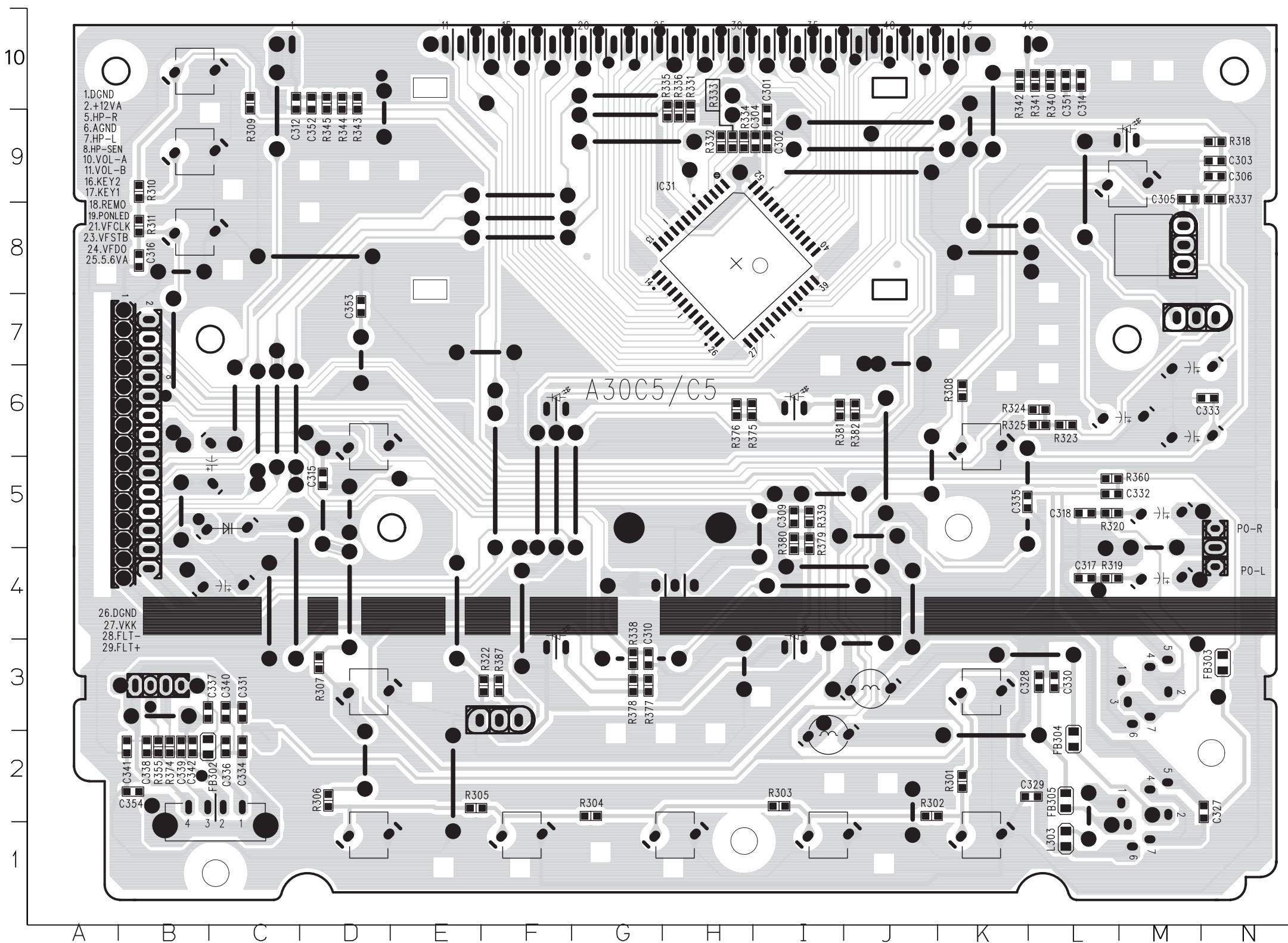
2. SMPS P.C.BOARD



3. FRONT P.C.BOARD
(TOP VIEW)



FRONT P.C.BOARD (BOTTOM VIEW)



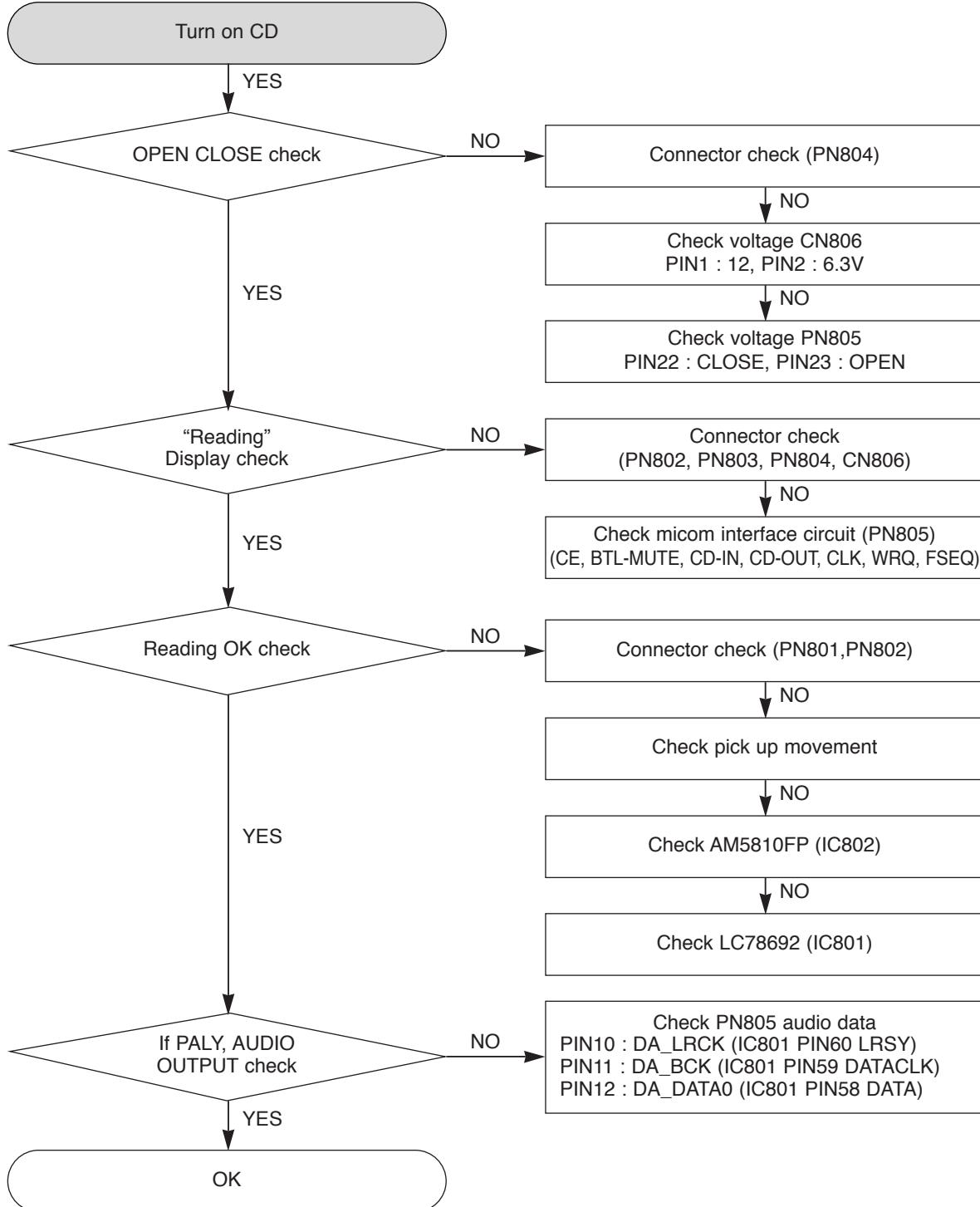
MEMO

MEMO

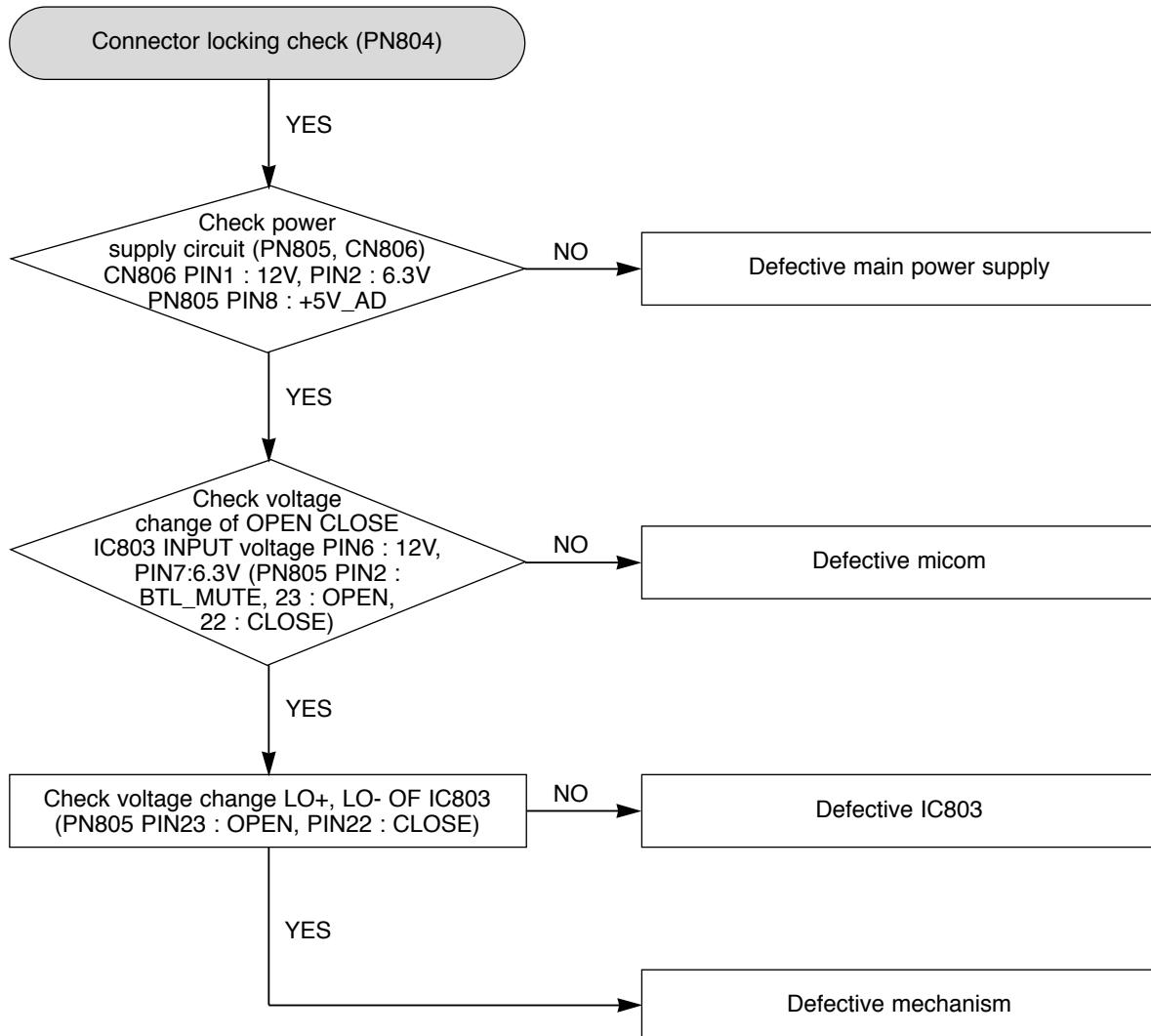
SECTION 4 CD PART ELECTRICAL

CD ELECTRICAL TROUBLESHOOTING GUIDE

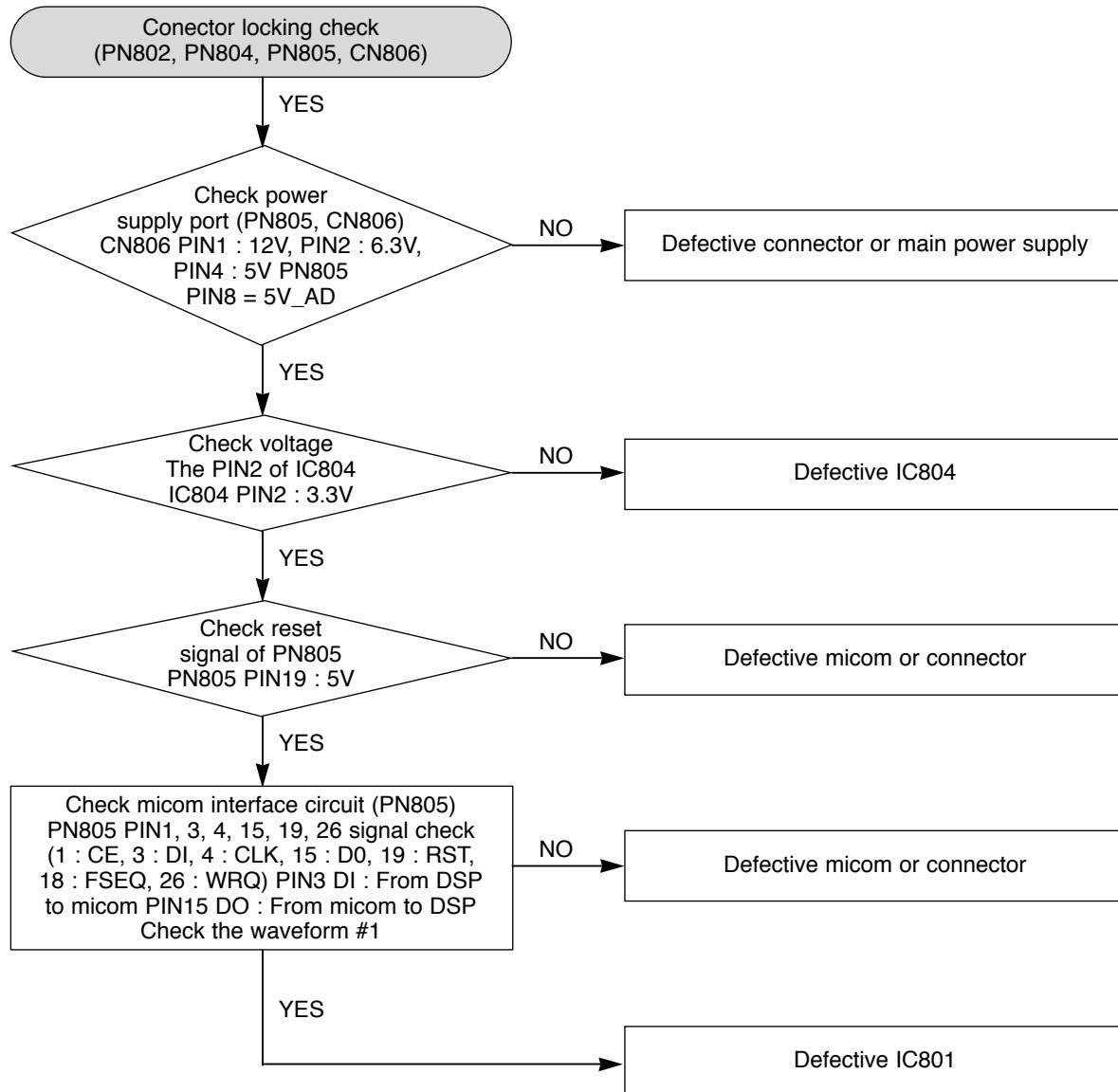
1. CD PART TROUBLESHOOTING



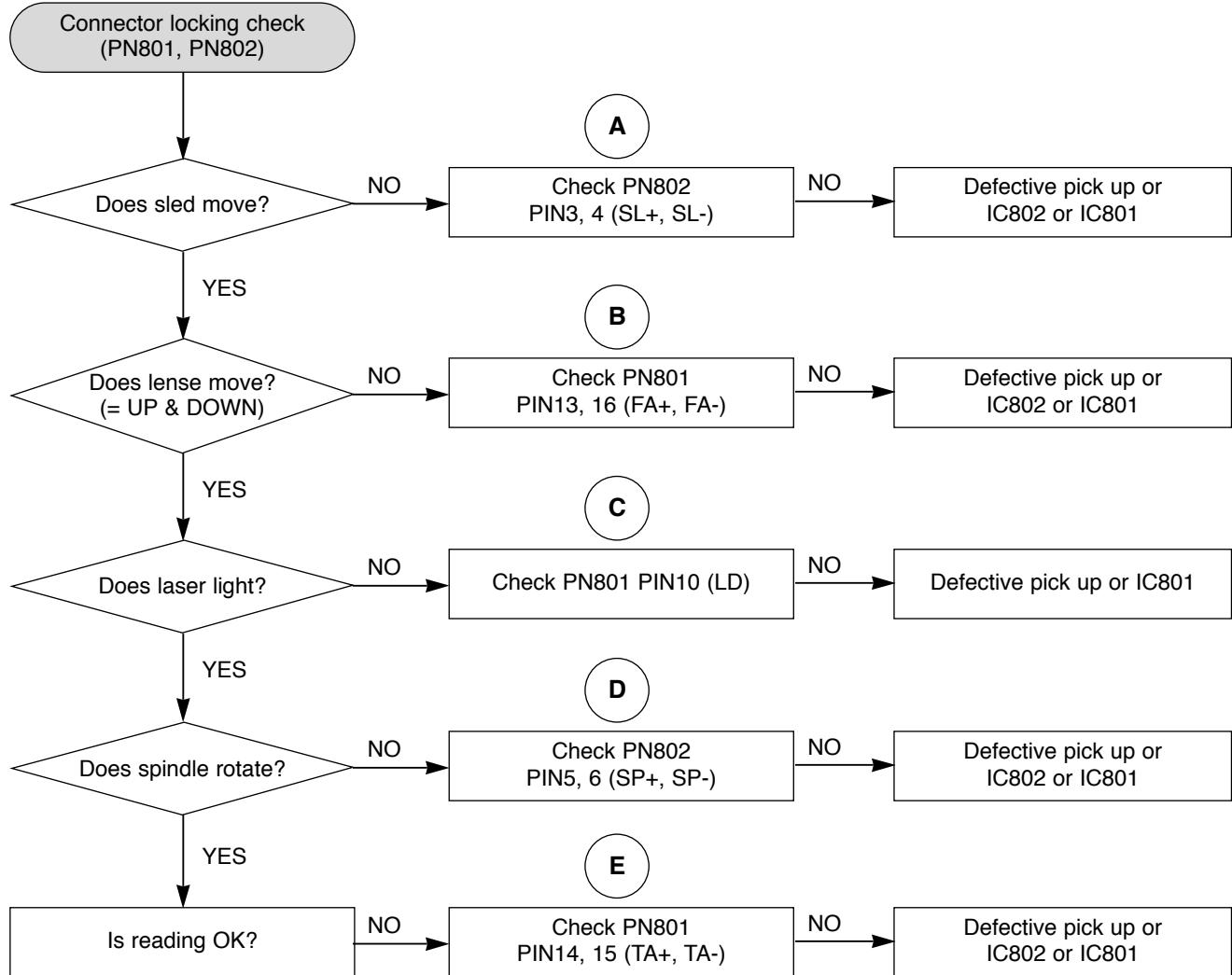
1-1. OPEN CLOSE NG



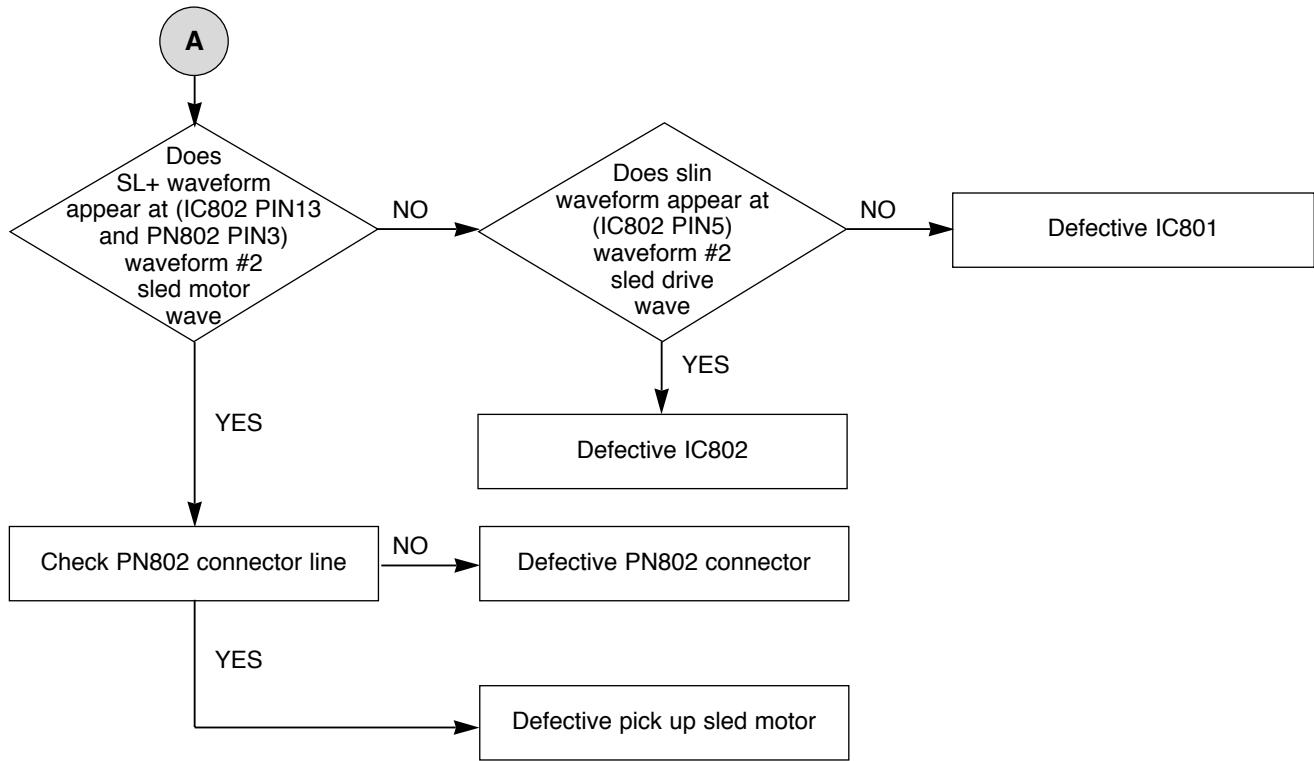
1-2. "READING" DISPLAY CHECK (= ONLY "CD" DISPLAY)



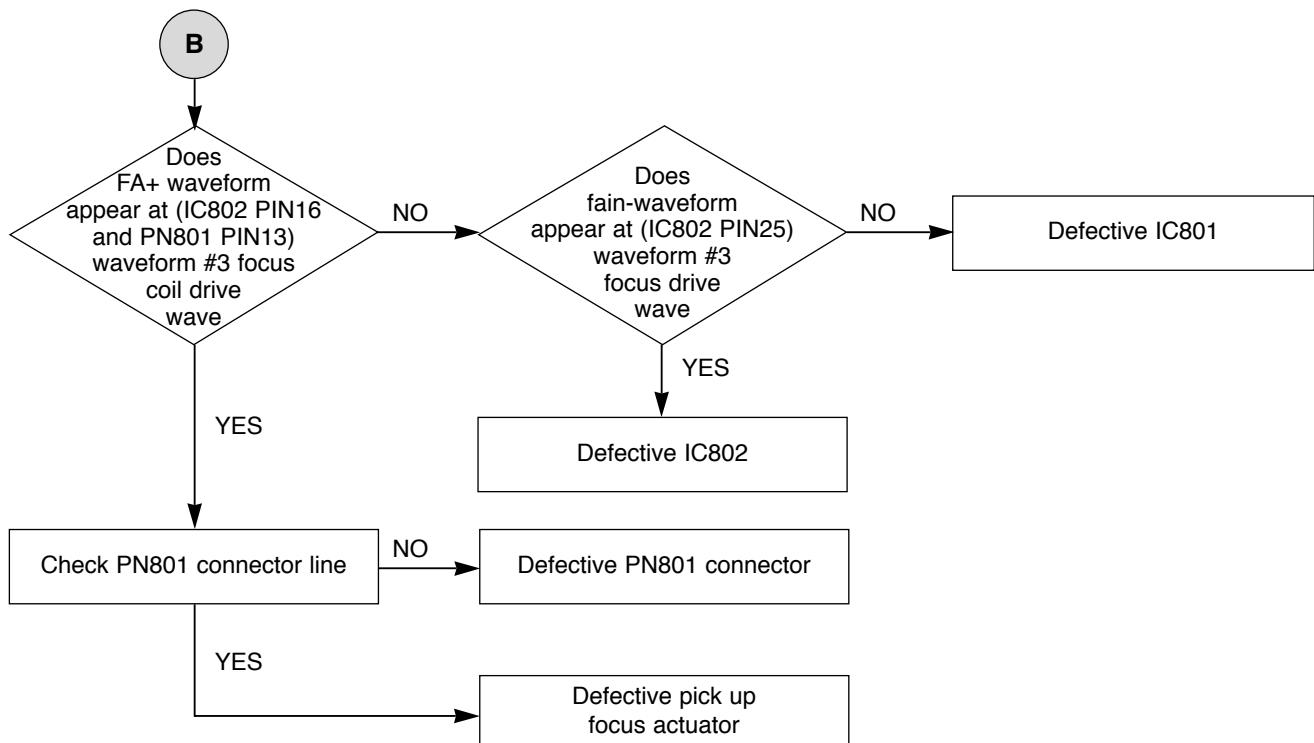
1-3. READING OK CHECK (= “NO DISC” DISPLAY)



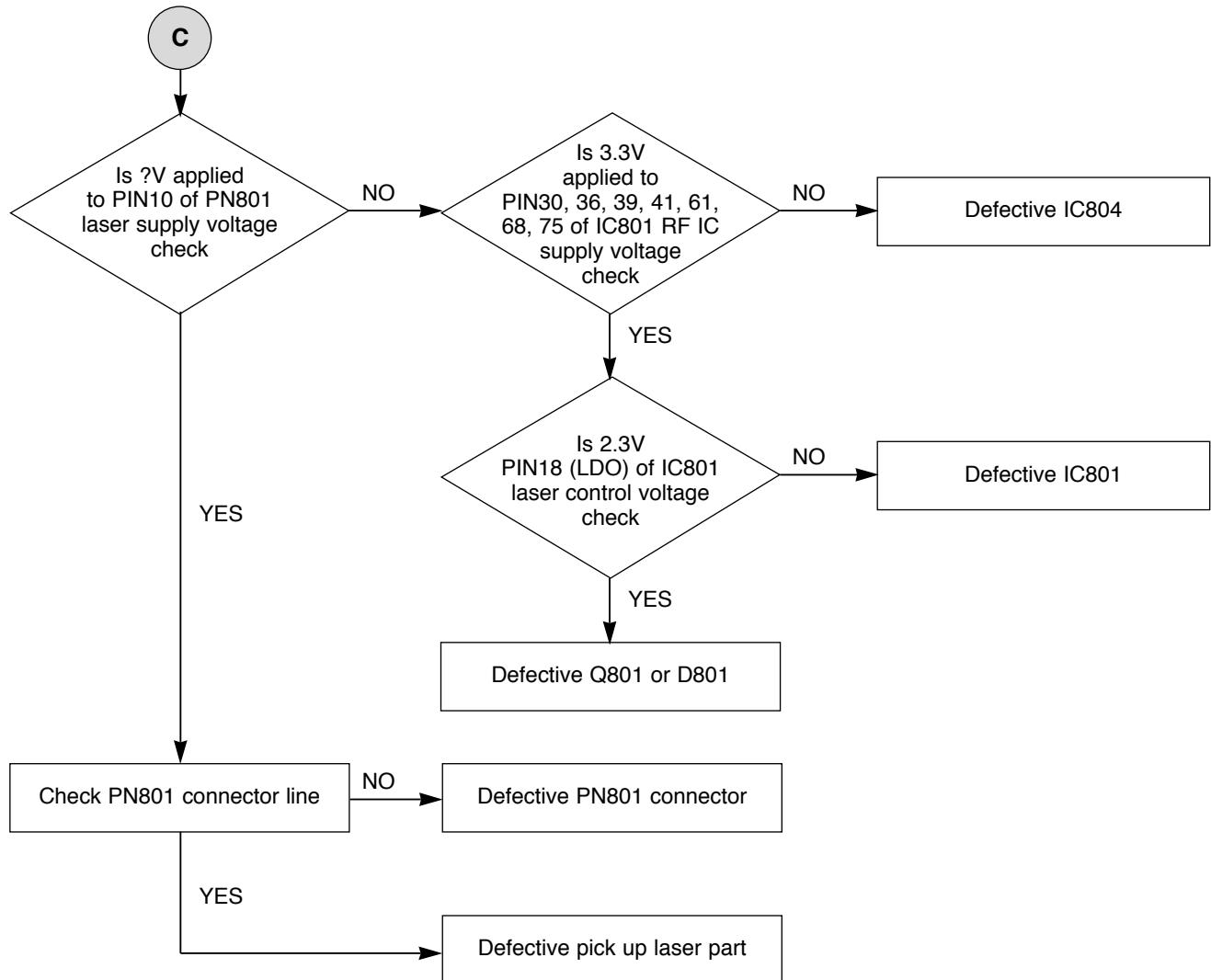
1-4. READING OK CHECK #A (= “NO DISC” DISPLAY)



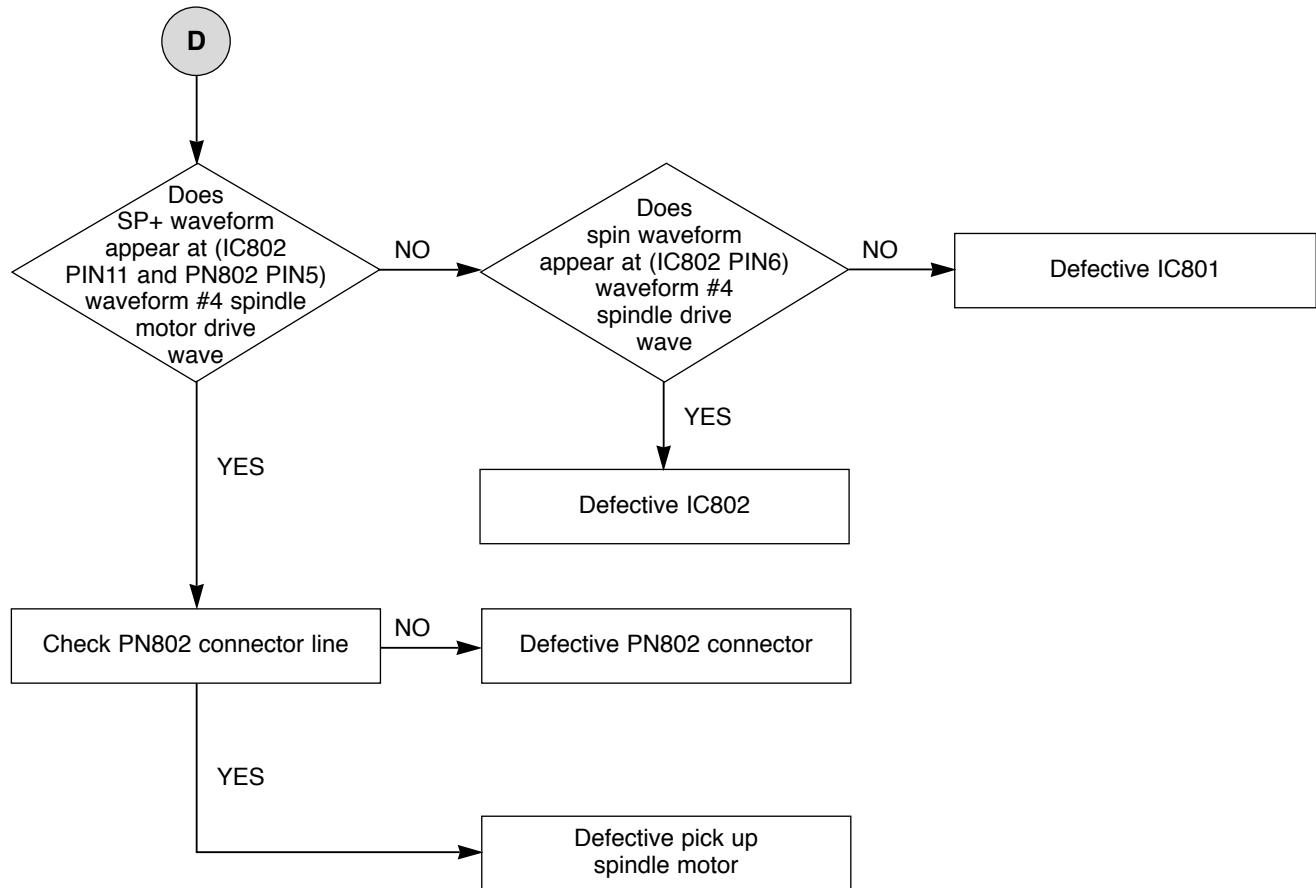
1-5. READING OK CHECK #B (= “NO DISC” DISPLAY)



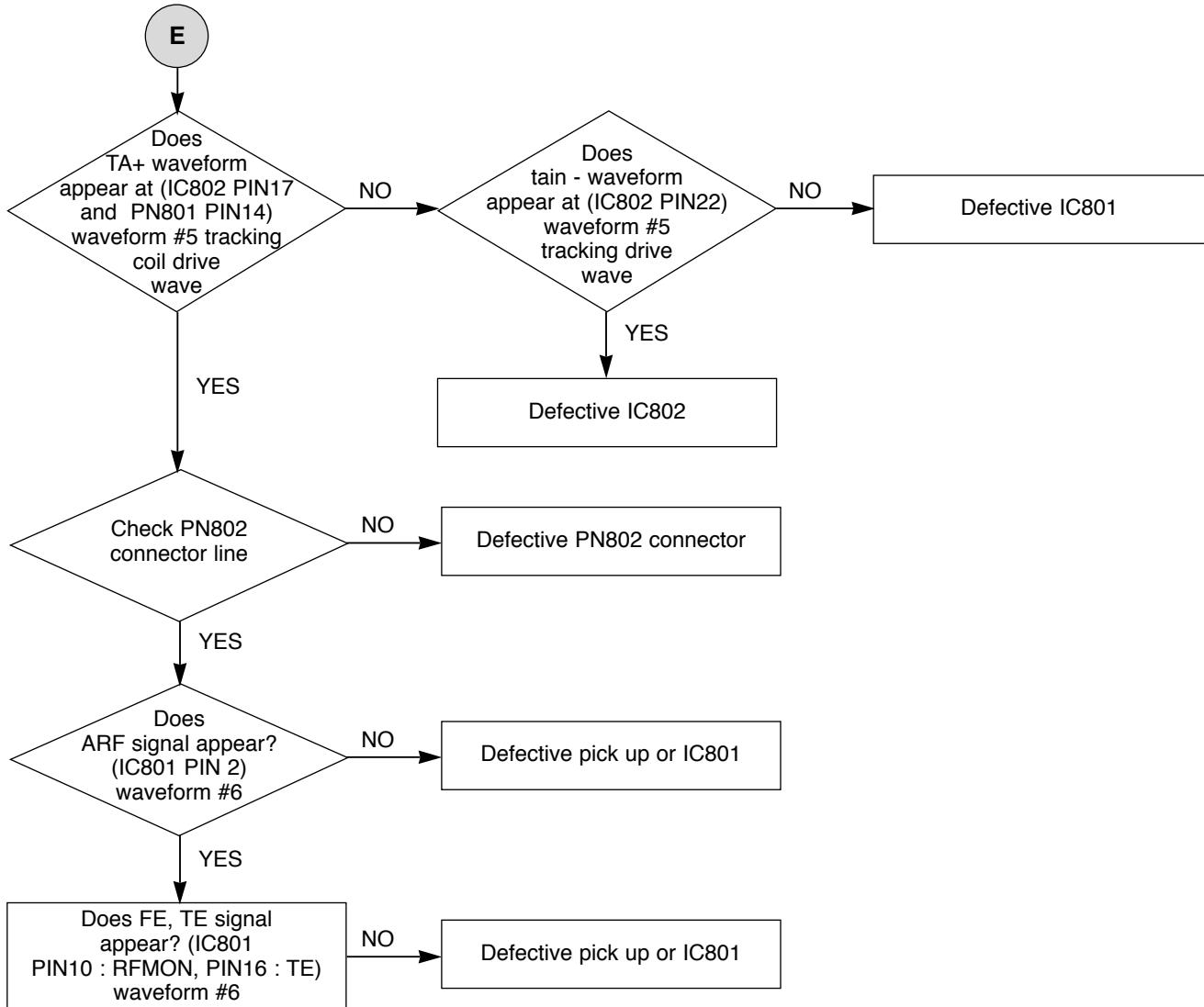
1-6. READING OK CHECK #C (= “NO DISC” DISPLAY)



1-7. READING OK CHECK #D (= “NO DISC” DISPLAY)

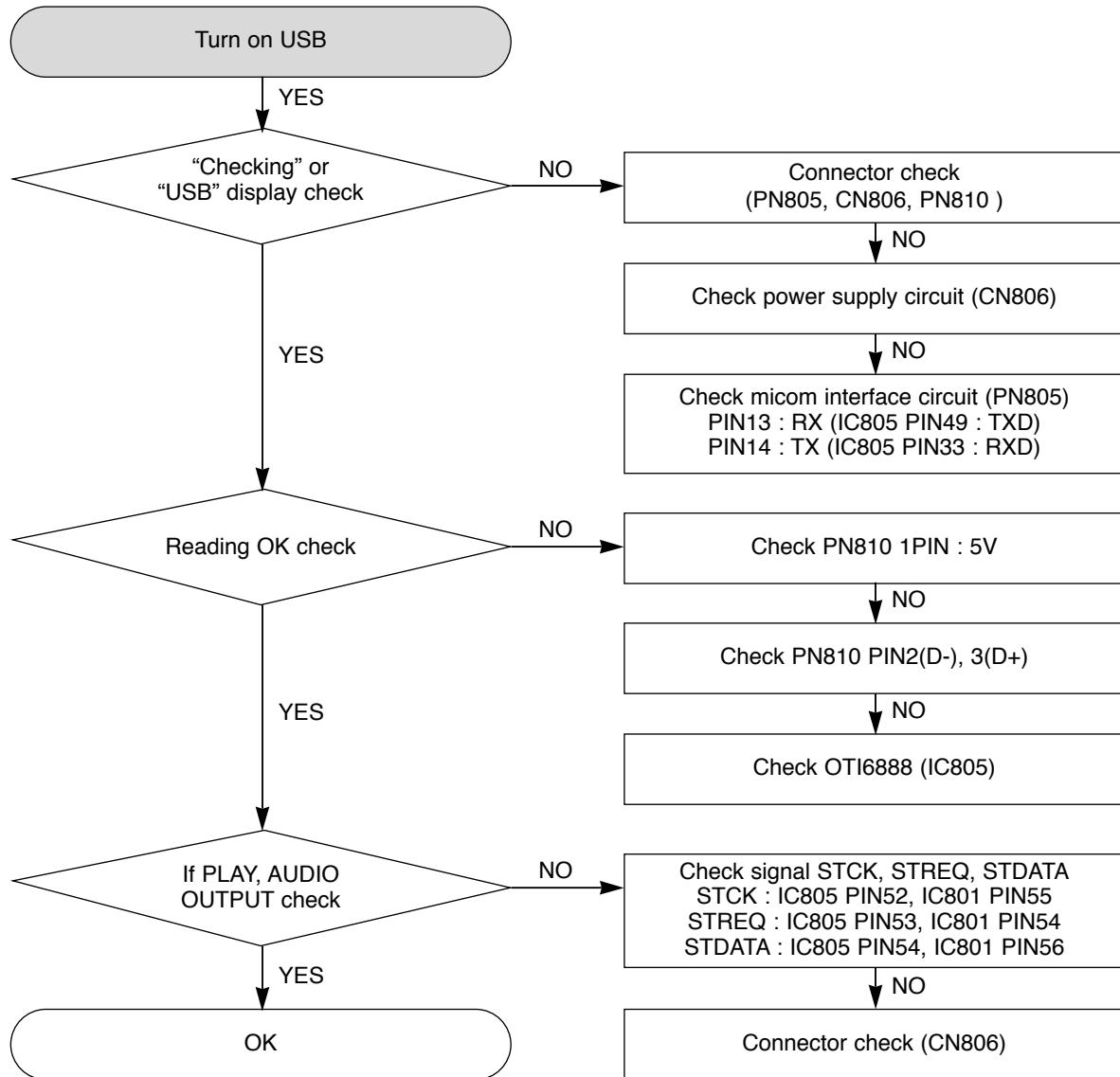


1-8. READING OK CHECK #E (= “NO DISC” DISPLAY)



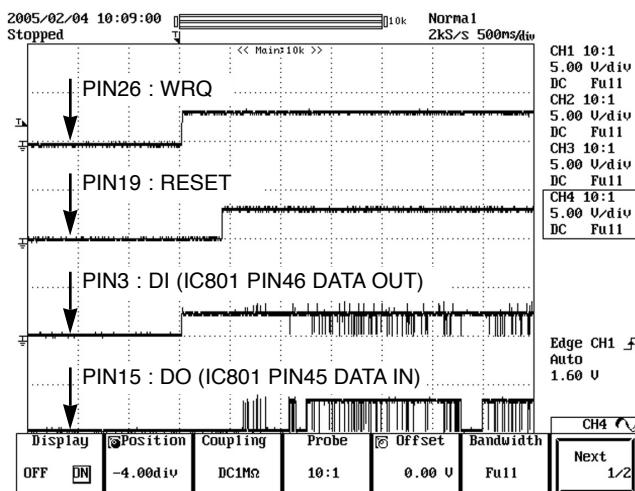
* REMON is FE

2. USB PART TROUBLESHOOTING

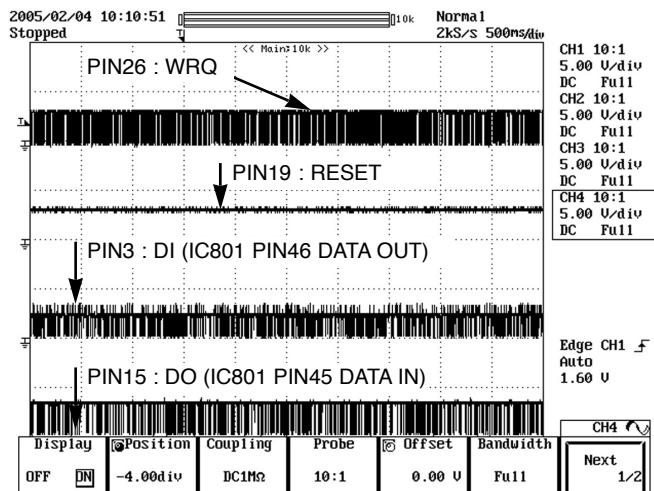


WAVEFORMS OF MAJOR CHECK POINT

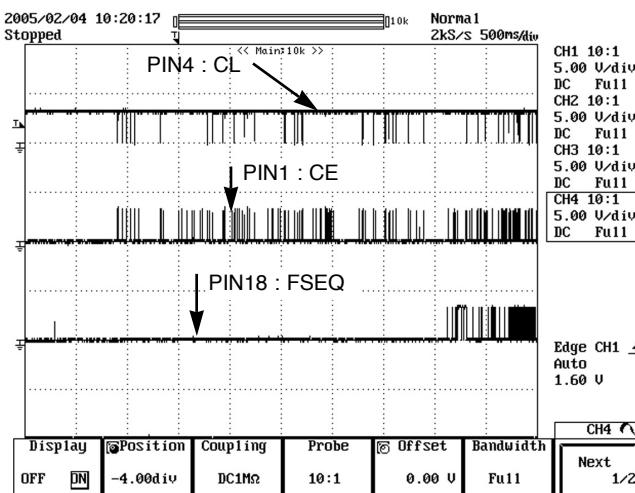
#1.MICOM INTERFACE WAVEFORM
(PN805 PIN26, 19, 3, 15) during power on



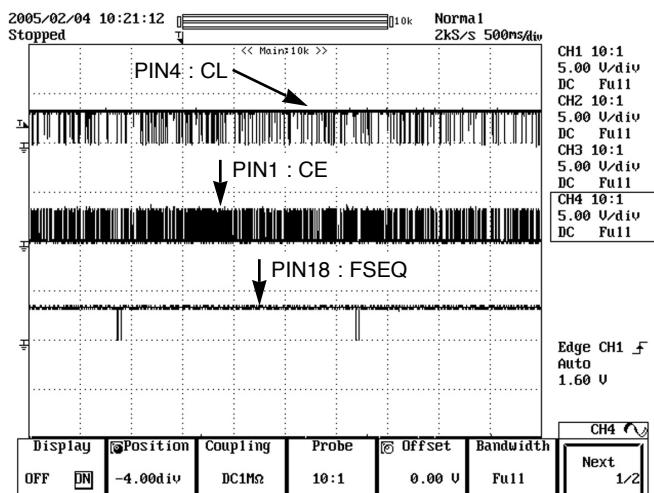
#1.MICOM INTERFACE WAVEFORM
(PN805 PIN26, 19, 3, 15) during normal play



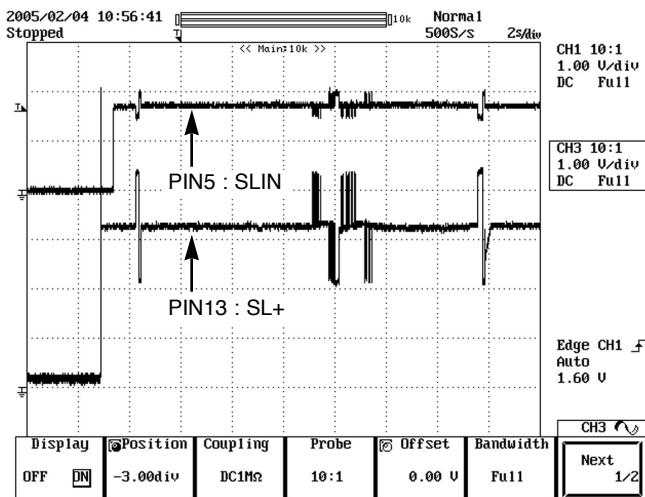
#1.MICOM INTERFACE WAVEFORM
(PN805 PIN4, 1, 18) during power on



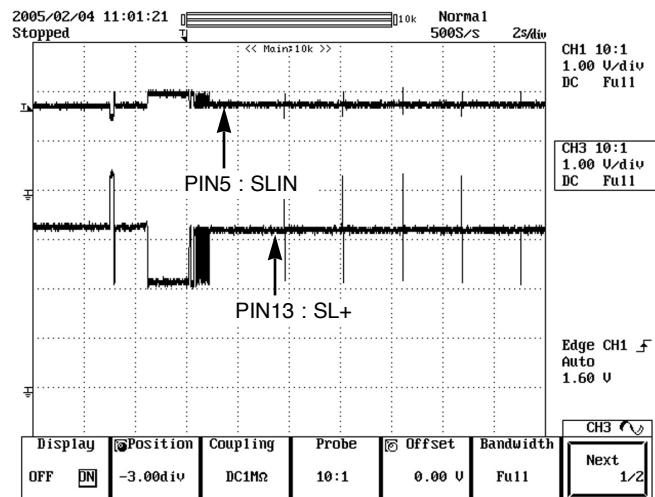
#1.MICOM INTERFACE WAVEFORM
(PN805 PIN4, 1, 18) during normal play



#2.SLED DRIVE AND MOTOR WAVEFORM
(IC802 PIN5, 13) when focus search

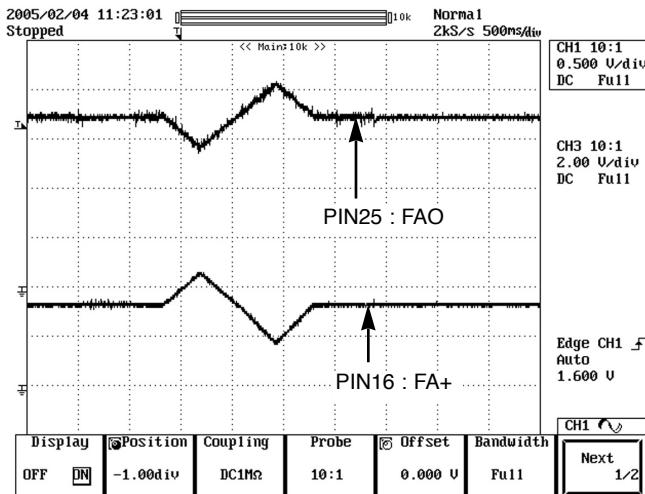


#2.SLED DRIVE AND MOTOR WAVEFORM
(IC802 PIN5, 13) during normal play



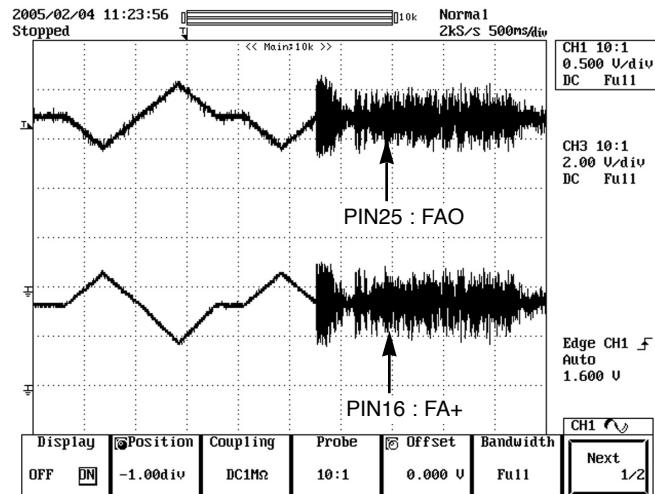
#3.FOCUS DRIVE AND MOTOR WAVEFORM
(IC802 PIN25, IC802 PIN16)

- When focus search failed or there is no disc on tray

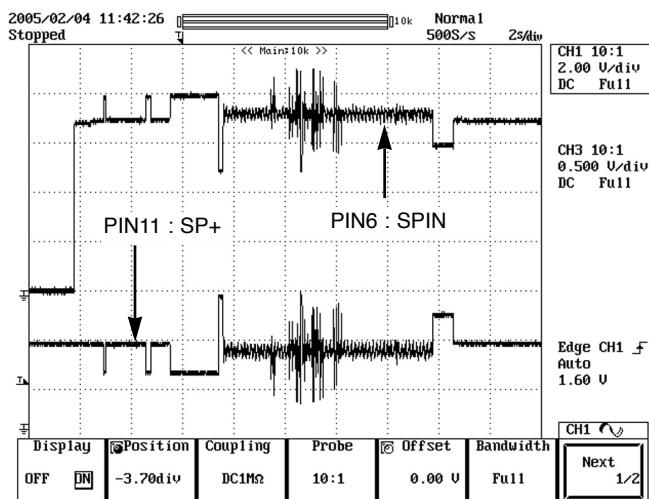


#3.FOCUS DRIVE AND MOTOR WAVEFORM
(IC802 PIN25, IC802 PIN16)

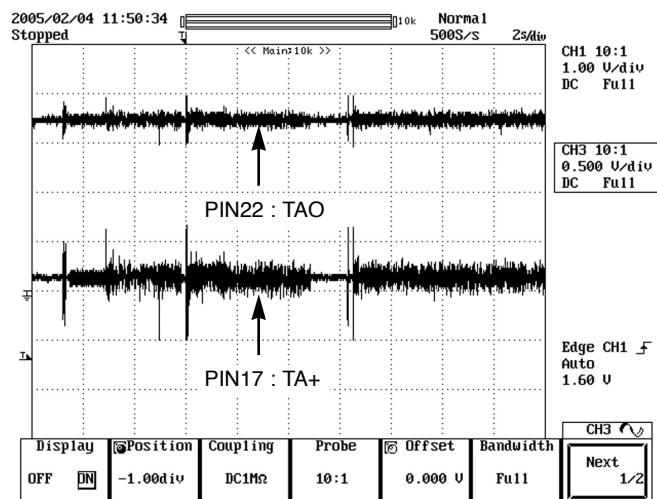
- There is disc on tray and focus search success



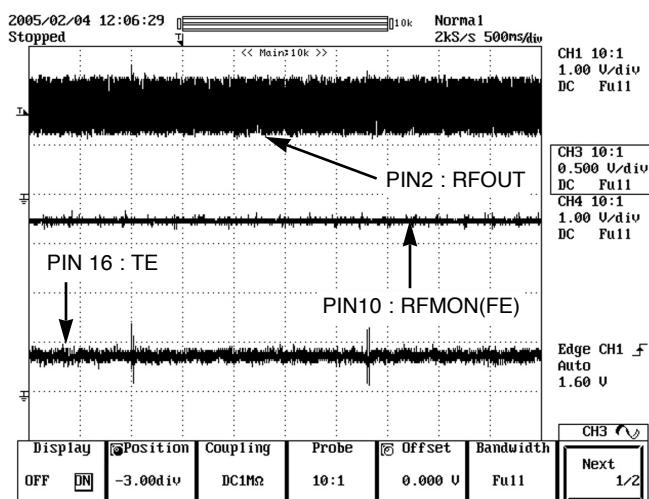
#4.SPINDLE DRIVE AND MOTOR WAVEFORM
(IC802 PIN6, 11) when TOC reading



#5.TRACK DRIVE AND MOTOR WAVEFORM
(IC802 PIN22, IC802 PIN17) during normal play

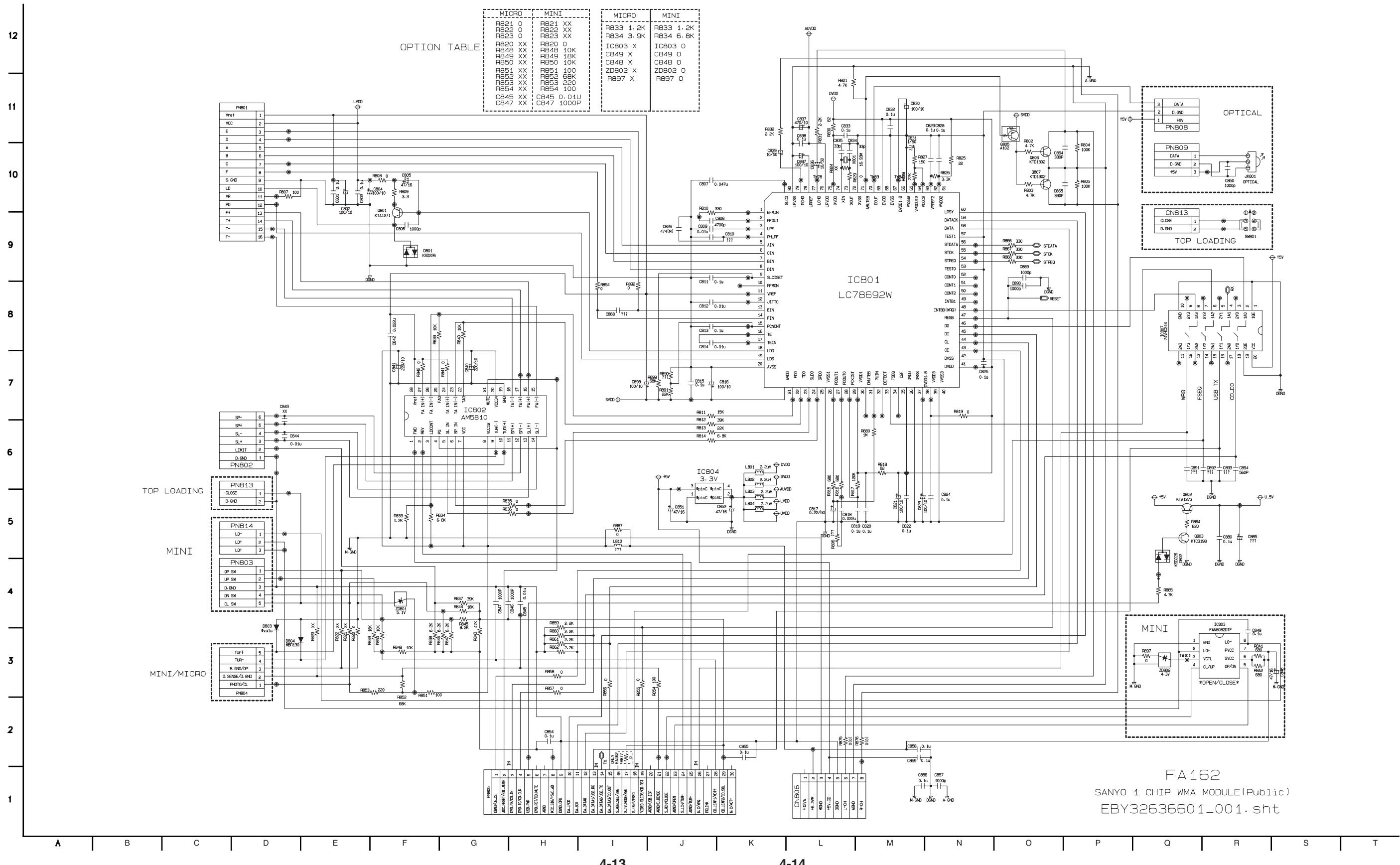


#6.RF, FOCUS AND TRACKING ERROR WAVEFORM
(IC801 PIN2, 10, 16) during normal play

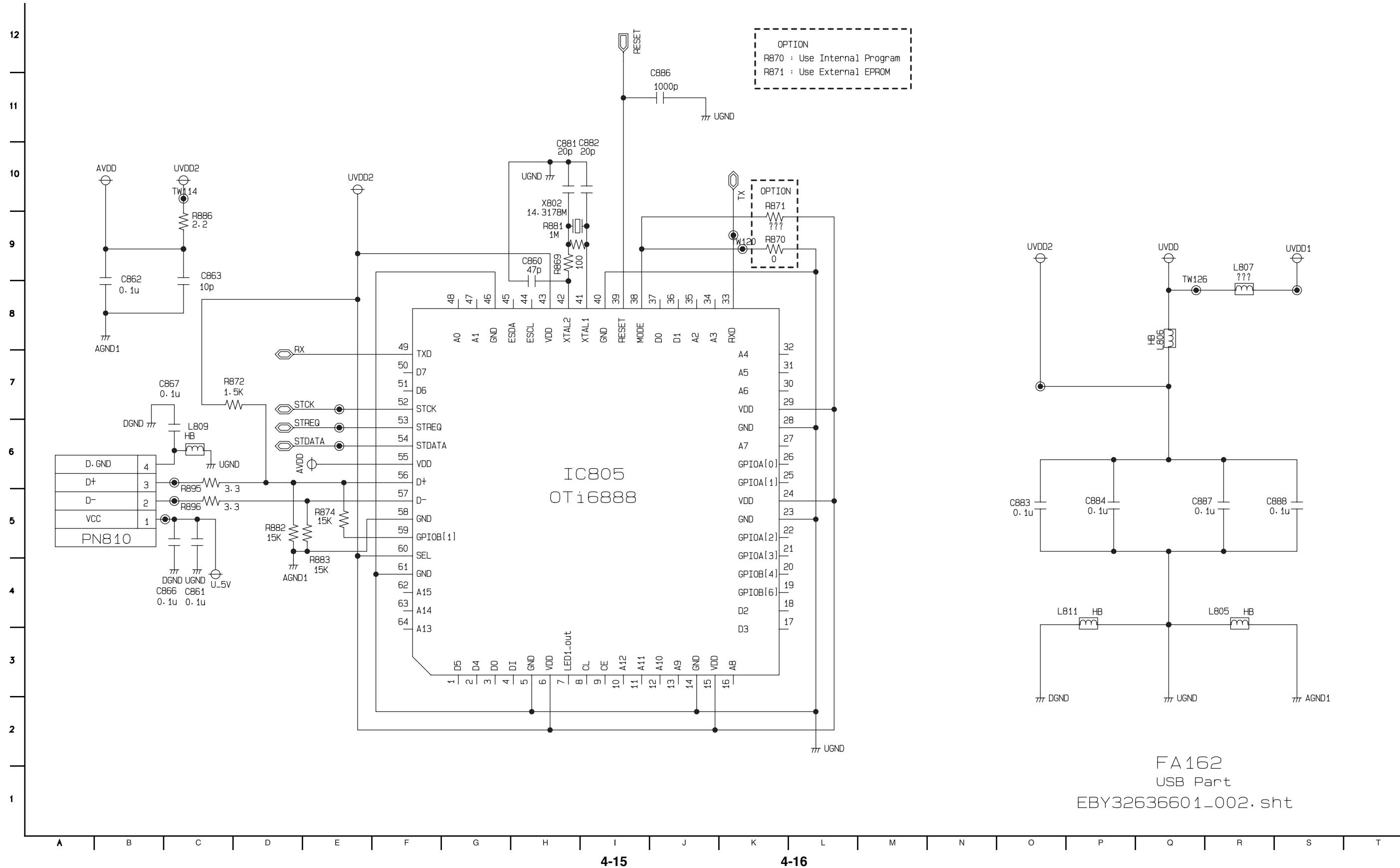


SCHEMATIC DIAGRAMS

1. CD SCHEMATIC DIAGRAM



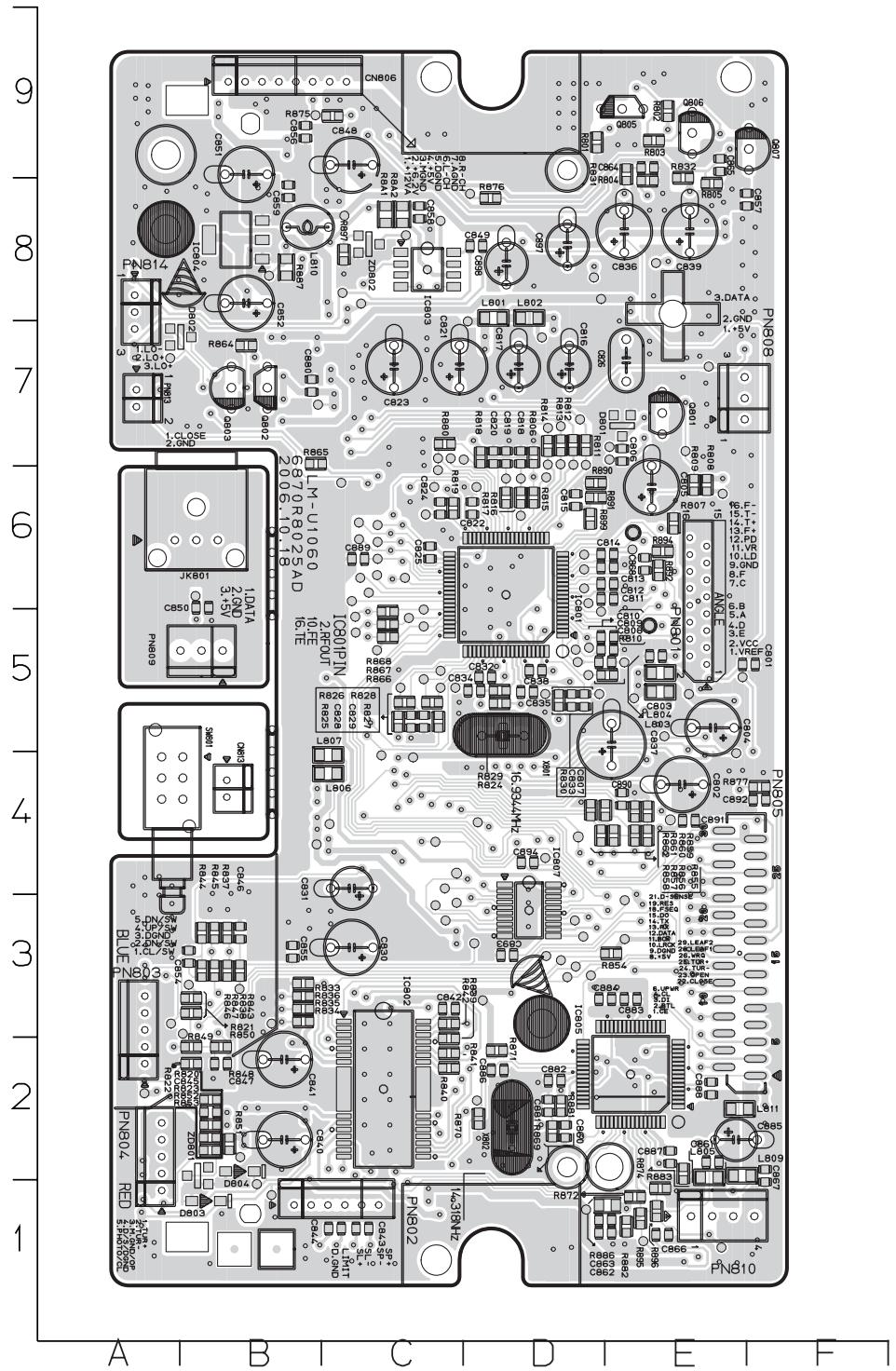
2. USB SCHEMATIC DIAGRAM



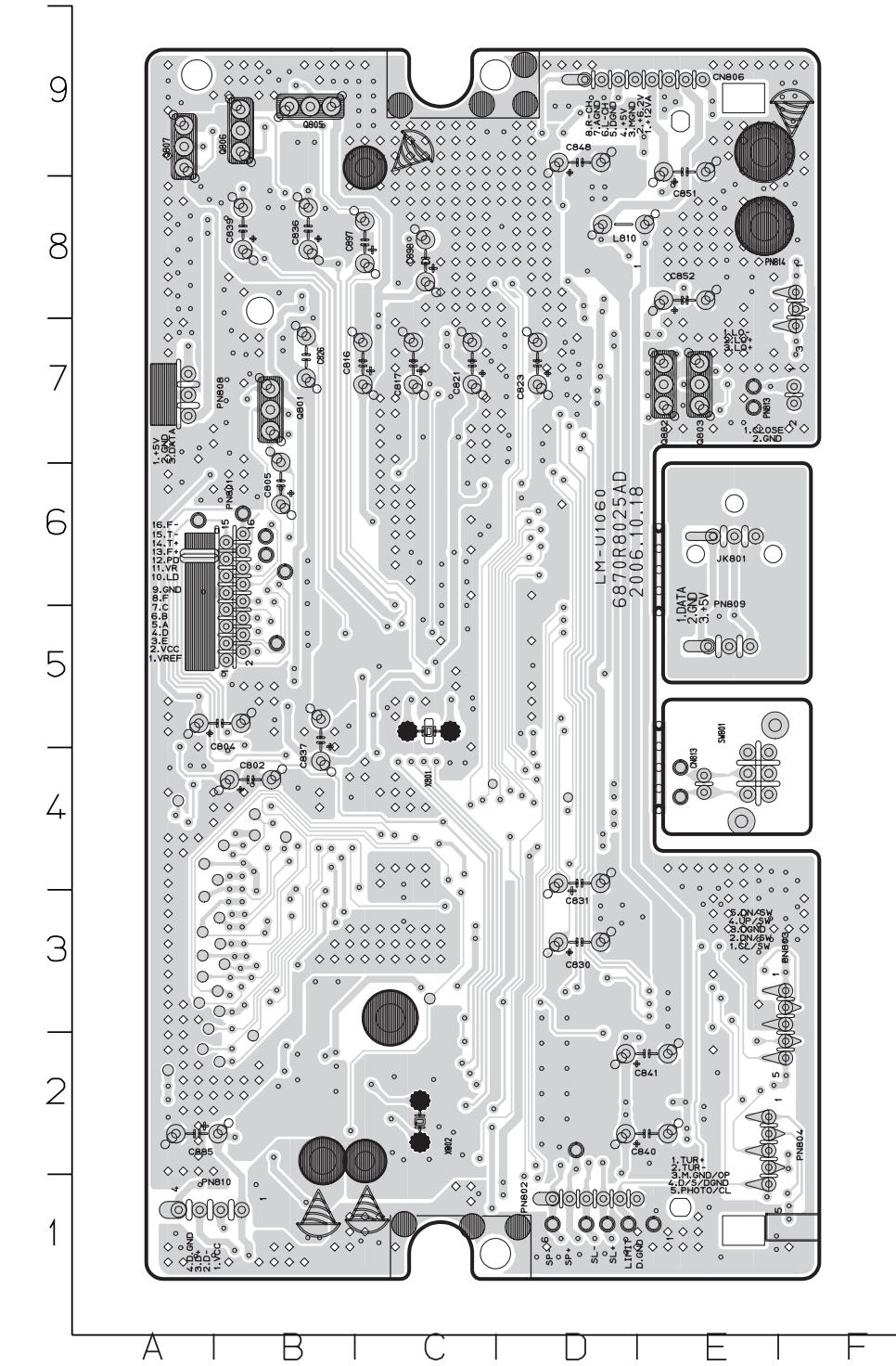
PRINTED CIRCUIT BOARD DIAGRAM

CD P.C.BOARD

(TOP VIEW)



(BOTTOM VIEW)



MEMO

MEMO